

AURIX™ TC33x/TC32x errata sheet

Marking/Step: (E)ES-AA, AA

10471AERRA

About this document

Scope and purpose

This document describes the deviations of the device from the current user documentation, to support the assessment of the effects of these deviations on your custom hardware and software implementations.

Please take note of the following information:

- This errata sheet applies to all temperature and frequency versions and to all memory size variants, unless explicitly noted otherwise. For a derivative synopsis, see the latest datasheet or user manual
- Multiple device variants are covered in this one document. If an issue is related to a particular module, and this module is not specified for a specific device variant, then the issue does not apply to that device variant
 - For example, issues with the identifier "EMEM" (extension memory) do not apply to devices for which no extension memory is specified ("EMEM" is used only as a generic example and may not be a feature of the device that this document covers)
- Devices marked with EES or ES are engineering samples which may not be completely tested in all functional and electrical characteristics and are therefore only suitable for evaluation
 - The specific test conditions for EES and ES are documented in a separate status sheet
- Some of the errata have workarounds which may be supported by the tool vendors. Some corresponding compiler switches may need to be set. Please refer to the respective documentation of your compiler
- To understand the effect of issues relating to the on-chip debug system, please refer to the respective debug tool vendor documentation

Table 1 Current documentation

AURIX™ TC3xx User's Manual	V2.0.0	2021-02
AURIX™ TC33x/TC32x Appendix to User's Manual	V2.0.0	2021-02
TC33x/TC32x AA-Step Data Sheet	V1.1	2021-03
TriCore™ TC1.6.2 Core Architecture Manual:		
• Core Architecture (Vol. 1)	V1.2.2	2020-01-15
• Instruction Set (Vol. 2)	V1.2.2	2020-01-15
AURIX™ TC3xx Safety Manual	V2.0	2021-05-03

Newer versions replace older versions, unless specifically stated otherwise.

Please always refer to the corresponding documentation for this device available in the category 'Documents' at www.infineon.com/AURIX™ and www.myInfineon.com.

Conventions used in this document

Each erratum identifier follows the pattern [Module]_[Arch].[Type][Number]:

- [Module] = subsystem, peripheral, or function affected by the erratum
- [Arch] = microcontroller architecture where the erratum was initially detected
 - AI = Architecture Independent
 - TC = TriCore™
- [Type] = category of deviation
 - [none] = Functional deviation

About this document

- P = Parametric deviation
- H = Application hint
- [Number] = ascending sequential number within the three previous fields

Note: *[Number] As this sequence is used over several derivatives, including already solved deviations, gaps can occur inside this numbering sequence*

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1 Errata overview

1 Errata overview

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2 Functional deviations

2 Functional deviations

2.1 [BROM_TC.013] CAN BSL does not send error message if no valid baudrate is detected

Description

If the CAN Bootstrap loader (BSL) is unable to determine the baudrate from the initialization message sent by the host, it does not send the error message as defined in table “Error message (No baudrate detected)” in chapter “AURIX™ TC3xx Platform Firmware” in TC3xx User's Manual, but enters an endless loop with no activity on external pins.

Workaround

If the external host does not receive Acknowledgment Message 1 from the CAN BSL within the expected time (~5 ms), it should check the integrity of the connection, and then may reset the TC3xx to restart the boot procedure.

2.2 [BROM_TC.014] Lockstep comparator alarm for CPU0 after warm PORST, system or application reset if lockstep is disabled

Description

Lockstep monitoring may be disabled in the Boot Mode Header structure (BMHD) for each CPUx with lockstep functionality (including CPU0). The startup software (SSW) will initially re-enable lockstep upon the next reset trigger.

If lockstep is disabled for CPU0, and the next reset is a warm PORST, system or application reset, a lockstep comparator alarm will be raised for CPU0.

Note: This effect does not occur for CPUx, x>0.

Workaround

Do not disable lockstep for CPU0, always keep lockstep on CPU0 enabled.
Non-safety applications may ignore the lockstep comparator alarm for CPU0.

2.3 [BROM_TC.016] Uncorrectable ECC error in Boot Mode Headers

Description

If one or more boot mode headers UCB_BMHDx_ORIG or UCB_BMHDx_COPY contain an uncorrectable ECC error (4-bit error) in the BMI, BMHDID, STAD, CRCBMHD or CRCBMHD_N fields, firmware will end up in an irrecoverable state resulting in a device not being able to boot anymore.

This may happen in the following scenarios:

- Power-loss during BMHD reprogramming or erase
- Over-programming of complete BMHD contents

Workaround

- Ensure continuous power-supply during BMHD reprogramming and erase using power monitoring including appropriate configuration
- Avoid over-programming of BMHD contents
- Ensure that also in any BMHDx_ORIG or _COPY unused in the application, the above fields are in a defined ECC-error free state (for example clear them to 0)

2 Functional deviations

2.4 [CCU_TC.005] ASC and CAN bootstrap loaders may not work if external clock is missing

Description

When using the ASC or CAN bootstrap loader (BSL) with internal clocking (f_{BACK}), and no supply noise or other source of signal level transition is present on the XTAL1 input during device power-up, the device does not respond to the zero byte (ASC BSL) or initialization frame (CAN BSL).

Effects

No code download for initial device programming is started.

Note: *This problem may only occur for initial start-up of unprogrammed devices. For TC3xx, if automatic start of the external crystal oscillation is programmed in UCB DFLASH, the problem will not occur.*

Workaround

Trigger reset and retry if bootstrap loader does not respond.

If connection to the device is possible through a debug tool, use the tool to reconfigure OSCCON.MODE = 00_B (when using an external crystal), and then trigger reset.

2.5 [CPU_TC.130] Data Corruption when ST.B to local DSPR coincides with external access to same address

Description

Under certain conditions, when a CPU accesses its local DSPR using “store byte” (ST.B) instructions, at the same time as stores from another bus master (such as remote CPU or DMA for example) to addresses containing the same byte, the result is the corruption of data in the adjacent byte in the same halfword.

All the following conditions must be met for the issue to be triggered:

- CPU A executes a ST.B targeting its local DSPR
- Remote bus master performs a write of 16-bit or greater targeting CPU A DSPR
- Both internal and external accesses target the same byte without synchronization

Note: *Although single 8-bit write accesses by the remote bus master do not trigger the problem, 16-bit bus writes from a remote CPU could occur from a sequence of two 8-bit writes merged by the store buffers into one 16-bit access.*

When the above conditions occur, the value written by the external master to the adjacent byte (to that written by CPU A) is lost, and the prior value is retained.

Workaround 1

Ensure mutually exclusive accesses to the memory location. A semaphore or mutex can be put in place in order to ensure that Core A and other bus masters have exclusive access to the targeted DSPR location.

Workaround 2

When sharing objects without synchronization between multiple cores, use objects of at least halfword in size.

Workaround 3

When two objects, being shared without synchronization between multiple cores, are of byte granularity, locate these objects in a memory which is not a local DSPR to either of the masters (LMU, PSPR, or other DSPR for example).

2 Functional deviations

2.6 [CPU_TC.131] Performance issue when MADD or MSUB instructions use E0 or D0 register as accumulator

Description

Note: Consider the following notes for TC26x, TC27x, TC29x:

- **TC26x:** In TC26x devices, this problem only affects the TC1.6P processor (CPU1). The TC1.6E processor (CPU0) is not affected by this problem.
- **TC27x:** In TC27x devices, this problem only affects the TC1.6P processors (CPU1 and CPU2). The TC1.6E processor (CPU0) is not affected by this problem.
- **TC29x:** In TC29x devices, this problem affects the TC1.6P processors (CPU0, CPU1, and CPU2).

Under certain conditions, when a Multiply (MULx.y) or Multiply-Accumulate (MAC) instruction is followed by a MAC instruction which uses the result of the first instruction as its accumulator input, a performance reduction may occur if the accumulator uses the E0 or D0 register. The accumulator input is that to which the multiplication result is added to (in the case of MADDx.y), or subtracted from (in the case MSUBx.y), in a MAC instruction.

All MAC instructions MADDx.y, MSUBx.y are affected except those that operate on Floating-Point operands (MADD.F, MSUB.F).

The problem occurs where there is a single cycle bubble, or an instruction not writing a result, between these dependent instructions in the Integer Pipeline (IP). When this problem occurs the dependent MAC instruction will take 1 additional cycle to complete execution. If this sequence is in a loop, the additional cycle will be added to every iteration of the loop.

Example

```
maddm.h e0, e0, d3, d5ul ; MUL/MAC writing E0 as result
ld.d e8, [a5] ; Load instruction causing IP bubble
maddm.h e0, e0, d6, d8ul ; MAC using E0 as accumulator.
                        ; Should be delayed by 1 cycle due to
                        ; dependency to result of previous LD.D,
                        ; but is delayed for 2 cycles
```

Note: If there are 2 or more IP instructions, or a single IP instruction writing a result, between the MAC and the previous MUL/MAC, then this issue does not occur.

Workaround

Since the issue only affects D0 or E0, it is recommended that to ensure the best performance of an affected sequence as the above example, D0 or E0 is replaced with another register (D1-D15 or E2-E14).

2.7 [CPU_TC.132] Unexpected PSW values used upon Fast Interrupt entry

Description

Under certain conditions, unexpected PSW values may be used during the first instructions of an interrupt handler, if the interrupt has been taken as a fast interrupt. For a description of fast interrupts, see the “CPU Implementation-Specific Features” section of the relevant User’s Manual.

2 Functional deviations

When the problem occurs, the first instructions of the interrupt handler may be executed using the PSW state from the end of the previous exception handler, rather than that which is being loaded by the fast interrupt entry sequence. The TC1.6E, TC1.6P and TC1.6.2P processors are all affected by this problem as follows:

- TC1.6E (in TC21x..TC27x):
 - Only the first instruction of the ISR is affected
- TC1.6P (in TC26x..TC29x), TC1.6.2P (in TC3xx):
 - Up to 4 instructions at the start of the ISR may be affected.
 - However, if the following pre-condition is not met, then there is no issue for these processor variants: A11 must point to the first instruction of the fast interrupt handler at the end of the previous exception handler, i.e. the return value from the previous exception must be pointing to the very first instruction of the new interrupt handler. Note that this case should not occur normally, unless software updates the A11 register to a value corresponding to the start of an interrupt handler

Workaround 1

When the PSW fields PSW.PRS, PSW. S, PSW.IO or PSW.GW need to be changed in an exception handler, the change should be wrapped in a function call.

```

_exception_handler:
    CALL _common_handler
    RFE

_common_handler:
    MOV.U d0, #0x0380
    MTCR #(PSW), d0 // PSW.IO updated to User-0 mode
    ...
    RET

```

Note that this workaround assumes SYSCON.TS == SYSCON.IS such that the workaround functions correctly for both traps and interrupts. If this is not the case it is possible for bus accesses to use an incorrect master Tag ID, potentially resulting in an access to be incorrectly allowed, or an unexpected alarm to be generated. In this case it should be ensured that for all interrupt handlers the potentially affected instructions do not produce bus accesses.

Workaround 2

Do not use any instructions dependent upon PSW settings (for example BISR or ENABLE, dependent on PSW.IO) as the first instruction of an ISR in TC1.6E, or as one of the first 4 instructions in an ISR for TC1.6P or TC1.6.2P.

Note: *The workarounds need to be applied in TC1.6P and TC1.6.2P only in case software modifies the A11 register in an exception handler, as described in the pre-conditions above.*

2.8 [CPU_TC.133] Test sequence for DTAG single or double bit errors

Description

The error injection method described in the section “Error injection and Alarm Triggering” in the MTU chapter of the TC3xx User’s Manual using the ECCMAP method is not sufficient to trigger alarms pertaining to the DTAG RAM of each CPU. In the case of DTAG RAM, an alternate method relying on the Read Data and Bit Flip register (RDBFL) must be used instead.

When using the ECCMAP, the DTAG ECC error detection is disabled when the DTAG memory is mapped in the system address map.

This limitation only affects the testing using ECCMAP for DTAG RAM.

2 Functional deviations

During normal operation, where DTAG is used as part of the CPU data cache operation, the ECC error detection functions as intended.

During SSH test mode (used for MBIST) the ECC error detection also operates as intended.

Workaround

A correct test sequence for DTAG single and double bit error injection must therefore use the RDBFL register without mapping the RAM to the system address space.

DTAG SRAM test sequence

In order to test the DTAG error injection the following test sequence should be followed:

1. Read an DTAG SRAM location into RDBFL register (see section “Reading a Single Memory Location”)
2. Flip some bit in RDBFL[0]
3. Writeback the content of the RDBFL into the DTAG SRAM (see section “Writing a Single Memory Location”)
4. Read the DTAG SRAM location again

Depending on the number of bits flipped the CE or UCE alarms will be triggered.

2.9 [DAP_TC.005] DAP client_read: dirty bit feature of Cerberus’ Triggered Transfer Mode

Description

Note: *This problem is only relevant for tool development, not for application development.*

The DAP telegram client_read reads a certain number of bits from an IOclient (for example Cerberus). The parameter k can be selected to be zero, which is supposed to activate reading of 32 bits plus dirty bit. However, in the current implementation, the dirty bit feature does not work correctly.

It is recommended not to use this dirty bit feature, meaning the number k should not evaluate to “0”.

2.10 [DAP_TC.007] Incomplete client_blockread telegram in DXCM mode when using the “read CRCup” option

Description

In DXCM (DAP over CAN Messages) mode, the last parcel containing the CRC32 might be skipped in a client_blockread telegram using the “read CRCup” option.

Workaround

Do not use CRCup option with client_blockread telegrams in DXCM mode.

Instead the CRCup can be read by a dedicated getCRCup telegram.

2.11 [DMA_TC.066] DMA double buffering operations - Update address pointer

Description

Software may configure a DMA channel for one of the DMA double buffering operations:

- DMA Double Source Buffering Software Switch Only
 - (DMA channel DMA_ADICRz.SHCT = 1000_B)

2 Functional deviations

- DMA Double Source Buffering Automatic Hardware and Software Switch
 - (DMA channel DMA_ADICRz.SHCT = 1001_B)
- DMA Double Destination Buffering Software Switch Only
 - (DMA channel DMA_ADICRz.SHCT = 1010_B)
- DMA Double Destination Buffering Automatic Hardware and Software Switch
 - (DMA channel DMA_ADICRz.SHCT = 1011_B)

If the software updates a buffer address pointer by BYTE or HALF-WORD writes, the resulting value of the address pointer is corrupted.

Workaround

If the software updates a buffer address pointer, the software should only use a 32-bit WORD access.

2.12 [DMA_TC.067] DMA Double Buffering Software Switch buffer overflow

Description

If a DMA channel is configured for DMA Double Buffering Software Switch Only and the active buffer is emptied or filled, the DMA does not stop. A bug results in the DMA evaluating the state of the FROZEN bit (DMA channel CHCSR.FROZEN). If the FROZEN bit is not set, the DMA continues to service DMA requests in the current buffer. The DMA may perform DMA write moves outside of the address range of the buffer potentially trashing other data.

Workaround

Implement one or more of the following to minimize the impact of the bug:

1. Configure access protection across the whole memory map to prevent the trashing data by the DMA channel configured for DMA double buffering. A DMA resource partition may be used to assign a unique master tag identifier to the DMA channel
2. The address generation of the DMA channel configured for DMA double buffering should use a circular buffer aligned to the size of the buffer to prevent the DMA from writing outside the address range of the buffer

2.13 [DMA_TC.068] DMA Double Buffering lost DMA request

Description

If a DMA channel is configured for DMA Double Buffering and a buffer switch is performed, no DMA requests shall be lost by the DMA and there shall be no loss, duplication or split of data across two buffers.

A bug results in a software switch clearing a pending DMA request. As a result a DMA transfer is lost without the recording of a TRL event so violating the aforementioned top-level requirements of DMA double buffering.

Workaround

The system must ensure that a software switch does not collide with a DMA request. A user program must execute the following steps to switch the buffer:

1. Software must disable the servicing of interrupt service requests by the DMA channel by disabling the corresponding Interrupt Router (IR) Service Request Node (SRN)
 - a. Software shall write IR_SRCi.SRE = 0_B
2. Software must halt the DMA channel configured for DMA double buffering
 - a. Software shall write DMA channel TSRc.HLTREQ = 1_B
 - b. Software shall monitor DMA channel TSRc.HLTACK = 1_B

2 Functional deviations

3. Software must monitor the DMA Channel Transaction Request State
 - a. Software shall read DMA channel TSRC.CH and store the value in a variable SAVED_CH
4. Software must switch the source or destination buffer
 - a. Software shall write DMA channel CHCSRc.SWB = 1_B
 - b. Software shall monitor the DMA channel frozen bit CHCSRc.FROZEN
5. When the DMA channel has switched buffers (DMA channel CHCSRc.FROZEN = 1_B)
 - a. If (SAVED_CH==1), software shall trigger a DMA software request by writing DMA channel CHCSRc.SCH = 1_B to restore DMA channel TSRC.CH to the state before the buffer switch
6. Software must unhalt the DMA channel
 - a. Software shall write DMA channel TSRC.HLTCLR = 1_B
7. Software must enable the servicing of interrupt service requests by the DMA channel
 - a. Software shall write IR_SRCi.SRE = 1_B

The software must include an error routine.

1. Software must monitor for interrupt overflows (IR_SRCi.IOV = 1_B) and lost DMA requests (TSRC.TRL = 1_B)
2. If software detects an overflow or lost DMA request, the software must execute an error routine and take the appropriate reaction consistent with the application

2.14 [FLASH_TC.053] Erase size limit for PFLASH

Description

The device may fail to start up after a primary voltage monitor triggered (cold) PORST if all of the following four conditions are fulfilled at the same time:

- Erase operation is ongoing in PFLASH, AND
- PORST is triggered by one of the primary voltage monitors, AND
- Ambient temperature $T_A > 60^\circ\text{C}$ OR junction temperature $T_J > 70^\circ\text{C}$, AND
- Size of logical sectors > 256 Kbyte is specified in "Erase Logical Sector Range" command

Workaround

If it cannot be excluded that all four conditions listed above may occur at the same time:

- Limit the maximum logical sector erase size to 256 Kbyte in the "Erase Logical Sector Range" command

2.15 [FLASH_TC.055] Multi-bit errors detected by PFlash are not communicated to SPB masters

Description

Section "PFLASH ECC" in the NVM chapter of the TC3xx User Manual states in bullet points

- "Multi-bit error and not All-0 error" and
- "Multi-bit error and All-0 error"

that a bus error is returned to the reading master.

The same statement is repeated in section "Program Side Memories" in the CPU chapter under the headline "Local Pflash Bank (LPB)" and in the HSM Target Specification.

Effectively the processing of such errors depends on the type of transaction (burst or single) and the path the read transaction takes through the on-chip connectivity with the result that an SPB master (like HSM) gets no information about the detected error as detailed below:

When a CPU reads its local PFlash bank using direct access through its DPI (also called "Fast Path") such errors are directly translated into a PIE trap for instruction fetch and a DIE trap for data read. No bus error is generated as no bus communication is involved.

2 Functional deviations

When any master reads PFlash through the SRI (this includes CPUs reading the PFlash located at another CPU or its local bank with disabled Fast Path) a single transfer with multi-bit error returns a bus error but a burst read is reporting this error using a forced “Transaction ID Error” (concept described in “On-Chip System Connectivity {and Bridges}”). The bus error is always communicated back to the master. The handling of the Transaction ID Error however is master specific.

When a CPU receives the SRI transaction ID error it handles it as bus error and triggers a PSE trap for instruction fetch and a DSE trap for data read.

Also the DMA handles the Transaction ID Error like a bus error, sets the corresponding error flags and triggers the source error interrupt request.

When an SPB master like HSM performs a burst read from a PFlash bank this SRI Transaction ID Error terminates at the SFI_F2S bridge. The SPB master does not receive a bus error and continues operation with wrong data. The SFI_F2S bridge signals the error to the XBar for alarm generation.

The SPB master Cerberus acting on behalf of a debug tool issues only single transfers and is therefore correctly informed by a bus-error.

Workaround

Such multi-bit errors are added to the MBAB error buffer in the PFI (documented in the NVM chapter). Filling the MBAB results in sending an alarm “Safety Mechanism: PFlash ECC; Alarm: Multiple Bit Error Detection Tracking Buffer Full” to the SMU.

As described above also SFI_F2S bridge informs the XBar to generate an alarm “Safety Mechanism: Built-in SRI Error Detection; Alarm: XBAR0 Bus Error Event” to the SMU. With HSM as requesting master the XBAR0 just captures the occurrence of this error but doesn’t capture address or other transaction data in its Error Capture registers.

The application has to take care that the SMU alarm handler informs the SPB master.

2.16 [FLASH_TC.056] Reset value for register HF_ECCC is 0x0000 0000 - Documentation correction

Description

In the register description for register HF_ECCC (DF0 ECC Control Register) in the TC3xx User’s Manual, the application reset value is documented as C000 0000_H.

However, this register is cleared by the startup software SSW, and the user software will read the reset value of 0000 0000_H.

Documentation correction

- The application reset value for register HF_ECCC is 0000 0000_H

Note: *The user must consider that field HF_ECCC.TRAPDIS is 00_B after reset, which means a bus error trap is generated if an uncorrectable ECC error occurs upon read from DF0, or read from DF1 when DF1 is configured as not HSM_exclusive.*

2.17 [FlexRay_AI.087] After reception of a valid sync frame followed by a valid non-sync frame in the same static slot the received sync frame may be ignored

Description

If in a static slot of an even cycle a valid sync frame followed by a valid non-sync frame is received, and the frame valid detection (prt_frame_decoded_on_X) of the DEC process occurs one sclk after valid frame detection of FSP process (fsp_val_syncfr_chx), the sync frame is not taken into account by the CSP process (devte_xxs_reg).

2 Functional deviations

Scope

The erratum is limited to the case where more than one valid frame is received in a static slot of an even cycle.

Effects

In the described case the sync frame is not considered by the CSP process. This may lead to a SyncCalcResult of MISSING_TERM (error flag SFS.MRCS set). As a result the POC state may switch to NORMAL_PASSIVE or HALT or the Start-up procedure is aborted.

Workaround

Avoid static slot configurations long enough to receive two valid frames.

2.18 [FlexRay_AI.088] A sequence of received WUS may generate redundant SIR.WUPA/B events

Description

If a sequence of wake-up symbols (WUS) is received, all separated by appropriate idle phases, a valid wake-up pattern (WUP) should be detected after every second WUS. The E-Ray detects a valid wake-up pattern after the second WUS and then after each following WUS.

Scope

The erratum is limited to the case where the application program frequently resets the appropriate SIR.WUPA/B bits.

Effects

In the described case there are more SIR.WUPA/B events seen than expected.

Workaround

Ignore redundant SIR.WUPA/B events.

2.19 [FlexRay_AI.089] Rate correction set to zero in case of SyncCalcResult=MISSING_TERM

Description

In case a node receives too few sync frames for rate correction calculation and signals a SyncCalcResult of MISSING_TERM, the rate correction value is set to zero instead of to the last calculated value.

Scope

The erratum is limited to the case of receiving too few sync frames for rate correction calculation (SyncCalcResult=MISSING_TERM in an odd cycle).

Effects

In the described case a rate correction value of zero is applied in NORMAL_ACTIVE / NORMAL_PASSIVE state instead of the last rate correction value calculated in NORMAL_ACTIVE state. This may lead to a desynchronisation of the node although it may stay in NORMAL_ACTIVE state (depending on gMaxWithoutClockCorrectionPassive) and decreases the probability to re-enter NORMAL_ACTIVE state if it has switched to NORMAL_PASSIVE (pAllowHaltDueToClock=false).

2 Functional deviations

Workaround

It is recommended to set gMaxWithoutClockCorrectionPassive to 1. If missing sync frames cause the node to enter NORMAL_PASSIVE state, use higher level application software to leave this state and to initiate a re-integration into the cluster. HALT state can also be used instead of NORMAL_PASSIVE state by setting pAllowHaltDueToClock to true.

2.20 [FlexRay_AI.090] Flag SFS.MRCS is set erroneously although at least one valid sync frame pair is received

Description

If in an odd cycle $2c+1$ after reception of a sync frame in slot n the total number of different sync frames per double cycle has exceeded gSyncNodeMax and the node receives in slot $n+1$ a sync frame that matches with a sync frame received in the even cycle $2c$, the sync frame pair is not taken into account by CSP process. This may cause the flags SFS.MRCS and EIR.CCF to be set erroneously.

Scope

The erratum is limited to the case of a faulty cluster configuration where different sets of sync frames are transmitted in even and odd cycles and the total number of different sync frames is greater than gSyncNodeMax.

Effects

In the described case the error interrupt flag EIR.CCF is set and the node may enter either the POC state NORMAL_PASSIVE or HALT.

Workaround

Correct configuration of gSyncNodeMax.

2.21 [FlexRay_AI.091] Incorrect rate and / or offset correction value if second Secondary Time Reference Point (STRP) coincides with the action point after detection of a valid frame

Description

If a valid sync frame is received before the action point and additionally noise or a second frame leads to a STRP coinciding with the action point, an incorrect deviation value of zero is used for further calculations of rate and/or offset correction values.

Scope

The erratum is limited to configurations with an action point offset greater than the static frame length.

Effects

In the described case a deviation value of zero is used for further calculations of rate and/or offset correction values. This may lead to an incorrect rate and / or offset correction of the node.

Workaround

Configure action point offset smaller than static frame length.

2 Functional deviations

2.22 [FlexRay_AI.092] Initial rate correction value of an integrating node is zero if pMicroInitialOffsetA,B = 0x00

Description

The initial rate correction value as calculated in figure 8-8 of protocol spec v2.1 is zero if parameter pMicroInitialOffsetA,B was configured to be zero.

Scope

The erratum is limited to the case where pMicroInitialOffsetA,B is configured to zero.

Effects

Starting with an initial rate correction value of zero leads to an adjustment of the rate correction earliest 3 cycles later (see figure 7-10 of protocol spec v2.1). In a worst case scenario, if the whole cluster is drifting away too fast, the integrating node would not be able to follow and therefore abort integration.

Workaround

Avoid configurations with pMicroInitialOffsetA,B equal to zero. If the related configuration constraint of the protocol specification results in pMicroInitialOffsetA,B equal to zero, configure it to one instead. This will lead to a correct initial rate correction value, it will delay the start-up of the node by only one micro tick.

2.23 [FlexRay_AI.093] Acceptance of start-up frames received after reception of more than gSyncNodeMax sync frames

Description

If a node receives in an even cycle a start-up frame after it has received more than gSyncNodeMax sync frames, this start-up frame is added erroneously by process CSP to the number of valid start-up frames (zStartupNodes). The faulty number of start-up frames is delivered to the process POC. As a consequence this node may integrate erroneously to the running cluster because it assumes that it has received the required number of start-up frames.

Scope

The erratum is limited to the case of more than gSyncNodeMax sync frames.

Effects

In the described case a node may erroneously integrate successfully into a running cluster.

Workaround

Use frame schedules where all start-up frames are placed in the first static slots. gSyncNodeMax should be configured to be greater than or equal to the number of sync frames in the cluster.

2.24 [FlexRay_AI.094] Sync frame overflow flag EIR.SFO may be set if slot counter is greater than 1024

Description

If in the static segment the number of transmitted and received sync frames reaches gSyncNodeMax and the slot counter in the dynamic segment reaches the value cStaticSlotIDMax + gSyncNodeMax = 1023 + gSyncNodeMax, the sync frame overflow flag EIR.SFO is set erroneously.

2 Functional deviations**Scope**

The erratum is limited to configurations where the number of transmitted and received sync frames equals to gSyncNodeMax and the number of static slots plus the number of dynamic slots is greater or equal than 1023 + gSyncNodeMax.

Effects

In the described case the sync frame overflow flag EIR.SFO is set erroneously. This has no effect to the POC state.

Workaround

Configure gSyncNodeMax to number of transmitted and received sync frames plus one or avoid configurations where the total of static and dynamic slots is greater than cStaticSlotIDMax.

2.25 [FlexRay_AI.095] Register RCV displays wrong value**Description**

If the calculated rate correction value is in the range of [-pClusterDriftDamping .. +pClusterDriftDamping], vRateCorrection of the CSP process is set to zero. In this case register RCV should be updated with this value. Erroneously RCV.RCV[11:0] holds the calculated value in the range [-pClusterDriftDamping .. +pClusterDriftDamping] instead of zero.

Scope

The erratum is limited to the case where the calculated rate correction value is in the range of [-pClusterDriftDamping .. +pClusterDriftDamping].

Effects

The displayed rate correction value RCV.RCV[11:0] is in the range of [-pClusterDriftDamping .. +pClusterDriftDamping] instead of zero. The error of the displayed value is limited to the range of [-pClusterDriftDamping .. +pClusterDriftDamping]. For rate correction in the next double cycle always the correct value of zero is used.

Workaround

A value of RCV.RCV[11:0] in the range of [-pClusterDriftDamping .. +pClusterDriftDamping] has to be interpreted as zero.

2.26 [FlexRay_AI.096] Noise following a dynamic frame that delays idle detection may fail to stop slot**Description**

If (in case of noise) the time between 'potential idle start on X' and 'CHIRP on X' (see Protocol Spec. v2.1, Figure 5-21) is greater than gdDynamicSlotIdlePhase, the E-Ray will not remain for the remainder of the current dynamic segment in the state 'wait for the end of dynamic slot rx'. Instead, the E-Ray continues slot counting. This may enable the node to further transmissions in the current dynamic segment.

Scope

The erratum is limited to noise that is seen only locally and that is detected in the time window between the end of a dynamic frame's DTS and idle detection ('CHIRP on X').

2 Functional deviations

Effects

In the described case the faulty node may not stop slot counting and may continue to transmit dynamic frames. This may lead to a frame collision in the current dynamic segment.

Workaround

None

2.27 [FlexRay_AI.097] Loop back mode operates only at 10 MBit/s

Description

The looped back data is falsified at the two lower baud rates of 5 and 2.5 MBit/s.

Scope

The erratum is limited to test cases where loop back is used with the baud rate prescaler (PRTC1.BRP[1:0]) configured to 5 or 2.5 MBit/s.

Effects

The loop back self test is only possible at the highest baud rate.

Workaround

Run loop back tests with 10 MBit/s (PRTC1.BRP[1:0] = 00_B).

2.28 [FlexRay_AI.099] Erroneous cycle offset during start-up after abort of start-up or normal operation

Description

An abort of start-up or normal operation by a READY command near the macro tick border may lead to the effect that the state INITIALIZE_SCHEDULE is one macro tick too short during the first following integration attempt. This leads to an early cycle start in state INTEGRATION_COLDSTART_CHECK or INTEGRATION_CONSISTENCY_CHECK.

As a result the integrating node calculates a cycle offset of one macro tick at the end of the first even/odd cycle pair in the states INTEGRATION_COLDSTART_CHECK or INTEGRATION_CONSISTENCY_CHECK and tries to correct this offset.

If the node is able to correct the offset of one macro tick (pOffsetCorrectionOut >> gdMacroTick), the node enters NORMAL_ACTIVE with the first start-up attempt.

If the node is not able to correct the offset error because pOffsetCorrectionOut is too small (pOffsetCorrectionOut ≤ gdMacroTick), the node enters ABORT_STARTUP and is ready to try start-up again. The next (second) start-up attempt is not effected by this erratum.

Scope

The erratum is limited to applications where READY command is used to leave STARTUP, NORMAL_ACTIVE, or NORMAL_PASSIVE state.

Effects

In the described case the integrating node tries to correct an erroneous cycle offset of one macro tick during start-up.

2 Functional deviations**Workaround**

With a configuration of `pOffsetCorrectionOut >> gdMacroTick • (1+cClockDeviationMax)` the node will be able to correct the offset and therefore also be able to successfully integrate.

2.29 [FlexRay_AI.100] First WUS following received valid WUP may be ignored**Description**

When the protocol engine is in state `WAKEUP_LISTEN` and receives a valid wake-up pattern (WUP), it transfers into state `READY` and updates the wake-up status vector `CCSV.WSV[2:0]` as well as the status interrupt flags `SIR.WST` and `SIR.WUPA/B`. If the received wake-up pattern continues, the protocol engine may ignore the first wake-up symbol (WUS) following the state transition and signals the next `SIR.WUPA/B` at the third instead of the second WUS.

Scope

The erratum is limited to the reception of redundant wake-up patterns.

Effects

Delayed setting of status interrupt flags `SIR.WUPA/B` for redundant wake-up patterns.

Workaround

None

2.30 [FlexRay_AI.101] READY command accepted in READY state**Description**

The E-Ray module does not ignore a `READY` command while in `READY` state.

Scope

The erratum is limited to the `READY` state.

Effects

Flag `CCSV.CSI` is set. Cold starting needs to be enabled by POC command `ALLOW_COLDSTART` (`SUCC1.CMD = 1001B`).

Workaround

None

2.31 [FlexRay_AI.102] Slot status `vPOC!SlotMode` is reset immediately when entering HALT state**Description**

When the protocol engine is in the states `NORMAL_ACTIVE` or `NORMAL_PASSIVE`, a `HALT` or `FREEZE` command issued by the Host resets `vPOC!SlotMode` immediately to `SINGLE` slot mode (`CCSV.SLM[1:0] = 00B`). According to the FlexRay protocol specification, the slot mode should not be reset to `SINGLE` slot mode before the following state transition from `HALT` to `DEFAULT_CONFIG` state.

2 Functional deviations

Scope

The erratum is limited to the HALT state.

Effects

The slot status vPOC!SlotMode is reset to SINGLE when entering HALT state.

Workaround

None

2.32 [FlexRay_AI.103] Received messages not stored in Message RAM when in Loop Back Mode

Description

After a FREEZE or HALT command has been asserted in NORMAL_ACTIVE state, and if state LOOP_BACK is then entered by transition from HALT state via DEF_CONFIG and CONFIG, it may happen that acceptance filtering for received messages is not started, and therefore these messages are not stored in the respective receive buffer in the Message RAM.

Scope

The erratum is limited to the case where Loop Back Mode is entered after NORMAL_ACTIVE state was left by FREEZE or HALT command.

Effects

Received messages are not stored in Message RAM because acceptance filtering is not started.

Workaround

Leave HALT state by hardware reset.

2.33 [FlexRay_AI.104] Missing start-up frame in cycle 0 at coldstart after FREEZE or READY command

Description

When the E-Ray is restarted as leading coldstarter after it has been stopped by FREEZE or READY command, it may happen, depending on the internal state of the module, that the E-Ray does not transmit its start-up frame in cycle 0. Only E-Ray configurations with start-up frames configured for slots 1 to 7 are affected by this behavior.

Scope

The erratum is limited to the case when a coldstart is initialized after the E-Ray has been stopped by FREEZE or READY command. Coldstart after hardware reset is not affected.

Effects

During coldstart it may happen that no start-up frame is sent in cycle 0 after entering COLDSTART_COLLISION_RESOLUTION state from COLDSTART_LISTEN state.

The next coldstart attempt is no longer affected. Coldstart sequence is lengthened but coldstart of FlexRay system is not prohibited by this behavior.

2 Functional deviations

Workaround

Use a static slot greater or equal 8 for the start-up/sync message.

2.34 [FlexRay_AI.105] RAM select signals of IBF1/IBF2 and OBF1/OBF2 in RAM test mode

Description

When accessing Input Buffer RAM 1, 2 (IBF1, 2) or Output Buffer RAM 1, 2 (OBF1, 2) in RAM test mode, the following behavior can be observed when entering RAM test mode after hardware reset.

- Read or write access to IBF2:
 - In this case also IBF1 RAM select `eray_ibf1_cen` is activated initiating a read access of the addressed IBF1 RAM word. The data read from IBF1 is evaluated by the respective parity checker.
- Read or write access to OBF1:
 - In this case also OBF2 RAM select `eray_obf2_cen` is activated initiating a read access of the addressed OBF2 RAM word. The data read from OBF2 is evaluated by the respective parity checker.

If the parity logic of the erroneously selected IBF1 resp. OBF2 detects a parity error, bit `MHDS.PIBF` resp. `MHDS.POBF` in the E-Ray Message Handler Status register is set although the addressed IBF2 resp. OBF1 had not error. The logic for setting `MHDS.PIBF` / `MHDS.POBF` does not distinguish between set conditions from IBF1 or IBF2 resp. OBF1 or OBF2.

Due to the IBF / OBF swap mechanism as described in section 5.11.2 in the E-Ray Specification, the inverted behavior with respect to IBF1, 2 and OBF1, 2 can be observed depending on the IBF / OBF access history.

Scope

The erratum is limited to the case when IBF1, 2 or OBF1, 2 are accessed in RAM test mode. The problem does not occur when the E-Ray is in normal operation mode.

Effects

When reading or writing IBF1, 2 / OBF1, 2 in RAM test mode, it may happen, that the parity logic of IBF1, 2 / OBF1, 2 signals a parity error.

Workaround

For RAM testing after hardware reset, the Input / Output Buffer RAMs have to be first written and then read in the following order: IBF1 before IBF2 and OBF2 before OBF1

2.35 [FlexRay_AI.106] Data transfer overrun for message transfers Message RAM to Output Buffer (OBF) or from Input Buffer (IBF) to Message RAM

Description

The problem occurs under the following conditions:

- 1) A received message is transferred from the Transient Buffer RAM (TBF) to the message buffer that has its data pointer pointing to the first word of the Message RAM's Data Partition located directly after the last header word of the Header Partition of the Last Configured Buffer as defined by `MRC.LCB`
- 2) The Host triggers a transfer from / to the Last Configured Buffer in the Message RAM with a specific time relation to the start of the TBF transfer described under 1)

Under these conditions the following transfers triggered by the Host may be affected:

- a) Message buffer transfer from Message RAM to OBF

2 Functional deviations

When the message buffer has its payload configured to maximum length (PLC = 127), the OBF word on address 00h (payload data bytes 0 to 3) is overwritten with unexpected data at the end of the transfer.

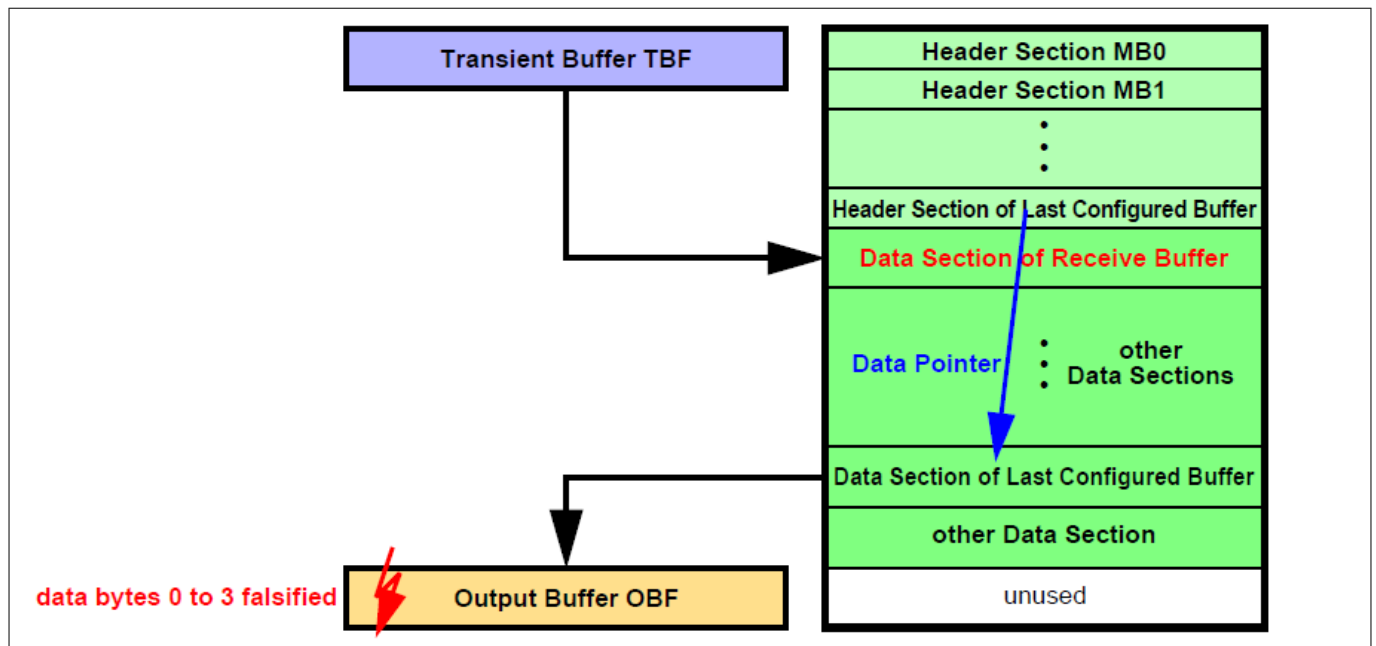


Figure 1 Message buffer transfer from Message RAM to OBF

b) Message buffer transfer from IBF to Message RAM

After the Data Section of the selected message buffer in the Message RAM has been written, one additional write access overwrites the following word in the Message RAM which might be the first word of the next Data Section.

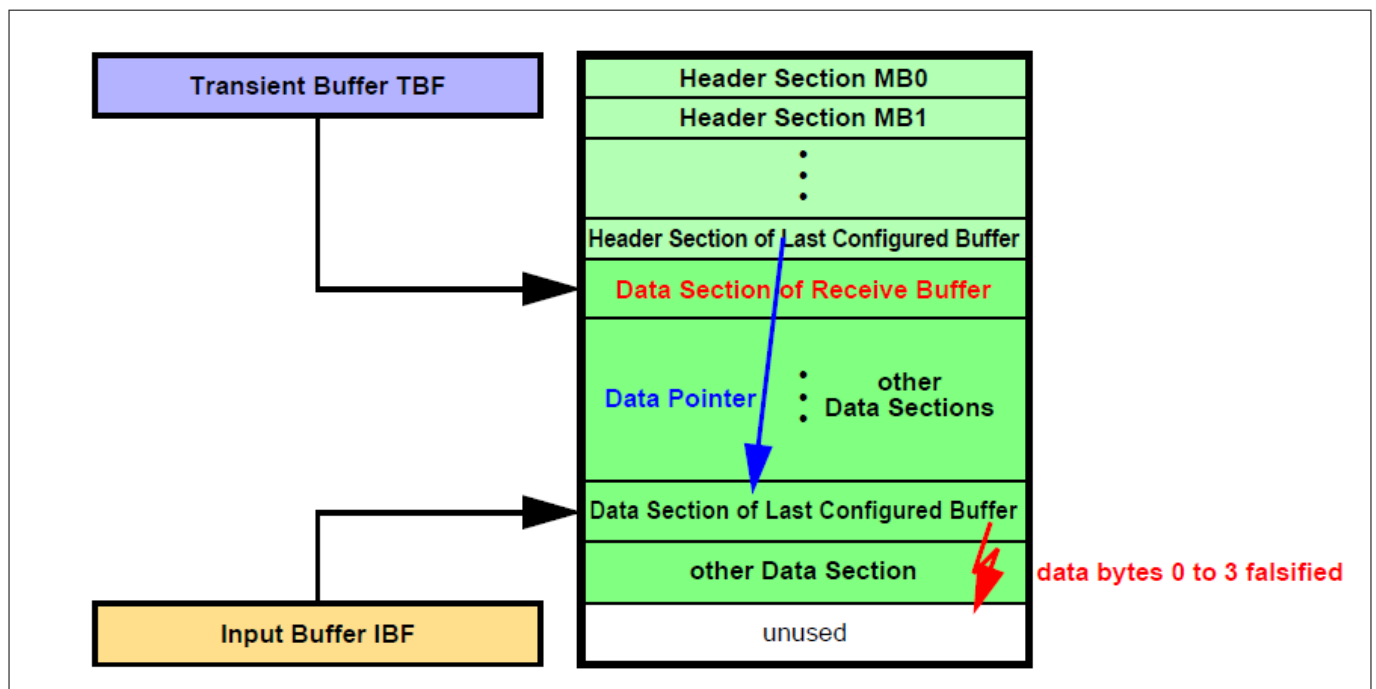


Figure 2 Message buffer transfer from IBF to Message RAM

Scope

The erratum is limited to the case when (see [Figure 3](#) “Bad Case”):

- 1) The first Data Section in the Data Partition is assigned to a receive buffer (incl. FIFO buffers)

2 Functional deviations

AND

2) The Data Partition in the Message RAM starts directly after the Header Partition (no unused Message RAM word in between)

Effects

a) When a message is transferred from the Last Configured Buffer in the Message RAM to the OBF and PLC = 127 it may happen, that at the end of the transfer the OBF word on address 00h (payload data bytes 0 to 3) is overwritten with unexpected data (see [Figure 1](#))

b) When a message is transferred from IBF to the Last Configured Buffer in the Message RAM, it may happen, that at the end of the transfer of the Data Section one additional write access overwrites the following word, which may be the first word of another message's Data Section in the Message RAM (see [Figure 2](#))

Workaround 1

Leave at least one unused word in the Message RAM between Header Section and Data Section.

Workaround 2

Ensure that the Data Section directly following the Header Partition is assigned to a transmit buffer.

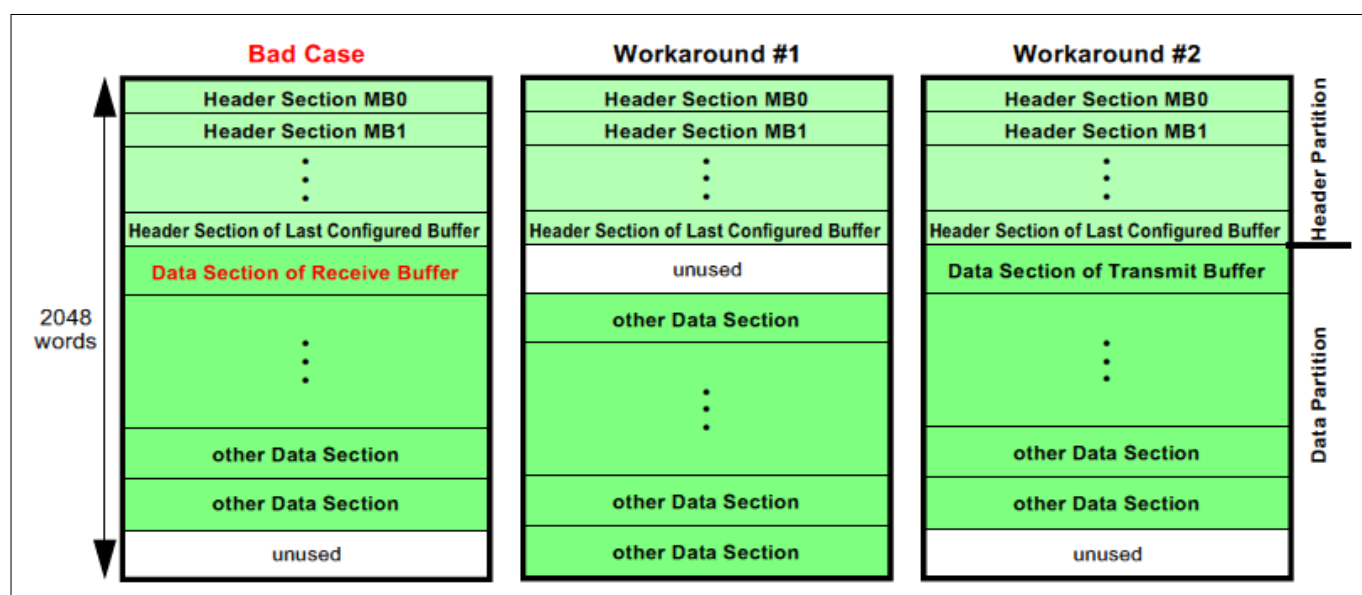


Figure 3 Message RAM configurations

2.36 [GTM_AI.254] TIM TDU: TDU_STOP=b101 not functional

Description

Stop counting of register TO_CNT on an tdu_word_event or stop counting of TO_CNT1 on a tdu_frame_event is not possible.

Scope

TIM

Effects

TO_CNT1, TO_CNT can not be stopped counting.

2 Functional deviations

Workaround

No workaround available.

2.37 [GTM_AI.308] TIM, ARU: Limitation that back-to-back TIM data transfers at full ARU clock rate cannot be transferred correctly with ARU dynamic routing feature

Description

If TIM input signals with signal changes faster or equal than ARU clock rate are processed with the TIM and the results are routed via ARU in dynamic routing mode, it is likely that there is a data loss and only each second data can be transferred.

Scope

ARU Routing, DEBUG signal interface

Effects

- a) If the ARU CADDR is kept stable and data is transferred back-to-back for 2 or more consecutive aru clock cycles while operating in ARU dynamic routing mode, then every second data provided by the TIM module gets lost
- b) Debugging of an ARU data transfer not completely correct. Every second GTM_DBG_ARU_DATAi_val signal missing

Workaround

Do not use the dynamic routing feature of ARU in the manner that the same ARU caddr is served for multiple cycles with back-to-back data transfers.

Ensure that every ARU clock cycle the CADDR address will change.

2.38 [GTM_AI.335] TOM output signal to SPE not functional if up/down counter mode is configured

Description

TOM output signal TOM[i]_CH[x]_SOUR to SPE not functional if up/down counter mode is configured by setting of TOM[i]_CH[x]_CTRL.UDMODE > 0.

Scope

TOM - SPE interface

Effects

TOM output signal TOM[i]_CH[x]_SOUR to SPE not functional.

Workaround

No workaround available.

Don't use up/down counter mode together with SPE interface.

2 Functional deviations

2.39 [GTM_AI.340] TOM/ATOM: Generation of TRIG_CCU0/TRIG_CCU1 trigger signals skipped in initial phase of A/TOM SOMP one-shot mode

Description

Configuration in use:

- A/TOM[i]_CH[x]_CTRL.OSM=1
- A/TOM[i]_CH[x]_CTRL.OSM_TRIG=0
- A/TOM[i]_CH[x]_CTRL.UDMODE=00
- ATOM[i]_CH[x]_CTRL.MODE=10

Expected behavior

The generation of one-shot pulses in A/TOM can be initiated by a write to CN0. In this case the pulse generation comprises of an initial phase where the signal level at A/TOM output is inactive followed by a pulse. The duration of the initial phase can be controlled by the written value of CN0, where the duration is defined by CM0-CN0. After the counter CN0 reaches the value of CM0-1, the pulse starts with its active edge, CN0 is reset, and starts counting again. When CN0 reaches CM1-1, the inactive edge of the pulse occurs. Due to the fact, that the capture compare units CCU0 and CCU1 compare also in the initial phase of the pulse generation, the trigger conditions for these comparators apply also in this initial phase. Thus, the TRIG_CCU0 and TRIG_CCU1 signals also occur in the initial phase of the one-shot pulse. When these trigger signals are enabled in the A/TOM[i]_CH[x]_IRQ_EN, an interrupt signal is generated by A/TOM on the CCU0TC and CCU1TC trigger conditions and the corresponding A/TOM[i]_CH[x]_IRQ_NOTIFY bits are set.

Observed behavior

For certain start values of CN0 and dependent on the history of pulse generation, the trigger signals TRIG_CCU0 and TRIG_CCU1 are skipped. As a consequence, this can lead to missing interrupts CCU0TC and CCU1TC on behalf of their missing trigger signals TRIG_CCU0 and TRIG_CCU1.

For the first pulse generation after enabling the channel, all trigger signals TRIG_CCU0 and TRIG_CCU1 appear as expected and described in the section expected behavior. If the channel stays enabled and a new value CN0 is written to trigger a subsequent one-shot pulse, the TRIG_CCU0/TRIG_CCU1 triggers in the initial phases of subsequent one-shot pulses are skipped under the following conditions:

- For TRIG_CCU0 trigger: if the one-shot pulse is started by writing a value to CN0 greater or equal to CM0-1
- For TRIG_CCU1 trigger: if the one-shot pulse is started by writing a value to CN0 greater or equal to CM1-1

Scope

TOM/ATOM

Effects

Missing TRIG_CCU0 and TRIG_CCU1 trigger signals in initial phase of subsequent pulses in A/TOM one-shot mode, when one shot-mode is started with writing to CN0 values greater equal CM0-1 or CM1-1.

Workaround 1

Disabling, resetting (channel reset), re-enabling and initializing of the channel between each one-shot pulse will ensure the correct behavior of CCU0TC and CCU1TC interrupt source.

Workaround 2

Starting a new one-shot pulse by writing twice the counter CN0 whereas the first value, which is written to CN0 should be zero followed by the value which defines the length of the initial phase.

2 Functional deviations

Be aware that in this case, the total length of the initial phase until the pulse is started, is influenced by the time between the two write accesses to CN0.

2.40 [GTM_AI.341] TOM/ATOM: False generation of TRIG_CCU1 trigger signal in SOMP one-shot mode with OSM_TRIG=1 when CM1 is set to value 1

Description

Configuration in use:

- A/TOM[i]_CH[x]_CTRL.OSM=1
- A/TOM[i]_CH[x]_CTRL.OSM_TRIG=1
- A/TOM[i]_CH[x]_CTRL.UDMODE=00
- ATOM[i]_CH[x]_CTRL.MODE=10

Expected behavior

The generation of one-shot pulses in A/TOM can be initiated by the trigger event TRIG_[x-1] from trigger chain or by TIM_EXT_CAPTURE(x) trigger event from TIM, whereas the counter CN0 is reset to zero and starts counting. In this case the pulse generation comprises of an initial phase where the signal level at A/TOM output is inactive followed by a pulse. The duration of the initial phase is always as long until the counter CN0 reaches CM0-1.

After the counter CN0 reaches the value of CM0-1, the pulse starts with its active edge, CN0 is reset, and starts counting again. When CN0 reaches CM1-1, the inactive edge of the pulse occurs. Due to the fact, that the capture compare units CCU0 and CCU1 compare also in the initial phase of the pulse generation, the trigger conditions for these comparators apply also in this initial phase. Thus, the TRIG_CCU0 and TRIG_CCU1 signals also occur in the initial phase of the one-shot pulse. When these trigger signals are enabled in the A/TOM[i]_CH[x]_IRQ_EN, an interrupt signal is generated by A/TOM on the CCU0TC and CCU1TC trigger conditions and the corresponding A/TOM[i]_CH[x]_IRQ_NOTIFY bits are set.

Observed behavior

If the compare register CM1 is set to 1 and a new one-shot pulse is triggered, two effects can be observed:

- The first observed behavior is that the capture compare unit doesn't generate the TRIG_CCU1 trigger signal in the initial phase of the one-shot cycle
- The second observed behavior is that at the end of the operation phase of the one-shot cycle, where CN0 reaches CM0-1 a second time, the capture compare unit generates a TRIG_CCU1 trigger signal which is not expected at this point in time

Scope

TOM/ATOM

Effects

Missing TRIG_CCU1 trigger signal in initial phase of the one-shot cycle and unexpected TRIG_CCU1 trigger signal at the end of the operation phase of the one-shot cycle.

Workaround

Instead of using value 1 for CM1 it could be possible to generate the same pulse length by using a higher CMU_FXCLK/CMU_CLK frequency. Then, to get the same pulse length, the value of CM1 has to be multiplied by the difference of the two CMU_FXCLK/CMU_CLK frequencies.

Be aware that this workaround is only possible, if you are not already using the CMU_FXCLK(0) because there is no higher CMU_FXCLK frequency to select.

2 Functional deviations

Example for TOM : Instead of using CMU_FXCLK(1), which has the divider value 2^{**4} , use CMU_FXCLK(0), which has the divider value 2^{**0} . In this case, CM1 has to be configured with value 2^{**4} minus 2^{**0} which is equal to $2^{**4}-16$.

Hint : To get the same length of period, which defines the length of the initial phase, the value for the period in CM0 has to be multiplied by the same value.

A second limitation is that the maximum length of the period, which is configured in CM0, is limited. Using a higher CMU_FXCLK/CMU_CLK frequency reduces the maximum possible period.

2.41 [GTM_AI.345] SPE: Incorrect behaviour of direction change control via SPE_CMD.SPE_CTRL_CMD bits

Description

A direction change ("00" <-> "01") via SPE_CTRL_CMD disturbs the increment/decrement of the pat_ptr resulting in incorrect output patterns not corresponding to the input pattern position. Changing the direction bit in SPE_CTRL_CMD can also generate invalid IRQs.

Scope

SPE, TOM

Effects

Modifying the direction bit ("00" <-> "01") in SPE_CTRL_CMD does not provide the correct output pattern to the BLDC motor. Due to a wrong pat_ptr position incorrect output patterns will be sent to the motor, which are not correlated to the sensor position.

In addition the SPE logic can generate unpredictable IRQs (perr_irq, dchg_irq, bis_irq).

Workaround

Do not use SPE_CTRL_CMD.

Instead reprogram the SPE_OUT_PAT register to change the direction.

2.42 [GTM_AI.346] ATOM SOMS mode: Shift cycle is not executed correctly in case the reload condition is deactivated with ATOM[i]_AGC_GLB_CTRL.UPEN = 0

Description

ATOM is configured to SOMS continuous mode by setting the following configuration bit-fields:

- ATOM[i]_CH[x]_CTRL.MODE=11
- ATOM[i]_CH[x]_CTRL.OSM=0
- ATOM[i]_CH[x]_CTRL.ARU_EN=0
- ATOM[i]_AGC_GLB_CTRL.UPEN[x]=0b00

Expected behaviour

After the counter CN0 reaches CM0, no reload cycle is executed due to the configuration of UPEN=0b00. Instead of a reload cycle a shift cycle has to be executed to ensure an continuous shifting.

Observed behaviour

Neither a reload cycle nor a shift cycle is executed when the counter CN0 reaches CM0. The shifting stops and the shift register CM1 as well as the output ATOM[i]_CH[x]_OUT stays unexpectedly stable for two shift clock cycles whereas the counter CN0 continuously counting further on.

2 Functional deviations

Scope

ATOM

Effects

After the counter CN0 reaches CM0 the output stays stable for two shift clock cycles before the next shift will be executed.

Workaround

Increase the number of bits that have to be shifted out inside CM0 register to the maximum value of 23 to ensure an continuous shifting of all bits of the shift register CM1.

2.43 [GTM_AI.347] TOM/ATOM: Reset of (A)TOM[i]_CH[x]_CN0 with TIM_EXT_CAPTURE are not correctly synchronized to selected CMU_CLK/CMU_FXCLK

Description

To reset the counter (A)TOM[i]_CH[x]_CN0 (SOMP mode in ATOM), the input signal TIM_EXT_CAPTURE can be used by configuration of (A)TOM[i]_CH[x]_CTRL.EXT_TRIG=1 and (A)TOM[i]_CH[x]_CTRL.RST_CCU0=1.

The reset of the counter (A)TOM[i]_CH[x]_CN0 should happen synchronously to the internal selected CMU clock CMU_CLK/CMU_FXCLK. Therefore a synchronisation stage is implemented to synchronize the input signal TIM_EXT_CAPTURE to the internal selected CMU clock CMU_CLK/CMU_FXCLK.

It can be observed, that the reset of the counter is done immediately with the occurrence of the input signal TIM_EXT_CAPTURE and not as expected synchronously to the selected CMU clock enable CMU_CLK/CMU_FXCLK.

As a consequence of this, the output signal for the compare values 0 and 1 of (A)TOM[i]_CH[x]_CM1.CM1 and (A)TOM[i]_CH[x]_CM0.CM0 will not be set correctly.

Scope

ATOM, TOM

Effects

The output signal (A)TOM[i]_CH[x]_OUT is not set correctly for the compare values 0 and 1 of the operation register bitfields (A)TOM[i]_CH[x]_CM1.CM1 and (A)TOM[i]_CH[x]_CM0.CM0.

Workaround 1

Do not use clock dividing for the affected (A)TOM channels, so the undivided cluster clock is used. For this configure the control registers in the CMU and CCM to generate non-dividing CMU_FXCLK and/or CMU_CLK signals. Select within the (A)TOM the non-dividing CMU_FXCLK0 (for TOM) and/or CMU_CLK0..7 (for ATOM) via the settings for CLK_SRC in the (A)TOM[i]_CH[x]_CTRL register(s).

Workaround 2

Avoid the compare values 0 and 1 for the operation register bitfields (A)TOM[i]_CH[x]_CM1.CM1 and (A)TOM[i]_CH[x]_CM0.CM0.

2 Functional deviations

2.44 [GTM_AI.349] TOM-SPE: OSM-Pulse width triggered by SPE_NIPD for selected CMU_FXCLK not correct

Description

The SPE_NIPD signal is used to reset TOM_CH_CN0 and to generate a one-shot pulse. When the CMU_FXCLK of the corresponding TOM_CH is set to a value unequal to 0, there are two effects observed:

1. the first pulse triggered by SPE_NIPD is generated with the CMU_FXCLK(0), while any subsequent pulses are generated with the configured CMU_FXCLK;
2. the pulses generated with the correct CMU_FXCLK show no determinism. Some pulses end with CCU_TRIG1, some with CCU_TRIG0

Scope

TOM, SPE

Effects

The OSM-Pulse width triggered by SPE_NIPD are not correct.

Workaround

Use SYS_CLK by selecting CMU_FXCLK(0) instead of a value unequal to zero for CMU_FXCLK.

To reach the same pulse width on the output signal, the value for the period (TOM[i]_CH[x]_CM0.CM0) and duty cycle (TOM[i]_CH[x]_CM1.CM1) has to be scaled due to the relationship between SYS_CLK and the needed CMU_FXCLK.

2.45 [GTM_AI.350] TOM-SPE: Update of SPE[i]_OUT_CTRL triggered by SPE_NIPD not working for a delay value 1 in TOM[i]_CH[x]_CM1

Description

When configured in one-shot mode some TOM channels can initiate a delayed change of register SPE_OUT_CTRL. The delay can be configured in TOM[i]_CH[x]_CM1 register of the corresponding TOM channel.

Expected behaviour

The SPE_OUT_CTRL register changed its content after a delay of CMU_FXCLK cycles which are configured in the TOM channel. For CM1=0, no update is expected, for CM1=1, the update is expected with the next CMU_FXCLK, for CM1=2, a delay of two CMU_FXCLK clock cycles is expected.

Observed behaviour

For CM1=1, there is no change of SPE_OUT_CTRL at all, independent of CMU_FXCLK.

Scope

TOM, SPE

Effects

The update of SPE_OUT_CTRL register is not executed.

Workaround

Use SYS_CLK by selecting CMU_FXCLK(0) instead of a value unequal to zero for CMU_FXCLK.

2 Functional deviations

To get the trigger signal from TOM for the delayed update at the same time, the value for the period (TOM[i]_CH[x]_CM0.CM0) and duty cycle (TOM[i]_CH[x]_CM1.CM1) has to be scaled due to the relationship between SYS_CLK and the needed CMU_FXCLK.

2.46 [GTM_AI.352] ATOM: Wrong reload of data from ARU in SOMS and SOMP mode if TIM_EXT_CAPTURE(x) or TRIGIN(x) is selected as clock source

Description

ATOM configuration:

- SOMP or SOMS mode (ATOM[i]_CH[x]_CTRL.MODE=10_B/11_B)
- ARU input stream enabled (ATOM[i]_CH[x]_CTRL.ARU_EN=1)
- TRIGIN(x) or TIM_EXT_CAPTURE(x) as selected clock source (ATOM[i]_CH[x]_CTRL.CLK_SRC=1101_B/1110_B)

Expected behavior in SOMS mode

ATOM Channel in SOMS mode shifts all data provided by ARU.

Observed behavior in SOMS mode

An ARU read request is initiated and not cancelled after the first data was received from the ARU. The received data overwrites the previously received data in the ATOM[i]_CH[x]_SRy.SRy register (y=0,1).

In SOMS continuous mode with ATOM[i]_CH[x]_CTRL.OSM=0, an update of the ATOM[i]_CH[x]_CMy.CMy register (y=0,1) from last received data in ATOM[i]_CH[x]_SRy.SRy register (y=0,1) is executed at the end of the period.

In SOMS one-shot mode with ATOM[i]_CH[x]_CTRL.OSM=1, the ATOM channel stops after data is shifted out which was stored in shift register ATOM[i]_CH[x]_CM1.CM1 by the CPU. Data which was transferred via ARU stays in shadow register ATOM[i]_CH[x]_SR1.SR1 and will not be reloaded into the shift register; instead the channel stops.

Expected behavior in SOMP continuous mode

Synchronized to the beginning of a new period ATOM Channel requests new data from ARU. The received values from ARU are stored into the shadow registers. If the actual period is ended the stored values are copied from the shadow registers into the operation registers for the new period. At the same time, a new read request to the ARU is started.

Observed behavior in SOMP continuous mode

ATOM Channel requests new data from ARU without synchronization to the beginning of a new period. The received values are stored into the shadow registers and then copied directly into the operation registers. The next ARU read request is started immediately without synchronization to the actual period.

SOMP one-shot mode together with the reloading of values via the ARU is not supported and is therefore not affected by this ERRATUM.

Scope

ATOM

Effects

For the described modes the reloading and update of new values for the shadow registers from ARU is corrupted.

In the SOMS one-shot mode the channel stops.

2 Functional deviations

Workaround

If TIM_EXT_CAPTURE(x) is to be used as clock source, this can be configured within the CCM as clock source for one of the CMU clock sources. This clock source must then be selected in the ATOM itself.

If TRIGIN(x) is to be used as clock source, the output signal of the ATOM channel, which delivers the trigger signal TRIGIN(x), can be routed to TIM input as AUX_IN signal. Now the TIM_EXT_CAPTURE(x) signal from this TIM module can be used with the same workaround as described before for TIM_EXT_CAPTURE(x) clock source. An additional clock delay of 3 cluster clocks would need to be considered for the generation of the TRIGIN(x) source.

2.47 [GTM_AI.353] SPEC-ATOM: Specification of the smallest possible PWM period in SOMP mode wrong, when ARU_EN=1

Description

Configuration in use:

- ATOM[i]_CH[x]_CTRL.MODE=0b10 (SOMP)
- ATOM[i]_CH[x]_CTRL.ARU_EN=1
- ATOM[i]_AGC_GLB_CTRL.UPEN_CTRLx=1

Functionality

When ATOM[i]_CH[x]_CTRL.ARU_EN=1 and ATOM[i]_AGC_GLB_CTRL.UPEN_CTRLx=1 the PWM period and duty cycle (PWM characteristic) can be reloaded via ARU in SOMP mode. The ATOM generates a PWM on the operation registers ATOM[i]_CH[x]_CM0.CM0 and ATOM[i]_CH[x]_CM1.CM1 while the new values received via ARU are stored in the shadow registers ATOM[i]_CH[x]_SR0.SR0 and ATOM[i]_CH[x]_SR1.SR1.

Reloading of the ATOM[i]_CH[x]_CM0.CM0 and ATOM[i]_CH[x]_CM1.CM1 registers with the values from ATOM[i]_CH[x]_SR0.SR0 and ATOM[i]_CH[x]_SR1.SR1 takes place, when the old PWM period expires (ATOM[i]_CH[x]_CN0.CN0 reaches ATOM[i]_CH[x]_CM0.CM0 in up counter mode or ATOM[i]_CH[x]_CN0.CN0 reaches 0 in up/down counter mode).

Therefore, it is important, that the new PWM characteristic is available in the shadow registers ATOM[i]_CH[x]_SR0.SR0 and ATOM[i]_CH[x]_SR1.SR1 before ATOM[i]_CH[x]_CN0.CN0 reaches ATOM[i]_CH[x]_CM0.CM0 (up counter mode) or 0 (up/down counter mode).

Problem description

The GTM-IP specification defines as minimal possible PWM period, where the PWM characteristic can be reloaded in a predictable manner so that new data is always available in time at the ATOM channel, to be the ARU round trip time of the specific microcontroller device. This is not correct, because the data needs two additional ARU clock cycles to flow through the ARU from a source to the ATOM channel plus one clock cycle for loading the value from the shadow registers ATOM[i]_CH[x]_SR0.SR0 and ATOM[i]_CH[x]_SR1.SR1 to the registers ATOM[i]_CH[x]_CM0.CM0 and ATOM[i]_CH[x]_CM1.CM1.

When the PWM period is smaller than the ARU round trip time plus three ARU clock cycles, the PWM output is not correct.

Scope

SPEC-ATOM

Effects

When the ATOM channel operates in SOMP mode and receives updates of PWM period and/or duty cycle via ARU, new PWM period and/or duty cycle values get lost, when the PWM Period is smaller than the ARU round trip time plus one or two ARU clock cycles for the given microcontroller device the PWM Period runs on.

2 Functional deviations

Recommendation for TC2xx

The PWM period has to be larger than ARU round trip time + 3 ARU clock cycles.

Recommendation for TC3xx

The PWM period has to be larger than ARU round trip time + 3 ARU clock cycles. Alternatively use ARU dynamic routing, or reduce the value of ARU_CADDR_END to a value, which fits the PWM period. So, PWM period greater than ARU_CADDR_END + 1 + 3 ARU clock cycles.

2.48 [GTM_AI.358] TOM/ATOM: Synchronous update of working register for RST_CCU0=1 and UDMODE=0b01 not correct

Description

TOM/ATOM is configured in SOMP mode with ATOM[i]_CH[x]_CTRL.MODE="10" (only for ATOM) and up-down counter mode is enabled by setting of (A)TOM[i]_CH[x]_CTRL.UDMODE=0b01. With the additional configuration of (A)TOM[i]_CH[x]_CTRL.RST_CCU0=1, the counter direction from up to down is changed with the trigger signal from a preceding channel TRIGIN[x] or with the TIM_EXT_CAPTURE signal from TIM module.

Expected behaviour

The synchronous update of the working registers (A)TOM[i]_CH[x]_CM0 and (A)TOM[i]_CH[x]_CM1 in this configuration shall be done only when the channel counter (A)TOM[i]_CH[x]_CN0 reaches zero.

Observed behaviour

Additionally to the update of the working registers (A)TOM[i]_CH[x]_CM0 and (A)TOM[i]_CH[x]_CM1 when the channel counter (A)TOM[i]_CH[x]_CN0 reaches zero, the update is executed with the selected trigger signal TRIGIN[x] or TIM_EXT_CAPTURE(x). This is not expected in this configuration with (A)TOM[i]_CH[x]_CTRL.UDMODE=0b01.

Scope

TOM, ATOM

Effects

The synchronous update of the working register (A)TOM[i]_CH[x]_CM0 and (A)TOM[i]_CH[x]_CM1 is done unintendedly with the selected trigger signal TRIGIN[x] or TIM_EXT_CAPTURE.

Workaround

For settings where the PWM phases are longer than the register access times on target system: Ensure to deliver new data to the associated shadow registers (A)TOM[i]_CH[x]_SR0 and (A)TOM[i]_CH[x]_SR1 only when the channel counter ATOM[i]_CH[x]_CN0 is in down counting phase. The down counting phase is reported by the according interrupt.

The described workaround is only possible for ATOM as long as the ARU interface is disabled and the new shadow register values are delivered by configuration interface and not by ARU interface.

2 Functional deviations

2.49 [GTM_AI.359] TOM: Both edges on TOM_OUT_T at unexpected times for RST_CCU0=1 and UDMODE>0

Description

TOM channel is configured in up-down counter mode by setting of TOM[i]_CH[x]_CTRL.UDMODE>0 and the channel is triggered by a preceding channel or by TIM_EXT_CAPTURE with configuration of TOM[i]_CH[x]_CTRL.RST_CCU0=1.

Expected behaviour

In up-counting phase, the output signal TOM_OUT is set to SL when $CN0 \geq CM1$ and the second output signal TOM_OUT_T has to be set to SL when $CN0 \geq CM0$.

In down-counting phase the output signals has to be set to !SL when $CN0 < CM1/CM0$.

Observed behaviour

The second output signal TOM_OUT_T is set to SL in upcounting phase when $CN0 \geq CM0 - 1$, which is one CMU clock cycle too early.

When the counter is counting down, the output signal TOM_OUT_T is set to !SL when $CN0 < CM0 - 1$, which is one CMU clock cycle too late.

Scope

TOM

Effects

The second output signal TOM_OUT_T is set one CMU clock cycle too early in up-counting phase and one CMU clock cycle too late in down-counting phase.

Workaround

The compare value TOM[i]_CH[x]_CM0 for the second output signal TOM_OUT_T has to be configured with a value which is greater by one ($CM0+1$).

2.50 [GTM_AI.360] SPEC-(A)TOM: PCM mode (BITREV=1) is only available for UDMODE=0

Description

If TOM/ATOM channel is configured in PCM mode with (A)TOM[i]_CH[x]_CTRL.BITREV=1, the channel may be configured in up-counting mode only with (A)TOM[i]_CH[x]_CTRL.UDMODE=0.

Up-down counting mode ((A)TOM[i]_CH[x]_CTRL.UDMODE>0) is not supported for PCM mode.

Scope

TOM, ATOM

Effects

The user is not aware that the combination of PCM mode together with up-down counting mode is not supported and may not be used.

Workaround

Do not use the combination of PCM mode together with up-down counting mode.

2 Functional deviations

2.51 [GTM_AI.361] IRQ: Missing pulse in single-pulse interrupt mode on simultaneous interrupt and clear event

Description

In single-pulse interrupt mode ([MODULE]_IRQ_MODE = 0b11) only the first interrupt event of the interrupt bits of the interrupt notify register inside this module generates a pulse on the output signal IRQ_line, if the associated interrupt is enabled ([MODULE]_IRQ_EN=1). All further interrupt events have no effect on the output signal IRQ_line until all enabled interrupts are cleared, except when an interrupt and a clear event (HW_clear or a SW_clear) occur at the same time.

Expected behaviour

On simultaneous occurrence of an interrupt and clear event, a pulse on the output signal IRQ_line is generated.

Observed behaviour

If the associated notify register bit of the interrupt event is not set and another bit of the same notify register is set and this interrupt is enabled, no pulse on the output signal IRQ_line is generated.

All modules ([MODULE]) are affected by this ERRATUM, which are able to generate interrupts and which have multiple interrupt sources which are ORed to the output. Not affected are the modules DPLL and ARU.

Scope

IRQ

Effects

Missing pulse on interrupt signal IRQ_line.

All modules, which deliver an interrupt signal and have more than one internal interrupt source which are ORed are affected. The only exceptions are the modules ARU and DPLL.

Workaround

On a SW clear prevent HW clear events and read the interrupt notify register to check on new interrupts without a received interrupt pulse on IRQ_line. In this case repeat the SW clear step to enable interrupt generation again.

When disabling the HW clear is not an option refrain from using the single-pulse interrupt mode.

2.52 [GTM_AI.364] ATOM: ARU read request does not start at expected timepoint in UDMODE = 1 and UDMODE = 3

Description

ATOM is configured in SOMP continuous up-down counter mode with UDMODE = 1 or 3 and ARU interface is enabled by setting of ARU_EN = 1.

Expected behavior

A new ARU read request has to be started always after the operation registers are updated from their shadow registers. This depends on the UDMODE configuration:

- UDMODE = 1: New ARU read request after CN0 changes the count direction from down to up
- UDMODE = 2: New ARU read request after CN0 changes the count direction from up to down
- UDMODE = 3: New ARU read request in both cases

2 Functional deviations

Observed behavior

A new ARU read request is always started when the counter CN0 changes the count direction from up to down, independently from UDMODE configuration:

- UDMODE = 1: New ARU read request after CN0 changes the count direction from up to down
- UDMODE = 2: Works as expected
- UDMODE = 3: New ARU read request after CN0 changes the count direction from up to down

Scope

ATOM

Effects

The effect depends on the UDMODE configuration:

- UDMODE = 1: The remaining time, from starting a ARU read request until new data from ARU should be received is only half of the defined PWM period instead of the full PWM period
- UDMODE = 3: No new ARU read request is started when the counter CN0 changes the count direction from down to up and therefore no new data can be delivered in this case

Workaround

- Workaround for UDMODE = 1
The PWM period length in up-down counter mode has to be double the length as the ARU round trip cycle (plus 3 ARU clock cycles).
- Workaround for UDMODE = 3
Use AEI interface for reloading new shadow register values instead of ARU.

2.53 [GTM_AI.370] TOM/ATOM: Unexpected reset of CN0 in up-down counter mode and CM0 = 2

Description

TOM/ATOM is configured in SOMP mode with $ATOM[i]_{CH[x]}_{CTRL.MODE} = 10_B$ (only for ATOM) and up-down counter mode is enabled by setting of $(A)TOM[i]_{CH[x]}_{CTRL.UDMODE} \neq 00_B$.

Expected behavior

In this case, the counter CN0 changes its count direction from up to down either until CN0 reaches CM0-1 for $RST_CCU0 = 0$ or with the selected trigger signal TRIGIN ($EXT_TRIG = 0$) or EXT_TRIGIN ($EXT_TRIG = 1$) for $RST_CCU0 = 1$.

Observed behavior

There are three different configuration scenarios, where the counter CN0 is unexpectedly reset.

1. In case of $RST_CCU0 = 0$:
The period value inside CM0 is configured to 2 and then reconfigured to a value greater than 2. After the counter CN0 starts incrementing and reaches value 1, CN0 is once reset to 0 unexpectedly, before it starts incrementing again.
2. In case of $RST_CCU0 = 1$ and $EXT_TRIG = 0$:
The TRIGIN signal from a preceding channel is used to reset the count direction of CN0. After the period value CM0 of the preceding channel is reconfigured from value 2 to a greater value, CN0 of this channel, which is triggered by the preceding channel, is once reset to 0 similar to the first scenario, which happens in the preceding channel.
3. In case of $RST_CCU0 = 1$ and $EXT_TRIG = 1$:

2 Functional deviations

The EXT_TRIGIN signal from TIM module is used to reset the count direction of CN0. If the EXT_TRIGIN signal occurs while the counter CN0 is incrementing and reaches the value 1, CN0 is once reset unexpectedly. However, there is already no deterministic dependency between the EXT_TRIGIN signal and the reset of CN0.

Scope

TOM, ATOM

Effects

Unexpected reset of the counter CN0.

Workaround

No workaround available. The following limitations have to be considered.

For scenario 1 and 2:

- Do not use value 2 for the period, which is configured inside CM0

For scenario 3:

- Do not use EXT_TRIGIN as trigger signal to change the count direction in up-down counter mode

2.54 [GTM_AI.374] SPEC-ATOM: Statement on timing of duty cycle output level change not correct for SOMP up/down-counter mode

Description

The duty cycle output level is determined by ATOM[i]_CH[x]_CTRL.SL bit. The specification describes in section 15.3.3 “ATOM Signal output mode PWM (SOMP)” of the GTM chapter in the AURIX™ TC3xx User’s Manual, that “the duty cycle output level can be changed during runtime by writing the new duty cycle level into SL bit of the channels configuration register” (section 15.3.3.4). Further, it is mentioned: “the new signal level becomes active for the next trigger CCU_TRIGx (since bit SL is written)”.

However, the timing specification in the second part of the statement is only valid for the SOMP in up-counter mode. When the ATOM is configured in SOMP up/down-counter mode, the new signal level becomes immediately active, when the ATOM[i]_CH[x]_CTRL.SL bit is written.

Scope

ATOM

Effects

When the ATOM channel is configured in SOMP up/down-counter mode, a change of bit ATOM[i]_CH[x]_CTRL.SL will be visible immediately after the value is written by software and not, as described in the specification, with the next compare match event of one of the CCUx compare units.

Workaround

No workaround for SOMP up/down-counter mode. Use SOMP up-counter mode, if update of SL-Bit needed during runtime.

2 Functional deviations

2.55 [GTM_AI.375] ATOM: Data from ARU are read only once in SOMC mode even though ARU blocking mode is disabled while FREEZE = 1 and ENDIS = 0

Description

ATOM is configured in SOMC mode and ARU input stream is enabled and ARU blocking mode is disabled.

Configuration register setting:

ATOM[i]_CH[x]_CTRL.MODE == 01_B (SOMC mode)

ATOM[i]_CH[x]_CTRL.ARU_EN == 1_B (ARU input stream enabled)

ATOM[i]_CH[x]_CTRL.ABM == 0_B (ARU blocking mode disabled)

Expected behavior

If the channel gets disabled while ATOM[i]_CH[x]_CTRL.FREEZE is set, a pending ARU read request will still be held active, even if the current request is served from ARU with valid data. This is the expected non-blocking behavior.

Observed behavior

If the channel gets disabled while ATOM[i]_CH[x]_CTRL.FREEZE is set and afterward the ARU read request is served by an ARU read valid, the ARU read request is reset and no more data is requested from ARU interface. This corresponds to a blocking behavior.

Scope

ATOM

Effects

In SOMC mode and activated FREEZE mode, reading new compare values stops after the first received data instead of continuing data reads.

Workaround

Instead of using the ARU interface for reloading new compare values while the channel is in FREEZE mode, the configuration interface can be used to deliver the new compare values.

If DPLL is used as data source for the ATOM compare values, an MCS channel has to be used to first read the data from DPLL by ARU interface and afterward to write the data via MCS master interface to ATOM. The used MCS module has to be in the same cluster as the ATOM module.

2.56 [GTM_AI.376] TOM/ATOM: Interrupt trigger signals CCU0TC_IRQ and CCU1TC_IRQ are delayed by one CMU_CLK period related to the output signals

Description

Interrupt trigger signals CCU0TC_IRQ and CCU1TC_IRQ are delayed by one CMU_CLK period if the following configurations are used:

1. Both CCU0TC_IRQ and CCU1TC_IRQ are affected (ATOM: in SOMP mode) when the channel is configured in up-down counter mode ((A)TOM[i]_CH[x]_CTRL.UDMODE > 0)
2. CCU1TC_IRQ only is affected (ATOM: in SOMP mode) when the channel is configured in up-counter mode ((A)TOM[i]_CH[x]_CTRL.UDMODE == 0) and (A)TOM[i]_CH[x]_CTRL.SR0_TRIG is enabled

2 Functional deviations

Scope

ATOM, TOM

Effects

Interrupt signals CCU0TC_IRQ and CCU1TC_IRQ are raised with a delay of one CMU_CLK period.
Depending on the CMU_CLK period related to system frequency outside of GTM this can be an issue or none at all.

Workaround

None.

2.57 [GTM_AI.406] (A)TOM: FREEZE mode has no effect on (A)TOM_OUT_T in up-down counter mode with RST_CCU0 = 1

Description

The channel is set into FREEZE mode while it is configured in up-down counter mode and triggered by a preceding channel or by TIM_EXT_CAPTURE.

Configuration for TOM:

TOM[i]_CH[x]_CTRL.UDMODE > 0
TOM[i]_CH[x]_CTRL.RST_CCU0 = 1
TOM[i]_CH[x]_CTRL.FREEZE = 1 (FREEZE mode)
TOM[i]_TGC[g]_ENDIS_STAT.ENDIS_STAT = 0

Configuration for ATOM:

ATOM[i]_CH[x]_CTRL.MODE = 10_B (SOMP mode)
ATOM[i]_CH[x]_CTRL.UDMODE > 0
ATOM[i]_CH[x]_CTRL.RST_CCU0 = 1
ATOM[i]_CH[x]_CTRL.FREEZE = 1 (FREEZE mode)
ATOM[i]_AGC_ENDIS_STAT.ENDIS_STAT = 0

Expected behavior

In FREEZE mode when the channel is disabled, it is expected that the output signal (A)TOM_OUT as well as (A)TOM_OUT_T has to keep its last value.

Observed behavior

In FREEZE mode when the channel is disabled, the output signal (A)TOM_OUT_T is set to the inverted signal level (ATOM[i]_CH[x]_CTRL_SOMP.SL, TOM[i]_CH[x]_CTRL.SL) and does not keep its last value.

Scope

TOM, ATOM

Effects

Output signal (A)TOM_OUT_T is set to inverse signal level (ATOM[i]_CH[x]_CTRL_SOMP.SL, TOM[i]_CH[x]_CTRL.SL) and does not keep the value.

Workaround

None.

2 Functional deviations

2.58 [GTM_AI.408] (A)TOM-RTL: Missing edge on output signal (A)TOM_OUT when CN0 is reset with force update event

Description

The channel is configured in continuous up-counter mode. Then a new period is started with a force update event and reset of CN0 is activated.

Configuration for TOM:

TOM[i]_CH[x]_CTRL.UDMODE = 0

TOM[i]_TGC[g]_FUPD_CTRL.FUPD_CTRL[k] = 10_B

TOM[i]_TGC[g]_FUPD_CTRL.RSTCN0_CH[k] = 10_B

Configuration for ATOM:

ATOM[i]_CH[x]_CTRL.MODE = 10_B (SOMP mode)

ATOM[i]_CH[x]_CTRL.UDMODE = 0

ATOM[i]_AGC_FUPD_CTRL.FUPD_CTRL[k] = 10_B

ATOM[i]_AGC_FUPD_CTRL.RSTCN0_CH[k] = 10_B

Expected behavior

After the counter (A)TOM[i]_CH[x]_CN0.CN0 has been reset and therefore a new period has to be started and the output signal (A)TOM_OUT has to be set immediately to the SL value (ATOM[i]_CH[x]_CTRL_SOMP.SL, TOM[i]_CH[x]_CTRL.SL), and after the counter reaches (A)TOM[i]_CH[x]_CM1.CM1, an edge on (A)TOM_OUT to the inverted SL value (ATOM[i]_CH[x]_CTRL_SOMP.SL, TOM[i]_CH[x]_CTRL.SL) is expected.

Observed behavior

An edge on the output signal (A)TOM_OUT to the SL value (ATOM[i]_CH[x]_CTRL_SOMP.SL, TOM[i]_CH[x]_CTRL.SL) at the beginning of the new period does not happen. Instead, the output signal (A)TOM_OUT holds its last value.

A second observation is in case the SL value (ATOM[i]_CH[x]_CTRL_SOMP.SL, TOM[i]_CH[x]_CTRL.SL) changes synchronously together with the force update event, an edge on (A)TOM_OUT to the inverted SL value (ATOM[i]_CH[x]_CTRL_SOMP.SL, TOM[i]_CH[x]_CTRL.SL) when (A)TOM[i]_CH[x]_CN0.CN0 reaches (A)TOM[i]_CH[x]_CM1.CM1 does not happen.

Scope

TOM, ATOM

Effects

Missing edge and false output signal level on (A)TOM_OUT.

Workaround

None.

2.59 [GTM_AI.410] GTM_AEI: The AEI bridge might not execute an accepted write transaction

Description

If the AEI Bridge operates in pipeline mode while a soft-reset is issued (writing BRIDGE_MODE.BRG_RST = '1'), upcoming write transactions primed in the buffer although accepted may never be actually executed. The maximum number of non-executed transactions depends on the buffer depth (BRIDGE_BUFF_DPT).

2 Functional deviations

Scope

GTM_AEI

Effects

Write transaction is signaled to be accepted but will never be executed.

Workaround

Issue a read access after the soft reset.

2.60 [GTM_AI.411] A change of the BRIDGE_MODE register might be delayed indefinitely

Description

After a write access to the BRIDGE_MODE register, the bit-fields BRG_MODE and BYPASS_SYNC will not be updated until the transaction buffer is empty. In split mode the bridge allows new transactions to be added to the buffer, even when an update of these bits is pending.

Polling the register in split mode might prevent the buffer from getting empty and as a result prevents the actual update of the described bit-fields.

Note: *Bit-field BYPASS_SYNC is not specified for TC2xx.*

Scope

GTM_AEI

Effects

Frequently polling the BRIDGE_MODE register ends in a deadlock.

Workaround 1

After every failed attempt to read back the new values, increase the wait time before issuing the next read transaction.

Workaround 2

Use standard mode (which is entered by setting AEI_PIPE and AEI_SPLIT at zero while asserting AEI_SEL) to write and read back the affected bits.

Note: *This workaround is only possible in devices without AXIS.*

2.61 [GTM_AI.419] TIM: Potentially wrong capture values

Description

Configuration: The TIM channel is configured in TIEM, TIPM, TGPS or TSSM mode by setting of $TIM[i]_{CH[x]}_{CTRL}.TIM_MODE = \{010_B, 011_B, 101_B, 110_B\}$. The TIM channel is disabled ($TIM[i]_{CH[x]}_{CTRL}.TIM_EN=0$) and later enabled again ($TIM[i]_{CH[x]}_{CTRL}.TIM_EN = 1$).

2 Functional deviations

Expected behavior for TIEM/TIPM/TGPS mode

The registers TIM[i]_CH[x]_CNT, TIM[i]_CH[x]_ECNT.ECNT[15:1], TIM[i]_CH[x]_GPR0 and TIM[i]_CH[x]_GPR1 are set to their reset values. In case of an input signal edge or an input capture event or an active selected CMU clock (TGPS mode) at the same time as the channel is enabled, this event has to be taken into account and the TIM[i]_CH[x]_CNT register must be updated/incremented based on its reset value. Due to this a capture event can happen depending on the configured TIM mode and the register values.

Expected behavior for TSSM mode

The registers TIM[i]_CH[x]_CNT, TIM[i]_CH[x]_ECNT.ECNT[15:1], TIM[i]_CH[x]_GPR0 and TIM[i]_CH[x]_GPR1 are set to their initial values. The initial value for TIM[i]_CH[x]_CNT register depends on TIM[i]_CH[x]_CTRL.ISL and TIM[i]_CH[x]_CNTS.CNTS(22). If TIM[i]_CH[x]_CNTS.CNTS(22) is set to 0 and TIM[i]_CH[x]_CTRL.ISL is set to 0 the initial value of TIM[i]_CH[x]_CNT is 0x000000. An input signal event simultaneously to the channel enable is not taken into account.

Observed behavior for TIEM/TIPM/TGPS mode

If no input signal event or input capture event or active selected CMU clock (TGPS mode) occurs, the registers TIM[i]_CH[x]_CNT, TIM[i]_CH[x]_ECNT.ECNT[15:1], TIM[i]_CH[x]_GPR0 and TIM[i]_CH[x]_GPR1 are set to their reset values as expected.

If an input signal event or an input capture event or an active selected CMU clock (TGPS mode) occurs at same time as the channel gets enabled, the TIM[i]_CH[x]_CNT register continues to count (or update) based on the previous (old) value. As a result, a capture could be performed too early and/or with the wrong values. The TIM[i]_CH[x]_ECNT.ECNT[15:1] register is set to its reset value as expected.

Observed behavior for TSSM mode

The register TIM[i]_CH[x]_CNT is not set to its initial value of 0x000000 on channel enabling when TIM[i]_CH[x]_CNTS.CNTS(22) is set to 0 and TIM[i]_CH[x]_CTRL.ISL is set to 0.

Note: The TIM channel modes TPWM, TPIM and TBCM (TIM[i]_CH[x]_CTRL.TIM_MODE = {000_B, 001_B, 100_B}) are not affected.

Scope

TIM

Effects

TIM[i]_CH[x]_CNT register is not reset and the wrong values could be captured into TIM[i]_CH[x]_GPR0 and TIM[i]_CH[x]_GPR1 registers.

Workaround 1

Reset the TIM channel by setting of TIM[i]_RST.RST_CH[x] = 1 before enabling the TIM channel.

Workaround 2

The following sequence has to be executed on the disabled channel, but before the actual enabling of the channel to ensure that the TIM[i]_CH[x]_CNT register is set to its reset value when the channel is enabled.

1. Configure TIM[i]_CH[x]_CNTS = 0
2. Enable the TIM channel with the following configuration inside the TIM[i]_CH[x]_CTRL register:
 - TIM_EN = 1
 - TIM_MODE = 101_B (TGPS)
 - ISL = 1

2 Functional deviations

- OSM = 1
 - ARU_EN = 0
 - select a fast CMU_CLK_RES, e.g. CLK_SEL = 000_B
3. Wait until an edge on the selected CMU_CLK_RES occurs. This can be observed on the NEWVAL IRQ notify register. This event sets the TIM[i]_CH[x]_CNT register to its reset value
 4. Disable TIM channel (TIM[i]_CH[x]_CTRL.TIM_EN = 0)
 5. Configure the former TIM channel configuration in TIM[i]_CH[x]_CTRL register and enable the TIM channel again

2.62 [GTM_AI.421] GTM_AEI: Changing BRIDGE_MODE.MSK_WR_RSP in pipeline mode can lead to violation of pipeline protocol

Description

In pipeline mode, a reconfiguration of the BRIDGE_MODE.MSK_WR_RSP directly after another write transaction can lead to a hang of following write transactions by not setting the AEI_READY.

Note: Please also check on errata GTM_AI.487 and GTM_AI.488.

Scope

GTM_AEI

Effects

Transaction not terminated according to protocol, user might be stuck waiting for AEI_READY to be set.

Workaround

Make sure the transaction preceding the write of BRIDGE_MODE.MSK_WR_RSP is a read transaction.

2.63 [GTM_AI.429] TIM: Missing glitch detection interrupt event

Description

Configuration:

TIM filter is configured in immediate edge propagation mode by setting TIM[i]_CH[x]_CTRL.FLT_MODE_RE = 0 or TIM[i]_CH[x]_CTRL.FLT_MODE_FE = 0. The filter is enabled by setting TIM[i]_CH[x]_CTRL.FLT_EN = 1.

Expected behavior

As long as the filter threshold is not reached and the input signal level unexpectedly changes (it is an input glitch occurs), the internal glitch detection interrupt event signal (TIM_GLITCHDET_IRQ) should have a HIGH pulse of one cluster clock cycle.

Observed behavior

When the input signal glitch occurs at the same time the filter counter reaches its threshold, the internal glitch detection interrupt event signal (TIM_GLITCHDET_IRQ) does not occur.

Scope

TIM

2 Functional deviations**Effects**

The TIM[i]_CH[x]_IRQ_NOTIFY.GLITCHDET bit is not set. Thus, no interrupt is triggered. Furthermore, the external capture source EXT_CAPTURE(x) is not triggered if its source is set to TIM_GLITCHDET_IRQ.

Workaround

The filter counter threshold can be set to the next higher value. Thus, a former not detected glitch would be detected. In that case, the output signal would be changed (one clock cycle longer) when the input signal is a single cycle pulse.

2.64 [GTM_AI.430] TIM: Unexpected increment of filter counter**Description**

Configuration: TIM filter is configured in immediate edge propagation mode by setting TIM[i]_CH[x]_CTRL.FLT_MODE_RE = 0 and/or TIM[i]_CH[x]_CTRL.FLT_MODE_FE = 0. The filter is enabled by setting TIM[i]_CH[x]_CTRL.FLT_EN = 1. The filter counter threshold is set to zero by setting TIM[i]_CH[x]_FLT_RE.FTL_RE = 0 and/or TIM[i]_CH[x]_FLT_FE.FTL_FE = 0.

Expected behavior

When the input signal level changes, the filter counter should not increment.

Observed behavior

When the input signal level changes, the filter counter increments by one and is not reset.

Scope

TIM

Effects

If an input edge occurs during the acceptance time, the following output signal change will happen one or more selected CMU clock cycles earlier than expected. This depends on the initial configuration and the reconfiguration of the filter mode and the filter counter threshold. If the filter mode for both edges is configured to immediate edge propagation and both filter counter thresholds are set to zero, the counter falsely can count up to a higher value than one without resetting. If one or both filter modes and/or thresholds are reconfigured during the application, the higher count of the filter counter can lead to a difference of more than one CMU clock cycle between the expected and actual output signal change at the next occurring input edge. If only one filter counter threshold is set to zero, the difference of the expected and actual output signal change is one CMU clock cycle.

Workaround

If acceptable, use a threshold greater than zero. Otherwise there is no workaround available. However, there is a possibility of minimizing the absolute error, deriving from this bug. If possible, a faster CMU clock can be selected. This leads to a shorter absolute time difference between the expected and actual output signal change. Additionally when applying this, the filter counter thresholds need to be assimilated proportionally in order to make the filter work as before.

2 Functional deviations

2.65 [GTM_AI.431] TIM: Glitch detection interrupt event of filter is not a single cycle pulse

Description

Configuration: The TIM filter must be enabled by setting `TIM[i]_CH[x]_CTRL.FLT_EN = 1`.

Expected behavior

As long as the filter threshold is not reached and the input signal level changes unexpectedly, the glitch detection interrupt event signal (`TIM_GLITCHDET_IRQ`) should have a single cycle HIGH pulse.

Observed behavior

When the input signal level changes unexpectedly for longer than one clock cycle, the glitch detection interrupt event signal (`TIM_GLITCHDET_IRQ`) is HIGH as long as the unexpected signal change is present.

Scope

TIM

Effects

- Effect 1: The longer lasting HIGH signal of the glitch detection interrupt event signal (`TIM_GLITCHDET_IRQ`) may lead to an unexpected behavior within the GTM only if `TIM_GLITCHDET_IRQ` is used for the external capture signal `EXT_CAPTURE(x)`.
- Effect 2: If the related interrupt notify register (`TIM[i]_CH[x]_IRQ_NOTIFY`) is cleared by software while the `TIM_GLITCHDET_IRQ` signal is still HIGH, the interrupt will unexpectedly retrigger.

Workaround

No workaround in hardware.

For the unexpected retrigger of the interrupt directly after an interrupt clear step, the interrupt routine has to consider that the interrupt might be invalid.

2.66 [GTM_AI.442] GTM Top Level: GTM_HALT mode not functional when cluster 0 clock is disabled

Description

When entering the halt mode (`GTM_HALT` activated by `gtm_halt_req=1`), all functional operation of the GTM shall stop. In case if the cluster 0 is switched off by `GTM_CLS_CLK_CFG.CLS_CLK_DIV0=00B`, the GTM operation will not stop for all clusters > 0 correctly. Operation of GTM functionality will partly continue, which is unexpected.

Scope

GTM Top Level

Effects

Functional operation of GTM is not completely stopped although `gtm_halt_req` is set and `GTM_HALT` mode is started. This will lead to an undefined state of the GTM and the GTM cannot be reliably resumed out of this state.

Workaround

No workaround available.

2 Functional deviations

Make sure to turn on the cluster 0 clock before setting gtm_halt_req=1 to switch to GTM_HALT mode.

2.67 [GTM_AI.454] (A)TOM: No output if trigger generation feature is used

Description

For trigger generation ((A)TOM[i]_CH[x]_CTRL.SR0_TRIG=1) in up-down counter mode ((A)TOM[i]_CH[x]_CTRL.UDMODE>0) neither a new PWM on (A)TOM_OUT nor an additional trigger output on (A)TOM_OUT_T is generated if (A)TOM[i]_CH[x]_SR0.SR0 register is configured to zero.

Scope

TOM, ATOM

Effects

No module output signals (A)TOM_OUT and (A)TOM_OUT_T are generated.

Workaround

A second (A)TOM channel z can be used to generate a trigger signal on (A)TOM_OUT_T for (A)TOM[i]_CH[z]_SR0.SR0=0. The channel has to be configured in up counter mode ((A)TOM[i]_CH[z]_CTRL.UDMODE=0) with a period value calculated by (A)TOM[i]_CH[x]_CM0.CM0*2-2 related to the period value of the first channel x. Both channels have to be started synchronously via the TGC/AGC mechanisms.

2.68 [GTM_AI.462] (A)TOM: Missing CCU0TC_IRQ interrupt signal

Description

Configuration:

The channel is configured in SOMP (ATOM) up-counter mode with up/down counter mode disabled ((A)TOM[i]_CH[x]_CTRL.UDMODE=0) or not existing and triggering by a preceding channel with configuration of (A)TOM[i]_CH[x]_CTRL.RST_CCU0=1.

Expected behavior

When the counter (A)TOM[i]_CH[x]_CN0.CN0 reaches the value of (A)TOM[i]_CH[x]_CM0.CM0, the interrupt signal CCU0TC_IRQ must be triggered.

Observed behavior

In the first period after (A)TOM[i]_CH[x]_CM0.CM0 is changed to the value 0 or 1, no CCU0TC_IRQ interrupt signal is triggered.

Note: When the second period starts after (A)TOM[i]_CH[x]_CM0.CM0 is changed to the value 0 or 1 and stays at that value, then the CCU0TC_IRQ interrupt signal generation works correctly.

Scope

TOM, ATOM

Effects

Interrupt signal CCU0TC_IRQ is not triggered.

2 Functional deviations

Workaround

No workaround available.

It needs to be checked if the application can accept the interrupt occurring with the second period.

2.69 [GTM_AI.465] (A)TOM: Missing CCU0TC_IRQ interrupt signal for UDMODE > 0

Description

Configuration:

The channel is configured in SOMP (ATOM) up/down counter mode with (A)TOM[i]_CH[x]_CTRL.UDMODE>0 and will be triggered by a preceding channel with configuration of (A)TOM[i]_CH[x]_CTRL.RST_CCU0=1.

Expected behavior

When the counter (A)TOM[i]_CH[x]_CN0.CN0 reaches in the up-counting phase the value of (A)TOM[i]_CH[x]_CM0.CM0, the interrupt signal CCU0TC_IRQ must be triggered.

Observed behavior

In the first period after (A)TOM[i]_CH[x]_CM0.CM0 is changed to the value 0, the CCU0TC_IRQ interrupt signal is triggered but not in the following periods with unchanged value of (A)TOM[i]_CH[x]_CM0.CM0=0.

A second observation is that the CCU0TC_IRQ interrupt signal is not triggered in the first period after the value of (A)TOM[i]_CH[x]_CM0.CM0 is changed from 0 to 1.

Note: *in this case, the CCU0TC_IRQ interrupt is triggered in the following periods with unchanged value of 1 for (A)TOM[i]_CH[x]_CM0.CM0.*

Scope

TOM, ATOM

Effects

Interrupt signal CCU0TC_IRQ is not triggered.

Workaround

No workaround available.

If applicable use the interrupt indication from the preceding channel, which is always generated half a period earlier.

2.70 [GTM_AI.466] TOM: Unexpected behavior of TOM_OUT_T for UDMODE>0

Description

Configuration:

The channel is configured in up-down counter mode with TOM[i]_CH[x]_CTRL.UDMODE>0 and will be triggered by a preceding channel with configuration of TOM[i]_CH[x]_CTRL.RST_CCU0=1.

2 Functional deviations

Expected behavior

The output signal TOM_OUT_T has to be set to TOM[i]_CH[x]_CTRL.SL value as long as the condition TOM[i]_CH[x]_CN0.CN0 >= TOM[i]_CH[x]_CM0.CM0 is true.

Observed behavior for TOM[i]_CH[x]_CM0.CM0=0

The output signal TOM_OUT_T is set to TOM[i]_CH[x]_CTRL.SL value only for one clock period of the selected CMU clock when TOM[i]_CH[x]_CN0.CN0 has reached 0. Afterwards TOM_OUT_T is set unexpectedly to the inverted value of TOM[i]_CH[x]_CTRL.SL.

Observed behavior for TOM[i]_CH[x]_CM0.CM0=1

An unexpected pulse on the output signal TOM_OUT_T with the length of one clock period of the selected CMU clock to the inverted value of TOM[i]_CH[x]_CTRL.SL can be observed when the trigger input signal TRIGIN occurs and the counter TOM[i]_CH[x]_CN0.CN0 starts to count down.

Scope

TOM

Effects

Output signal TOM_OUT_T behaves not as expected.

Workaround

No workaround available.

2.71 [GTM_AI.487] GTM_AEI: Changing BRIDGE_MODE[2:0] in pipeline mode can lead to violation of pipeline protocol

Description

The issue from erratum GTM_AI.421 ("GTM_AEI: Changing BRIDGE_MODE.MSK_WR_RSP in pipeline mode can lead to violation of pipeline protocol") not only appears when BRIDGE_MODE.MSK_WR_RSP changes, but also when it stays '1' while the other configuration bit-fields in BRIDGE_MODE.BYPASS_SYNC and/or BRIDGE_MODE.BRG_MODE change.

Please also check on erratum GTM_AI.488

Scope

GTM_AEI

Effects

Transaction not terminated according to protocol, user might be stuck waiting for AEI_READY to be set.

Workaround

Make sure the transaction preceding the write of the mentioned BRIDGE_MODE bit-fields is a read transaction. This workaround matches the workaround from GTM_AI.421.

2 Functional deviations

2.72 [GTM_AI.488] GTM_AEI: Turning off BRIDGE_MODE.MSK_WR_RSP in asynchronous mode might lead to following transactions being corrupted

Description

If the AEI bridge operates in asynchronous mode and in pipelined protocol, with Mask-Write-Response turned on ($\text{BRIDGE_MODE}[2:0] = 011_B$) and the $\text{BRIDGE_MODE.MSK_WR_RSP}$ is turned off (by writing $\text{BRIDGE_MODE}[2:0] = 001_B$), the following transaction might be corrupted by the AEI_READY not being set. This is an issue like in GTM_AI.421 and GTM_AI.487 but a different workaround is needed.

Scope

GTM_AEI

Effects

Transaction not terminated according to protocol, user might be stuck waiting for AEI_READY to be set.

Workaround

Change $\text{BRIDGE_MODE.MSK_WR_RSP}$ together with setting the software reset (pipeline writing $\text{BRIDGE_MODE}[16:0] = 10001_H$).

2.73 [GTM_AI.516] SPE-RTL: IRQ raised on disabled inputs

Description

The inputs for the interrupt generation of the $\text{SPE}[i]_{\text{IRQ_NOTIFY.SPE_PERR}}$ are not fed by the masked input signals. Hence, an interrupt $\text{SPE}[i]_{\text{IRQ_NOTIFY.SPE_PERR}}$ will occur when there is a pattern mismatch detected on the corresponding TIM channels beside active masking ($\text{SPE}[i]_{\text{CTRL_STAT.SIE}(k)} = 0$).

Scope

SPE

Effects

An interrupt will be raised on masked input signals instead of ignoring these.

Workaround

Do not toggle (it is not used) the TIM channels that are disabled on the input side of the SPE.

2.74 [GTM_AI.517] (A)TOM: Missing edge on output signal (A)TOM_OUT

Description

If an (A)TOM channel is configured to be triggered by a previous channel by setting of $(A)TOM[i]_{\text{CH}[x]_{\text{CTRL.RST_CCU0}}} = 1$ (SOMP mode in ATOM) and there is a pipeline register within the trigger chain between the triggering channel and the triggered channel, the edge to the inverse SL at the output signal (A)TOM_OUT is not generated for $(A)TOM[i]_{\text{CH}[x]_{\text{CM1.CM1}}} = 1$ and $(A)TOM[i]_{\text{CH}[x]_{\text{CM0.CM0}}} > 1$.

The problem only occurs if the selected clock resolution for the triggered channel has a divider factor of more than 1 related to the cluster clock.

2 Functional deviations

Scope

TOM, ATOM

Effects

Missing edge on output signal (A)TOM_OUT.

Workaround 1

If available use channels without a pipeline register within the trigger chain between the triggering channel and the triggered channel.

Workaround 2

Switch the order of the edges, so that (A)TOM[i]_CH[x]_CM1.CM0.CM0 defines the first edge and (A)TOM[i]_CH[x]_CM1.CM1.CM1 the second edge. Additionally invert the SL value to get the same waveform on the output signal (A)TOM_OUT.

Note: *In this case, to generate 0% duty cycle, do not use (A)TOM[i]_CH[x]_CM1.CM1=(A)TOM[i]_CH[x]_CM0.CM0. Instead, use (A)TOM[i]_CH[x]_CM1.CM1=1 and (A)TOM[i]_CH[x]_CM0.CM0=MAX. However, this only works in the non-fixed (relevant) releases.*

Workaround 3

Use a clock resolution for the triggered channel with a divider value of 1 related to the cluster clock.

2.75 [GTM_TC.020] Debug/Normal read access control via bit-field ODA.DRAC

Description

A few GTM registers have a different read behavior when accessing them with debug read accesses (see section “GTM Software Debugger Support” in the GTM chapter of the User’s Manual for further details).

Depending on the reading master and the configuration of bit-field DRAC in register GTM_ODA (OCDS Debug Access Register), the read can be performed in a specific way for debug related read operation.

According to the User’s Manual the read is performed as a debug read operation

- for all masters when ODA.DRAC = 10_B or 11_B
- for the Cerberus (OCDS) FPI master when ODA.DRAC = 00_B

Problem Description

In the current implementation the read is performed as debug read operation

- for all masters when ODA.DRAC = 10 or 11_B
- for the CPU2 FPI master when ODA.DRAC = 00_B

Workaround

The problem described above has 2 aspects:

1. For CPU2 Access to GTM

When the CPU2 FPI master is used to perform a normal read of the GTM registers mentioned above, setting ODA.DRAC = 01_B is required to avoid an unintended debug read access that would be caused by this issue.

2 Functional deviations

2. For Cerberus (OCDS) Access to GTM

When ODA.DRAC = 00_B, due to this problem any read access of the Cerberus (OCDS) FPI master to the registers that by default have a different behavior between normal and debug read will cause the normal read behavior. To get the intended debug read behavior, ODA.DRAC needs to be set to 10_B or 11_B before each access of the Cerberus and set back to 00_B afterwards to not affect the access of other FPI masters on the registers mentioned above.

2.76 [GTM_TC.026] Table “GTM IP Application Constraints” #1 (DPLL) - Documentation correction

Description

In table “GTM IP Application Constraints” in the GTM chapter of the AURIX™ TC3xx User’s Manual, in the first row, the unit of the required time for item #1 (Increment duration (time between two valid inputs of the DPLL: TRIGGER/STATE)) is erroneously listed as > 23.4 ms instead of > 23.4 μ s.

Documentation correction

The unit of the required time for item #1 (Increment duration (time between two valid inputs of the DPLL: TRIGGER/STATE)) in table “GTM IP Application Constraints” shall be corrected to > 23.4 μ s.

2.77 [GTM_TC.031]Connections of ADC_TRIG4 signals - Correction in TC3xx appendix

Description

In the table "Connections of ADC_TRIGx Signals to ADC/SENT Modules" in the GTM chapter of the product specific appendix to the TC3xx user manual, the following EVADC connections in section "ADC_TRIG4" are incorrect:

- G*REQGTL, G*REQTRL (should be G*REQGTG, G*REQTRG)

Documentation correction

The EVADC connections in the section "ADC_TRIG4" in the table "Connections of ADC_TRIGx Signals to ADC/SENT Modules" in the GTM chapter of the corresponding appendix shall be replaced by the following corrected section, depending on the particular product.

Note: This documentation issue is related to the appendix of the TC3xx user manual for TC3Ex, TC38x, TC37x, TC37xEXT, TC36x and TC33x/TC32x. For TC39x, see erratum GTM_TC.029.

Table 5 Connections of ADC_TRIGx Signals to ADC/SENT Modules - Correction for ADC_TRIG4 in TC3Ex and TC38x appendix

GTM Trigger Signal	EVADC	EDSADC	SENT
ADC_TRIG4			
ADC_TRIG4_[7:0]	-	G[7:0]REQGTG G[7:0]REQTRG	-
ADC_TRIG4_[9:8]	FC[1:0]REQTRM	G[9:8]REQGTG G[9:8]REQTRG	-
ADC_TRIG4_[11:10]	-	G[11:10]REQGTG G[11:10]REQTRG	-

2 Functional deviations

Table 6 **Connections of ADC_TRIGx Signals to ADC/SENT Modules - Correction for ADC_TRIG4 in TC37x and TC37xEXT appendix**

GTM Trigger Signal	EVADC	EDSADC	SENT
ADC_TRIG4			
ADC_TRIG4_[3:0]	-	G[3:0]REQGTG	G[3:0]REQTRG
ADC_TRIG4_[7:4]	-	-	-
ADC_TRIG4_[9:8]	FC[1:0]REQTRM	G[9:8]REQGTG	G[9:8]REQTRG
ADC_TRIG4_[11:10]	-	G[11:10]REQGTG	G[11:10]REQTRG

Table 7 **Connections of ADC_TRIGx Signals to ADC/SENT Modules - Correction for ADC_TRIG4 in TC36x appendix**

GTM Trigger Signal	EVADC	EDSADC	SENT
ADC_TRIG4			
ADC_TRIG4_[3:0]	-	G[3:0]REQGTG	G[3:0]REQTRG
ADC_TRIG4_[7:4]	-	-	-
ADC_TRIG4_[9:8]	FC[1:0]REQTRM	G[9:8]REQGTG	G[9:8]REQTRG
ADC_TRIG4_[11:10]	-	-	-

Table 8 **Connections of ADC_TRIGx Signals to ADC/SENT Modules - Correction for ADC_TRIG4 in TC33x/TC32x appendix**

GTM Trigger Signal	EVADC	SENT
ADC_TRIG4		
ADC_TRIG4_[1:0]	G[1:0]REQGTG	G[1:0]REQTRG
ADC_TRIG4_[3:2]	-	-
ADC_TRIG4_[7:4]	-	-
ADC_TRIG4_[9:8]	G[9:8]REQGTG	G[9:8]REQTRG
ADC_TRIG4_[11:10]	-	-

2.78 [MCMCAN_AI.015] Edge filtering causes mis-synchronization when falling edge at Rx input pin coincides with end of integration phase

Description

When edge filtering is enabled (CCCRi.EFBI = '1') and when the end of the integration phase coincides with a falling edge at the Rx input pin it may happen, that the MCMCAN synchronizes itself wrongly and does not correctly receive the first bit of the frame. In this case the CRC will detect that the first bit was received incorrectly, it will rate the received FD frame as faulty and an error frame will be send.

The issue only occurs, when there is a falling edge at the Rx input pin within the last time quantum (tq) before the end of the integration phase. The last time quantum of the integration phase is at the sample point of the 11th recessive bit of the integration phase. When the edge filtering is enabled, the bit timing logic of the MCMCAN sees the Rx input signal delayed by the edge filtering. When the integration phase ends, the edge filtering is automatically disabled. This affects the reset of the FD CRC control unit at the beginning of the

2 Functional deviations

frame. The Classical CRC control unit is not affected, so this issue does not affect the reception of Classical frames.

In CAN communication, the MCMCAN may enter integrating state (either by resetting CCCRI.INIT or by protocol exception event) while a frame is active on the bus. In this case the 11 recessive bits are counted between the acknowledge bit and the following start of frame. All nodes have synchronized at the beginning of the dominant acknowledge bit. This means that the edge of the following start of frame bit cannot fall on the sample point, so the issue does not occur. The issue occurs only when the MCMCAN is, by local errors, mis-synchronized with regard to the other nodes, or not synchronized at all.

Glitch filtering as specified in ISO 11898-1:2015 is fully functional.

Edge filtering was introduced for applications where the data bit time is at least two t_q (of the nominal bit time) long. In that case, edge filtering requires at least two consecutive dominant time quanta before the counter counting the 11 recessive bits for idle detection is restarted. This means edge filtering covers the theoretical case of occasional 1- t_q -long dominant spikes on the CAN bus that would delay idle detection. Repeated dominant spikes on the CAN bus would disturb all CAN communication, so the filtering to speed up idle detection would not help network performance.

When this rare event occurs, the MCMCAN sends an error frame and the sender of the affected frame retransmits the frame. When the retransmitted frame is received, the MCMCAN has left integration phase and the frame will be received correctly. Edge filtering is only applied during integration phase, it is never used during normal operation. As integration phase is very short with respect to “active communication time”, the impact on total error frame rate is negligible. The issue has no impact on data integrity.

The MCMCAN enters integration phase under the following conditions:

- when CCCRI.INIT is set to '0' after start-up
- after a protocol exception event (only when CCCRI.PXHD = '0')

Scope

The erratum is limited to FD frame reception when edge filtering is active (CCCRI.EFBI = '1') and when the end of the integration phase coincides with a falling edge at the Rx input pin.

Effects

The calculated CRC value does not match the CRC value of the received FD frame and the MCMCAN sends an error frame. After retransmission the frame is received correctly.

Workaround

Disable edge filtering or wait on retransmission in case this rare event happens.

2.79 [MCMCAN_AI.017] Retransmission in DAR mode due to lost arbitration at the first two identifier bits

Description

When the MCMCAN CAN Node is configured in DAR mode (CANx.CCCRI.DAR = '1') the Automatic Retransmission for transmitted messages that have been disturbed by an error or have lost arbitration is disabled. When the transmission attempt is not successful, the Tx Buffer's transmission request bit (CANx.TXBRPi.TRPz) shall be cleared and its cancellation finished bit (CANx.TXBCFi.CFz) shall be set.

When the transmitted message loses arbitration at one of the first two identifier bits, it may happen, that instead of the bits of the actually transmitted Tx Buffer, the CANx.TXBRPi.TRPz and CANx.TXBCFi.CFz bits of the previously started Tx Buffer (or Tx Buffer 0 if there is no previous transmission attempt) are written (CANx.TXBRPi.TRPz = '0', CANx.TXBCFi.CFz = '1').

If in this case the CANx.TXBRPi.TRPz bit of the Tx Buffer that lost arbitration at the first two identifier bits has not been cleared, retransmission is attempted.

2 Functional deviations

When the CAN Node loses arbitration again at the immediately following retransmission, then actually and previously transmitted Tx Buffer are the same and this Tx Buffer's CANx.TXBRPi.TRPz bit is cleared and its CANx.TXBCFi.CFz bit is set.

Scope

The erratum is limited to the case when the MCMCAN CAN Node loses arbitration at one of the first two transmitted identifier bits while in DAR mode.

The problem does not occur when the transmitted message has been disturbed by an error.

Effects

In this case it may happen, that the CANx.TXBRPi.TRPz bit is cleared after the second transmission attempt instead of the first.

Additionally it may happen that the CANx.TXBRPi.TRPz bit of the previously started Tx Buffer is cleared, if it has been set again. As in this case the previously started Tx Buffer has lost MCMCAN internal arbitration against the active Tx Buffer, its message has a lower identifier priority. It would also have lost arbitration on the CAN bus at the same position.

Workaround

None.

2.80 [MCMCAN_AI.018] Tx FIFO message sequence inversion**Description**

Assume the case that there are two Tx FIFO messages in the output pipeline of the Tx Message Handler (TxMH) and transmission of Tx FIFO message 1 is started:

- Position 1: Tx FIFO message 1 (transmission ongoing)
- Position 2: Tx FIFO message 2
- Position 3: --

Now a non-Tx FIFO message with a higher CAN priority is requested. Due to its priority it will be inserted into the output pipeline. The TxMH performs so called "message-scans" to keep the output pipeline up to date with the highest priority messages from the Message RAM. After the following two message-scans the output pipeline has the following content:

- Position 1: Tx FIFO message 1 (transmission ongoing)
- Position 2: non Tx FIFO message with higher CAN priority
- Position 3: Tx FIFO message 2

If the transmission of Tx FIFO message 1 is not successful (lost arbitration or CAN bus error) it is pushed from the output pipeline by the non-Tx FIFO message with higher CAN priority. The following scan re-inserts Tx FIFO message 1 into the output pipeline at position 3:

- Position 1: non Tx FIFO message with higher CAN priority (transmission ongoing)
- Position 2: Tx FIFO message 2
- Position 3: Tx FIFO message 1

Now Tx FIFO message 2 is in the output pipeline in front of Tx FIFO message 1 and they are transmitted in that order, resulting in a message sequence inversion.

Note: *Within the scope of the scenario described above, in case of more than two Tx FIFO messages, the Tx FIFO message that has lost arbitration will be inserted after the next pending Tx FIFO message.*

2 Functional deviations**Scope**

The erratum describes the case when the MCMCAN uses both, dedicated Tx Buffers and a Tx FIFO (CAN_TXBCi.TFQM = '0') and the messages in the Tx FIFO do not have the highest internal CAN priority. The described sequence inversion may also happen between two non-Tx FIFO messages (Tx Queue or dedicated Tx Buffers) that have the same CAN identifier and that should be transmitted in the order of their buffer numbers (not the intended use).

Effects

In the described case it may happen that two consecutive messages from the Tx FIFO exchange their positions in the transmit sequence.

Workaround

When transmitting messages from a dedicated Tx Buffer with higher priority than the messages in the Tx FIFO, choose one of the following workarounds:

Workaround 1

Use two dedicated Tx Buffers, for example use Tx Buffers 4 and 5 instead of the Tx FIFO.

The pseudo-code below replaces the function that fills the Tx FIFO.

- Write message to Tx Buffer 4
- Transmit Loop:
 - Request Tx Buffer 4 - write TXBAR.A4
 - Write message to Tx Buffer 5
 - Wait until transmission of Tx Buffer 4 completed – CAN_IRi.TC, read CAN_TXBTOi.TO4
 - Request Tx Buffer 5 - write CAN_TXBARi.AR5
 - Write message to Tx Buffer 4
 - Wait until transmission of Tx Buffer 5 completed – CAN_IRi.TC, read CAN_TXBTOi.TO5

Workaround 2

Assure that only one Tx FIFO element is pending for transmission at any time. The Tx FIFO elements may be filled at any time with messages to be transmitted, but their transmission requests are handled separately. Each time a Tx FIFO transmission has completed and the Tx FIFO gets empty (CAN_IRi.TFE = '1') the next Tx FIFO element is requested.

Workaround 3

Use only a Tx FIFO. Send the message with the higher priority also from Tx FIFO.

Drawback: The higher priority message has to wait until the preceding messages in the Tx FIFO have been sent.

2.81 [MCMCAN_AI.019] Unexpected High Priority Message (HPM) interrupt

Description

There are two configurations where the issue occurs:

Configuration A

- At least one Standard Message ID Filter Element is configured with priority flag set (S0.SFEC = "100"/"101"/"110")

2 Functional deviations

- No Extended Message ID Filter Element configured
- Non-matching extended frames are accepted (GFC.ANFE = "00"/"01")

The HPM interrupt flag IR.HPM is set erroneously on reception of a non-high-priority extended message under the following conditions:

1. A standard HPM frame is received, and accepted by a filter with priority flag set --> Interrupt flag IR.HPM is set as expected
2. Next an extended frame is received and accepted because of GFC.ANFE configuration --> Interrupt flag IR.HPM is set erroneously

Configuration B

- At least one Extended Message ID Filter Element is configured with priority flag set (F0.EFEC = "100"/"101"/"110")
- No Standard Message ID Filter Element configured
- Non-matching standard frames are accepted (GFC.ANFS = "00"/"01")

The HPM interrupt flag IR.HPM is set erroneously on reception of a non-high-priority standard message under the following conditions:

1. An extended HPM frame is received, and accepted by a filter with priority flag set --> Interrupt flag IR.HPM is set as expected
2. Next a standard frame is received and accepted because of GFC.ANFS configuration --> Interrupt flag IR.HPM is set erroneously

Scope

The erratum is limited to:

- Configuration A:
 - No Extended Message ID Filter Element configured and non-matching extended frames are accepted due to Global Filter Configuration (GFC.ANFE = "00"/"01")
- Configuration B:
 - No Standard Message ID Filter Element configured and non-matching standard frames are accepted due to Global Filter Configuration (GFC.ANFS = "00"/"01")

Effects

Interrupt flag IR.HPM is set erroneously at the reception of a frame with:

- Configuration A: extended message ID
- Configuration B: standard message ID

Workaround

Configuration A

Setup an Extended Message ID Filter Element with the following configuration:

- F0.EFEC = "001"/"010" - select Rx FIFO for storage of extended frames
- F0.EFID1 = any value - value not relevant as all ID bits are masked out by F1.EFID2
- F1.EFT = "10" - classic filter, F0.EFID1 = filter, F1.EFID2 = mask
- F1.EFID2 = zero - all bits of the received extended ID are masked out

Now all extended frames are stored in Rx FIFO 0 respectively Rx FIFO 1 depending on the configuration of F0.EFEC.

Configuration B

Setup a Standard Message ID Filter Element with the following configuration:

- S0.SFEC = "001"/"010" - select Rx FIFO for storage of standard frames

2 Functional deviations

- S0.SFID1 = any value - value not relevant as all ID bits are masked out by S0.SFID2
- S0.SFT = "10" - classic filter, S0.SFID1 = filter, S0.SFID2 = mask
- S0.SFID2 = zero - all bits of the received standard ID are masked out

Now all standard frames are stored in Rx FIFO 0 respectively Rx FIFO 1 depending on the configuration of S0.SFEC.

2.82 [MCMCAN_AI.022] Message order inversion when transmitting from dedicated Tx Buffers configured with same Message ID

Description

Configuration:

Several Tx Buffers are configured with the same Message ID. Transmission of these Tx Buffers is requested sequentially with a delay between the individual Tx requests.

Expected behavior

When multiple Tx Buffers that are configured with the same Message ID have pending Tx requests, they shall be transmitted in ascending order of their Tx Buffer numbers. The Tx Buffer with lowest buffer number and pending Tx request is transmitted first.

Observed behavior

It may happen, depending on the delay between the individual Tx requests, that in the case where multiple Tx Buffers are configured with the same Message ID the Tx Buffers are not transmitted in order of the Tx Buffer number (lowest number first).

Scope

The erratum is limited to the case when multiple Tx Buffers are configured with the same Message ID.

Effects

In the case described it may happen that Tx Buffers configured with the same Message ID and pending Tx request are not transmitted with lowest Tx Buffer number first (message order inversion).

Workaround

First write the group of Tx messages with same Message ID to the Message RAM and then afterwards request transmission of all these messages concurrently by a single write access to **TXBARI**. Before requesting a group of Tx messages with this Message ID ensure that no message with this Message ID has a pending Tx request.

2.83 [MCMCAN_AI.023] Incomplete description in section "Dedicated Tx Buffers" and "Tx Queue" of the M_CAN documentation in the user manual related to transmission from multiple buffers configured with the same Message ID

Description

Dedicated Tx Buffers

- Wording user manual

In case that multiple dedicated Tx Buffers are configured with the same Message ID, the Tx Buffer with the lowest buffer number is transmitted first.

- Enhancement - additional text

2 Functional deviations

These Tx Buffers shall be requested in ascending order with lowest buffer number first.

Alternatively all Tx Buffers configured with the same Message ID can be requested simultaneously by a single write access to TXBARi.

Tx Queue

- Wording user manual - to be deleted

In case that multiple Queue Buffers are configured with the same Message ID, the Queue Buffer with the lowest buffer number is transmitted first.

- Replacement

If multiple Tx Queue buffers are configured with the same Message ID, the transmission order depends on the numbers of the buffers where the messages were stored for transmission. As these buffer numbers depend on the current states of the Put index, a prediction of the transmission order is not possible.

- Wording user manual - to be deleted

An Add Request cyclically increments the Put Index to the next free Tx Buffer.

- Replacement

The Put Index always points to that free buffer of the Tx Queue with the lowest buffer number.

Scope

Use of multiple dedicated Tx Buffers or Tx Queue buffers configured with same Message ID.

Effects

In case the dedicated Tx Buffers with the same Message ID are not requested in ascending order or at the same time or in the case of multiple Tx Queue buffers with the same Message ID, it cannot be guaranteed, that these messages are transmitted in ascending order with lowest buffer number first.

Workaround

In case a defined order of transmission is required the Tx FIFO shall be used for the transmission of messages with the same Message ID. Alternatively dedicated Tx Buffers with same Message ID shall be requested in ascending order with the lowest buffer number first or by a single write access to TXBARi. Alternatively a single Tx Buffer can be used to transmit those messages one after the other.

2.84 [MCMCAN_AI.024] Frame transmitted despite confirmed transmit cancellation

Description

In case the transmission of Tx Buffer z was not successful and is restarted immediately afterwards by automatic retransmission, and the software requests a Tx cancellation for this Tx Buffer by setting the cancellation request bit TXBCRi.CRz during transmission of the first 4 identifier bits, a successful cancellation is wrongly signalled by setting TXBCFi.CFz = '1' and by clearing TXBRPi.TRPz. In addition, the respective transmission occurred bit remains zero (TXBTOi.TOz = '0'), wrongly indicating that the frame was not transmitted on the bus.

Other than signalled by TXBCFi.CFz and TXBTOi.TOz, the transmission continues until the complete frame has been sent on the CAN bus. If the transmission is successful, TXBTOi.TOz will be set.

If in this case new data is written to Tx Buffer z while the transmission is still ongoing, a frame with inconsistent data may appear on the bus.

Scope

This problem is limited to the case when automatic retransmission is enabled (CCCRi.DAR = '0'). Erroneous signaling of the relevant status flags (as described in above section) happens irrespective of the CAN frame types and length. The below described effect of inconsistent data in the transmitted frame happens only for CAN FD messages with more than 8 data bytes. Classical CAN and CAN FD messages with less than 8 data bytes are not affected.

2 Functional deviations

Effects

When bit TXBRPi.TRPz of Tx Buffer z is reset by an incomplete transmit cancellation, this Tx Buffer is reported to be “free”. In case the software now writes new data to this Tx Buffer while a transmission is still ongoing, it may happen that this new data is loaded into the protocol controller, leading to a data inconsistency of the transmitted frame, meaning that the transmitted frame consists partly of the data available at start of frame and data written to the Tx Buffer during the ongoing transmission.

Workaround

Do not use transmit cancellation for CAN FD messages with more than 8 data bytes.

Alternatively wait for the duration of the expected transmission time of the cancelled Tx Buffer before writing new data to that Tx Buffer. The duration of the waiting time can be shortened when a new frame is received or transmitted before the end of the expected transmission time of the cancelled Tx Buffer.

2.85 [MCMCAN_AI.025] Sporadic data corruption (payload) in case acceptance filtering is not finished before reception of data R3 (DB7..DB4) is completed

Description

During frame reception the Rx Handler accesses the external Message RAM for acceptance filtering (read accesses) and for storing accepted messages (write accesses).

The time needed for acceptance filtering and for storing a received message depends on:

- the host clock frequency (f_{MCANH})
- the worst-case latency of the read and write accesses to the external Message RAM
- the number of configured filter elements
- the workload of the transmit message (Tx) handler in parallel to the receive message (Rx) handler

Received data bytes (DB0..DBm) from the CAN Core are buffered in the cache of the Rx Handler before they are written to the Message RAM (in words of 4 byte). Data words inside the Message RAM are numbered from R2 to Rn ($n \leq 17$).

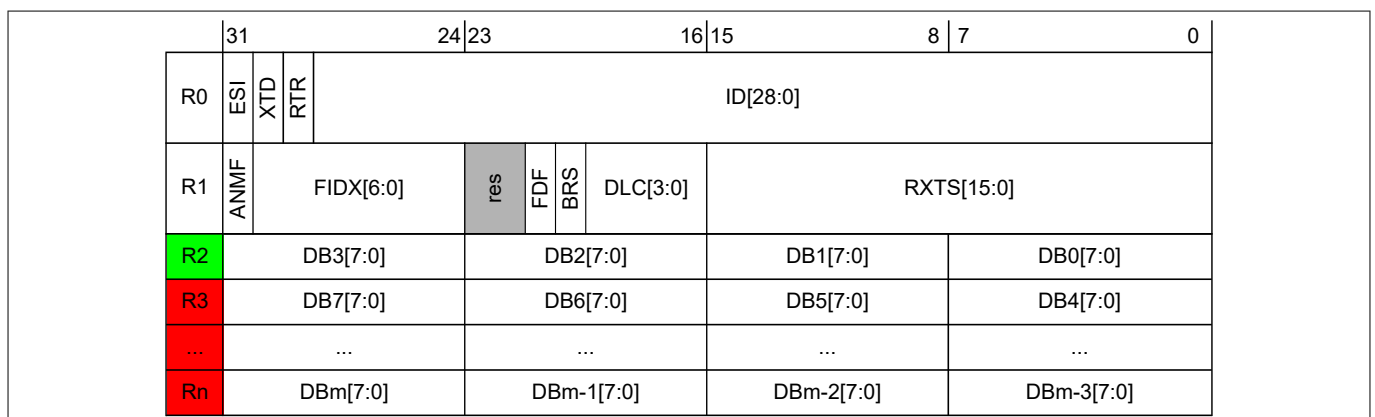


Figure 4 TC3xx - Rx Buffer and FIFO Element (R_i holds Data Byte DB(x+3)..DBx (with x=4*(i-2)))

Under the following conditions a received message will have corrupted data while the received message is signaled as valid to the host.

1. The data length code (DLC) of the received message is greater than 4 ($DLC > 4$)
2. The storage of R_i of a received message into the Message RAM (after acceptance filtering is done) has not completed before R_(i+1) is transferred from the CAN Core into the cache of the Rx Handler (where $2 \leq i \leq 5$)
3. While condition 1) and 2) apply, a concurrent read of data word R_i from the cache and write of data word R_(i+1) into the cache of the Rx handler happens

2 Functional deviations

The data will be corrupted in a way, that in the Message RAM $R_{(i+1)}$ has the same content as R_i .
 Despite the corrupted data, the M_CAN signals the storage of a valid frame in the Message RAM:

- Rx FIFO: FIFO put index RXFnS.FnPI is updated
- Dedicated Rx Buffer: New Data flag NDATn.NDxx is set
- Interrupt flag IR.MRAF is not set

The issue may occur in FD Frame Format as well as in Classic Frame Format.

The figure that follows shows how the available time for acceptance filtering and storage is reduced.

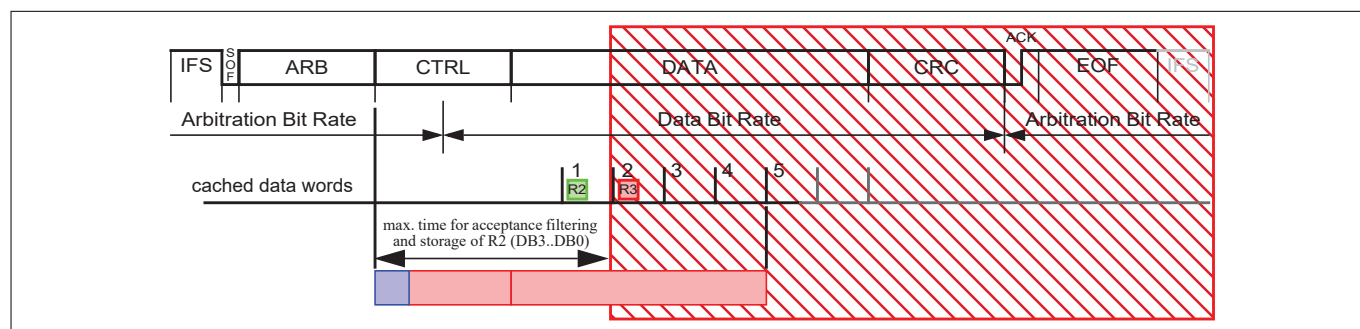


Figure 5 CAN Frame with DLC > 4

TC3xx: Minimum host clock frequency for CAN FD when DLC = 5

Table 9 TC3xx: Minimum host clock frequency for CAN FD when DLC = 5

No. of configured Active FE ^{1) 2)} 11-bit IDs/ 29-bit IDs	Number of Active CAN nodes	Arbitration bit rate = 0.5 Mbit/s			Arbitration bit rate = 1 Mbit/s		
		Data bit rate = 1 Mbit/s	Data bit rate = 2 Mbit/s	Data bit rate = 4 Mbit/s	Data bit rate = 2 Mbit/s	Data bit rate = 4 Mbit/s	Data bit rate = 5 Mbit/s
32/16	2	8	14	23	15	27	32
	3	10	19	32	20	37	44
	4	13	24	41	26	47	57
64/32	2	14	25	44	27	50	60
	3	19	35	61	38	70	84
	4	25	45	78	49	90	108 ³⁾
96/48	2	20	37	64	40	74	89
	3	28	52	90	56	103 ³⁾	124 ³⁾
	4	36	67	116 ³⁾	72	133 ³⁾	160 ³⁾
128/64	2	27	49	85	53	98	118 ³⁾
	3	37	68	119 ³⁾	74	136 ³⁾	164 ³⁾
	4	48	88	153 ³⁾	95	175 ³⁾	211 ³⁾

- 1) M_CAN starts always at filter element #0 and proceeds through the filter list to find a matching element. Acceptance filtering stops at the first matching element and the following filter elements are not evaluated for this message. Therefore the sequence of configured filter elements has a significant impact on the performance of the filtering process.
- 2) Acceptance filtering search for 11-bit IDs and 29-bit IDs filter element is running separately, only one configured filter setting should be considered. Searching for one 29-bit filter element requires double cycles for one 11-bit filter element.
- 3) Frequency not reachable since the maximum host clock frequency for MCMCAN in TC3xx is 100 MHz.

2 Functional deviations

Scope

The erratum is limited to the case when the host clock frequency used in the actual device is below the limit shown in section "TC3xx: Minimum host clock frequency for CAN FD when DLC = 5".

Effects

Corrupted data is written to the Rx FIFO element or the dedicated Rx Buffer. The received frame is nevertheless signaled as valid.

Workaround

Check whether the minimum host clock frequency, that is shown in section "TC3xx: Minimum host clock frequency for CAN FD when DLC = 5", is below the host clock frequency used in the actual device.

If yes, there is no problem with the selected configuration.

If no, use one of the following two workarounds.

Workaround 1

Try different configurations by changing the following parameters until ensuring that the actual synchronous clock f_{MCANH} frequency is above the minimum host clock frequency shown in section "TC3xx: Minimum host clock frequency for CAN FD when DLC = 5".

- Increase the f_{MCANH} in the actual device
- Reduce the CAN-FD data bit rate
- Reduce the number of configured filter elements and use a combination of 11-bit IDs and 29-bit IDs filter elements for one node
- Reduce the number of active M_CANs

Also, use DLC ≥ 8 instead of DLCs 5, 6 and 7 in the CAN environment/system, as they place higher demands on the minimum f_{MCANH} (the worst case is DLC=5) or restrict your CAN environment/system to DLC=4.

Note: While changing the actual host clock frequency, f_{MCANH} must always be equal or higher than f_{MCAN} for all configurations.

Workaround 2

Due to condition 3) the issue only occurs sporadically. Use an end-to-end (E2E) protection (for example, checksum or CRC covering the data field) and add it to all messages in the CAN system, to detect data corruption in received frames.

2.86 [MCMCAN_TC.006] MCMCAN specific access protection mechanisms

Description

As described in the section "Registers" of the MCMCAN chapter of the TC3xx user manual, the MCMCAN module provides the following access enable registers:

- ACCEN0: protects the complete address space of MCMCAN including ACCENCTR0 and ACCENNODEi0
- ACCENCTR0: protects the control registers MCR, BUFADR, MECDR, and MESTAT
- ACCENNODEi0: protects all the registers of the respective node i (i=0..3) and RAM range defined in the registers STARTADRI (i=0..3) and ENDADRI (i=0..3)

If an access violation takes place to the address space protected by ACCEN0, the access will be blocked and a bus error will be triggered.

Facing an access violation to a protected entity by either ACCENCTR0 or ACCENNODEi0, there will be no bus error triggered, however the access will be blocked.

2 Functional deviations

Effects

No bus error will be triggered in case of an access violation by using ACCENCTR0 or ACCENNODEi0.

Note: *This issue has no safety impact since the node-based access protection covered by ACCENCTR0 and ACCENNODEi0 provides freedom from interference between CAN nodes and triggering a bus error caused by such violation is not required in the safety case for AURIX™ 2nd generation.*

Workaround

No workaround is needed to ensure the access protection.

If bus error notification is required upon a MCMCAN access violation, use only the mechanism provided by ACCEN0.

2.87 [MEMMAP_TC.001] Size of PFLASH and DFLASH - Correction to TC33xEXT and TC33x/TC32x Appendix

Description

Note: *This issue only affects V1.6.0 and V2.0.0 of the TC33xEXT and the TC33x/TC32x Appendix.*

Versions V1.6.0 and V2.0.0 include incorrect sizes and address ranges for PFLASH (3 Mbyte instead of 2 Mbyte) and DFLASH DF0 (1 Mbyte instead of 128 Kbyte) in table “Address Map as seen by Bus Masters on Bus SRI” in the MEMMAP chapter of the TC33xEXT and TC33x/TC32x Appendix.

Earlier versions (V1.2.0 .. V1.5.0) of the TC33xEXT and TC33x/TC32x Appendix correctly specify the sizes and address ranges for PFLASH (2 Mbyte) and DFLASH DF0 (128 Kbyte).

Documentation correction

The sizes and address ranges for PFLASH and DFLASH DF0 in table “Address Map as seen by Bus Masters on Bus SRI” in the MEMMAP chapter of the TC33xEXT and TC33x/TC32x Appendix V1.6.0 and V2.0.0 shall be corrected as shown in the following table.

Table 10 Address Map as seen by Bus Masters on Bus SRI - Corrections

Address Range		Size	Unit
from	to		
80000000 _H	801FFFFFF _H	2 Mbyte	Program Flash (PFI0)
80200000 _H	8FDFFFFFF _H	-	Reserved
A0000000 _H	A01FFFFFF _H	2 Mbyte	Program Flash (PFI0_NC)
A0200000 _H	A7FFFFFF _H	-	Reserved
AF000000 _H	AF01FFFF _H	128 Kbyte	Data Flash 0 EEPROM (DF0) and Host Command
AF020000 _H	AF3FFFFFF _H	-	Reserved

2.88 [MTU_TC.012] Security of CPU cache memories during runtime is limited

Description

MTU chapter “Security Applications” in the User’s Manual describes that selected memories with potentially security relevant content are initialized under certain conditions to prevent reading of their data or supplying manipulated data.

2 Functional deviations

The description is correct, but the initialization of CPU cache and cache tag memories triggered by MBIST enable/disable and when mapping/un-mapping these memories to/from system address space using MEMMAP register is of limited value:

- These memories stay functional as cache in the address mapped state. Therefore software can enable address mapping and afterwards watch cache usage of the application (this is a debug feature). Even manipulation of the cache content is feasible
- It is possible to abort an ongoing memory initialization

The security of memory initialization during startup is not affected. Also protection of FSI0 and HSM memories is not limited.

Workaround

Handle security relevant data exclusively inside HSM. Protect the application code by locking external access (for example lock debug interface, prevent boot via serial interface). Consider validation of application code by HSM secure boot.

2.89 [MTU_TC.017] Unexpected alarms after application reset

Description

As described in the MTU chapter “Alarms after startup” section, in case of an application reset, there are no SSH alarms or status bits expected to be triggered.

However, this device deviates from this expected behavior, and status flags AG0.SF10 and AG1.SF10 (DMEM Uncorrectable critical error) are set also after an application reset. Correspondingly, the OPERR[0] bits of the following SSHs are also set in the corresponding MCi_FAULTSTS registers after an application reset:

- MC0 (CPU0_DMEM)
- MC34 (CPU0_DMEM1), and
- MC35 (CPU1_DMEM1)

Note: *In contrast to alarms resulting from real errors, for these unexpected alarms after application reset MCi_ERRINFO = 0x0 (i = 0, 34, 35).*

Workaround

The application software may clear the above mentioned alarms and errors after an application reset if MCi_ERRINFO = 0x0 (i = 0, 34, 35), and proceed.

In case these errors occur during normal application run, this shall be considered as a real error.

2.90 [MTU_TC.018] Gated SRAM alarms

Description

Due to a corner case, SRAM alarms to the SMU for SRAM errors are not correctly generated for the following modules.

- GTM: ALM6[10], ALM6[11]
- DMA, SCR: ALM6[19], ALM6[20]
- CPUx: ALMx[4], ALMx[7], ALMx[10] (x = 0..n; n depends on number of CPUs available in product)

Background

From the SRAMs, the following errors are triggered to the SMU:

- ECC-correctable error: Triggered on a read access to SRAM

2 Functional deviations

- ECC-uncorrectable error: Triggered on a read access to SRAM
- Address error: Triggered on read or write access to SRAM

In case of an error, normally these alarms are triggered appropriately on each read or write access.

However, due to this corner case, for certain SRAMs mentioned above, the alarm is not triggered on the read or write access on which the error is generated, rather, it is generated only on the **next** access to the SRAM or to an SSH register (for example MCx_ECCD register).

Note: *Only the SMU alarm generation is affected by this issue and not the error triggering to the module. For example, error notification to GTM MCS still works as expected and the MCS may be stopped on an uncorrectable ECC error.*

Additionally, only the alarm propagation is gated in this corner case, that is the error status is still correctly stored in the MCx_ECCD, MCx_FAULTSTS registers.

Workaround

- For GTM & SCR SRAMs:
Read the MCx_ECCD register periodically, depending on application safety considerations, for example within each diagnostic test interval.
Corresponding SSH instances:
 - GTM: MC53..MC60
 - SCR: MC77, MC78
- For DMA & CPU SRAMs (except DLMUx_STBY):
No workaround is recommended, because here the issue affects only the address error generation on a write access. In this case, the next read access (when the data would be used) will trigger the error.
- For DLMU_STBY:
The issue occurs in a corner case just before entering standby mode. Therefore, if standby mode is used and Standby RAM is enabled (PMSWCR0.STBYRAMSEL \neq 000_B) - then just before entering standby, perform an additional dummy read to DLMU_STBY location 0x9000 0000 or 0xB000 0000 (when using CPU0 dLMU RAM) and 0x9001 0000 or 0xB001 0000 (when using CPU1 dLMU RAM). This dummy read triggers the alarm propagation and ensures that no alarms are lost due to standby entry.

2.91 [PADS_TC.011] Pull-ups activate on specific analog inputs upon PORST

Description

If HWCFG[6] = 1 or PMSWCR5.TRISTREQ = 0, respectively, the following analog inputs in the V_{DDM} domain:

- analog inputs overlaid with general purpose inputs (class S pads) on all pins of P40 and P41¹⁾
- analog inputs (class D pads) of channels with multiplexer diagnostics²⁾

will activate internal pull-ups during cold or warm PORST.

When PORST is deasserted and the internal circuitry is reset, the inputs mentioned above will be released to tri-state mode.

Note: *This behavior differs from the description in the “Ports” chapter of the User’s Manual (P40/P41 always in tri-state mode during PORST) and the Data Sheet (corresponding pins marked with symbol “HighZ” in columns for buffer/pad type of the pin definition tables).*

¹⁾ Availability depends on TC3xy device version, see the product specific Data Sheet.

²⁾ These channels are explicitly marked with (MD) in table “Analog Input Connections for Product TC3xy” in the EVADC chapter of the product specific appendix to the AURIX™ TC3XX User’s Manual.

2 Functional deviations

2.92 [PADS_TC.013] Buffer type definition for P21.2: no ES functionality - Data Sheet documentation correction

Description

As described in section “Exceptions for Emergency Stop Implementation” in the Ports chapter of the User’s Manual and its appendix, the Emergency Stop function is not available for P21.2 (can be used as EMGSTOPB pin).

Erroneously, P21.2 is marked with symbol “ES” (= Supports Emergency Stop) in column “Buffer Type” in the Data Sheet.

Correction to Data Sheet

Symbol “ES” shall be removed for P21.2 in column “Buffer Type” in the Data Sheet.

2.93 [PADS_TC.016] Pull-ups active on P33 and P34 pins in standby mode when SCR is disabled and VEXT not supplied

Description

In the figure "Standby entry on VEXT ramp-down and wake-up on VEXT ramp-up" in the PMS and PMSLE chapters of the TC3xx user manual, the "Pin behavior" part shows that a pin state during and after wake-up from standby is configurable by bit PMSWCR5.TRISTREQ as pull-up or tristate.

Current documentation

For P33 and P34 pins which are supplied by VEVR SB, the following behavior is expected in standby mode as per the description mentioned in the "Pin behavior" part:

- If VEXT pins are not supplied, then VEVR SB supplied SCR pins are under SCR control (implies SCR is enabled)
- If SCR is not enabled and VEXT pins are not supplied, then VEVR SB supplied pins (P33, P34) are in tristate

However, the last part stating that P33 and P34 pins are in tristate during standby mode if the SCR is not enabled and VEXT pins are not supplied, is not correct.

Actual behavior

When the SCR is not enabled and VEXT pins are not supplied during standby, then pull-ups are active on all P33 and P34 pins in standby mode.

Workaround 1

When the SCR is not enabled and VEXT pins are not supplied during standby mode, and the application requires a low level on P33 and P34 pins in standby mode, external pull-downs (in the range of $> 2 \text{ k}\Omega$ and $< 4.7 \text{ k}\Omega$) should be added to the corresponding P33 and P34 pins.

In order to quantify the strength of such an external pull-down, parameter "Pull-up current" (I_{PUH}) for the respective pin may be used as the reference, and the value for the external pull-down can be calculated accordingly.

Workaround 2

Enable the SCR during standby mode.

Workaround 3

Supply VEXT pins during standby mode.

2 Functional deviations

2.94 [PMS_TC.005] Voltage rise at P33 and P34 up to $V_{EVR\text{SB}}$ during start-up and up to $V_{LVDR\text{STSB}}$ during power-down

Description

The HWCFG pins (located in the V_{EXT} domain) information is evaluated when basic supply and clock infrastructure components are available as the supplies $V_{EVR\text{SB}}$ and V_{EXT} ramp up. Tristate control information based on HWCFG[6] latched with V_{EXT} supply ramp can't be used within the $V_{EVR\text{SB}}$ supply domain until both supplies (V_{EXT} and $V_{EVR\text{SB}}$) have reached the minimum threshold value of $V_{LVDR\text{ST5}}$ and $V_{LVDR\text{STSB}}$, respectively. Therefore, the pad behavior at P33 and P34 pins is "pull-up", even if pin HWCFG[6] = 0, with the following characteristics:

- the pad voltage level rises to $V_{EVR\text{SB}}$ until the $V_{LVDR\text{STSB}}$ and $V_{LVDR\text{ST5}}$ thresholds of $V_{EVR\text{SB}}$ and V_{EXT} are reached during the ramp-up phase
- the pad voltage level is below $V_{LVDR\text{STSB}}$ for the ramp-down phase of the $V_{EVR\text{SB}}$ supply

Workaround

If an application requires to ensure the state of P33 and P34 pins within the logical "low" level, then an external pull-down must be used which can overdrive the internal pull-up.

In order to quantify the strength of such an external pull-down, parameter "Pull-up current" (I_{PUH} , CC) for the respective pin may be used as the reference. There, the values for the internal pull-up resistor (for TTL and AL) can be found via parameter R_{MDU} in table "VADC 5V" (see footnotes on parameter "Pull-up current" in the Data Sheet).

2.95 [PMS_TC.006] PORST not released during cold power-on reset until V_{DDM} is available

Description

Upon a cold power-on reset, the PORST pin may be kept asserted by the PMS until the ADC Analog Supply voltage (V_{DDM}) is above 500 mV. This might lead to an additional start-up delay dependent on when V_{DDM} is available from the external regulator relative to the V_{EXT} , V_{DDP3} , and V_{DD} supplies. When V_{DDM} is below 500 mV, the device may not be able to carry out PBIST. As a consequence, the device remains in PORST state until PBIST result gets available and supply voltages are in operating condition. PBIST result is always available when V_{DDM} is above 500 mV. From PBIST point of view, it is important to have enough V_{DDM} voltage level, and there is no special timing requirement on when to supply V_{DDM} .

During operation, if V_{DDM} drops below the secondary monitor undervoltage threshold, an SMU alarm is generated. If V_{DDM} further drops below 500 mV, the dedicated ADC of the secondary voltage monitor stops converting and the Secondary Monitor Activity Counter (EVRMONSTAT1.ACTVCNT) freezes at the last value.

Workaround

The ADC Analog Supply voltage (V_{DDM}) has to be available and needs to be above 500 mV to ensure proper release of PORST during start-up and proper functioning of secondary monitors.

User external regulator ramp-up sequence shall be analyzed to avoid unexpected delay or even potential deadlock.

For example:

- User selects EVRC to generate V_{DD}
- User external regulator will only supply V_{DDM} when its voltage monitor detects that V_{DD} has reached a certain level
- But when V_{DDM} is below 500 mV, the device may not be able to carry out PBIST and the device remains in PORST state and accordingly EVRC cannot generate V_{DD}
- Therefore, deadlock could happen

2 Functional deviations

2.96 [PMS_TC.007] VDDP3 or VDD Overvoltage during start-up may not be detected by PBIST

Description

In AURIX™ TC3xx devices, Power Built in Self Test (PBIST) is introduced to ensure that the supply voltages do not exceed absolute maximum limits during the start-up phase.

However, for a VDDP3 or VDD overvoltage event during start-up beyond operational upper limits, the PBIST is not able to detect this overvoltage event.

Workaround

Check the VDDP3 overvoltage condition in registers EVRSTAT (flag OV33) and EVRMONSTAT1 (field ADC33V) in software additionally during the start-up phase before enabling the corresponding SMU alarm.

Check the VDD overvoltage condition in registers EVRSTAT (flag OVC) and EVRMONSTAT1 (field ADCCV) in software additionally during the start-up phase before enabling the corresponding SMU alarm.

2.97 [PMS_TC.011] VEXT supplied PU2 and PD2 pads always in tristate after standby entry - Documentation correction

Description

Tristate mode is enabled for VEXT supplied PU2 and PD2 pads (marked PU2 / VEXT and PD2 / VEXT in column “Buffer Type” in the Data Sheet) at the moment of and after entry to standby mode, regardless of the PMSWCR5.TRISTREQ bit setting and the HWCFG[6] pin setting (reflected in the PMSWSTAT register).

For a definition of the buffer types see also chapter “Legend” in the Data Sheet.

Recommendation

If the application requires the pull-up state of VEXT supplied PU2 pads (or pull-down state of PD2 pads), then it shall ensure it by means of external pull-up devices (or pull-down devices for PD2 pads) in the event of:

- Standby entry while the VEXT supply ramps down
- Standby entry with the VEXT supply available

Documentation correction for TC3xx User's Manual V1.5.0 and following

In TC3xx User's Manual V1.5.0 and following versions, the description of this behavior has been included in the PMS and PMSLE chapters. Erroneously, the term “PU1” was used instead of “PU2 and PD2”.

In the following sections and sentences in chapter PMS (*=11) and PMSLE (*=12), the term “PU1” shall be replaced by “**PU2 and PD2**”:

- Section *.2.1.1 Supply Mode Selection:
 - „Regardless of the HWCFG[6] setting, the VEXT-buffered PU1 pads (see the PU1 buffer type in the data sheet) are set into tristate ..“ shall be replaced by
 - “Regardless of the HWCFG[6] setting, the VEXT-buffered **PU2 and PD2** pads (see the **PU2 and PD2** buffer type in the data sheet) are set into tristate ..”
- Section *.2.3.4.8 Entering Standby Mode (only VEVRSB domain supplied):
 - “Regardless of the PMSWCR5.TRISTREQ setting, the VEXT-buffered PU1 pads (see the PU1 buffer type in the data sheet) are set into tristate ..” shall be replaced by
 - “Regardless of the PMSWCR5.TRISTREQ setting, the VEXT-buffered **PU2 and PD2** pads (see the **PU2 and PD2** buffer type in the data sheet) are set into tristate ..”

2 Functional deviations

- Section *.2.3.4.9 Entering Standby Mode (both VEVRSB and VEXT domain supplied):
 - “Regardless of the PMSWCR5.TRISTREQ setting, the VEXT-buffered PU1 pads (see the PU1 buffer type in the data sheet) are set into tristate ..” shall be replaced by
 - “Regardless of the PMSWCR5.TRISTREQ setting, the VEXT-buffered **PU2 and PD2** pads (see the **PU2 and PD2** buffer type in the data sheet) are set into tristate ..”
- Section *.2.3.4.10 State during Standby Mode:
 - “Regardless of the PMSWCR5.TRISTREQ setting, the VEXT-buffered PU1 pads (see the PU1 buffer type in the data sheet) are set into tristate ..” shall be replaced by
 - “Regardless of the PMSWCR5.TRISTREQ setting, the VEXT-buffered **PU2 and PD2** pads (see the **PU2 and PD2** buffer type in the data sheet) are set into tristate ..”

See also the corresponding entries in the revision history for PMS chapter V2.2.31 and PMSLE chapter V1.0.4 at the end of each chapter.

2.98 [PMS_TC.014] Parasitic coupling on shared ADC pins depending on supply voltages

Description

Bulk diodes exist from the V_{EXT} supply rail to the V_{DDM} supply rail through respective shared analog pins of EVADC Group 9 (P00.1 - P0.12).

If $V_{EXT} > V_{DDM}$ and any of the shared pin voltages (V_{INPIN}) is higher than V_{DDM} by a diode voltage ($V_{Diode} \sim 0.6V$), i.e.

- $V_{INPIN} > (V_{DDM} + V_{Diode})$ OR V_{INPIN} pulled up to V_{EXT} by internal/external pull-ups $> (V_{DDM} + V_{Diode})$

then during start-up and operation, sink currents will flow from the pin to the V_{DDM} supply. The currents shall be limited by an internal/external pull-up resistor in order to stay within the overload conditions.

Behavior during start-up

Only during the start-up phase, when the V_{DDM} supply voltage is less than the V_{DDPPA} ($\sim 1.3V$) subthreshold limit, then the shared analog pins within an ADC multiplexer group of EVADC group G9 are internally connected together. The internal connection is high ohmic in nature (current $< 100 \mu A$). Consequently an external pull-up on one pin may be visible on the other pins in the same EVADC multiplexer group until the V_{DDM} supply is above the V_{DDPPA} limit and LVD reset limits on V_{EXT} and V_{EVRSB} have been reached.

Workaround

To avoid any current flow from V_{INPIN} / V_{EXT} to V_{DDM} and to prevent parasitic coupling on shared ADC pins:

- It needs to be ensured that the shared pin voltages (V_{INPIN}) are within the $(V_{DDM} + V_{Diode})$ supply range. Alternatively, V_{DDM} and V_{EXT} may be supplied together from the same supply source if the pull-ups on the pins are to the V_{EXT} rail
- When both V_{EXT} and V_{EVRSB} are kept supplied during Standby mode, V_{DDM} should also be kept supplied if shared analog pins are pulled high

Note: *Related to this text module, in TC3xx User's Manual versions after V1.6, the row for V_{DDM} in table “5 V Nominal Supply: Voltage variations at independent supply rails during system modes” will be updated accordingly, and a diagram “Parasitic Diode Connectivity between supply rails” will be added.*

2 Functional deviations

2.99 [PMS_TC.015] EVRC synchronization – Documentation update for register EVRSDCTRL11 (PMS) and EVRSDCTRL2 (PMSLE)

Description

The formulas for $d f_{MAXDEV}$ (Maximum Deviation of the Synchronization Input Frequency) and SYNCHYST (Lock Unlock Hysteresis Window) that are documented in the description of fields SYNCMAXDEV and SYNCHYST in register EVRSDCTRL11 (chapter PMS) and EVRSDCTRL2 (chapter PMSLE) of the TC3xx User's Manual shall be corrected/updated as listed below.

SYNCMAXDEV in TC3xx User's Manual V2.0.0 (and earlier versions)

- $d f_{MAXDEV} = 100 \text{ MHz} * (2 * SYNCMAXDEV) / (SDFREQ^2 + SYNCMAXDEV^2)$
- $SYNCMAXDEV = \text{round} [(100 \text{ MHz} / d f_{MAXDEV}) - \sqrt{(100 \text{ MHz} / d f_{MAXDEV})^2 - SDFREQ^2}]$

Correction to SYNCMAXDEV in register EVRSDCTRL11 (PMS) and EVRSDCTRL2 (PMSLE)

- $d f_{MAXDEV} = 100 \text{ MHz} * (2 * SYNCMAXDEV) / (SDFREQ^2 - SYNCMAXDEV^2)$
- $SYNCMAXDEV = \text{round} [\sqrt{(100 \text{ MHz} / d f_{MAXDEV})^2 + SDFREQ^2} - (100 \text{ MHz} / d f_{MAXDEV})]$

SYNCHYST in TC3xx User's Manual V2.0.0 (and earlier versions)

- $SYNCHYST = \text{round} [d f_{HYST} * (SDFREQ \pm SYNCMAXDEV)^2] / [d f_{HYST} * (SDFREQ \pm SYNCMAXDEV) + 100 \text{ MHz}]$

Correction/Update to SYNCHYST in register EVRSDCTRL11 (PMS) and EVRSDCTRL2 (PMSLE)

- $SYNCHYST = \text{round} [d f_{HYST} * (SDFREQ \pm SYNCMAXDEV)^2 / (100 \text{ MHz} \pm d f_{HYST} * (SDFREQ \pm SYNCMAXDEV))]$
- First hysteresis band:
 - $d f_{HYST} = 100 \text{ MHz} / (SDFREQ + SYNCMAXDEV - SYNCHYST) - 100 \text{ MHz} / (SDFREQ + SYNCMAXDEV)$
- Second hysteresis band:
 - $d f_{HYST} = 100 \text{ MHz} / (SDFREQ - SYNCMAXDEV) - 100 \text{ MHz} / (SDFREQ - SYNCMAXDEV + SYNCHYST)$

2.100 [PORTS_TC.009] PCSR register incompletely documenting use for EVADC PDD and MD feature - Update to TC33x/TC32x appendix

Description

In ports with analog inputs to the EVADC the PCSR register enables control of pull devices for the Pull Down Diagnostics (PDD) / Multiplexer Diagnostics (MD) feature.

However, in the PORTS chapter of the TC33x/TC32x appendix V2.0.0 (and earlier versions), the following register bits are documented as reserved and their name is **Rx**:

- bit 5 of register P40_PCSR associated with EVADC G8CH1 on P40.5
- bit 10 of register P00_PCSR associated with EVADC G9CH2 on P00.10
- bit 11 of register P00_PCSR associated with EVADC G9CH1 on P00.11

Documentation update

Correct would be to name the following bits as **SELx**:

- bit 5 of register P40_PCSR (symbolic name SEL5)
- bit 10 of register P00_PCSR (symbolic name SEL10)
- bit 11 of register P00_PCSR (symbolic name SEL11)

with the description:

"This bit enables or disables EVADC control of the pulls for Pull Down Diagnostics (PDD) / Multiplexer Diagnostics (MD) feature"

2 Functional deviations

and with documentation of encoding:

“0_B Disable EVADC PDD/MD feature of pin x

1_B Enable EVADC PDD/MD feature of pin x”

2.101 [QSPI_TC.006] Baud rate error detection in slave mode (error indication in current frame)

Description

According to the specification, a baud rate error is detected if the incoming shift clock supplied by the master has less than half or more than double the expected baud rate (determined by bit-field GLOBALCON.TQ).

However, in this design step, a baud rate error is detected not only if the incoming shift clock has less than half the expected baud rate (as specified), but also already when the incoming shift clock is somewhat (i.e. less than double) higher than the expected baud rate.

In this case, the baud rate error is indicated in the current frame.

Workaround

It is recommended not to rely on the baud rate error detection feature, and not to use the corresponding automatic reset enable feature (i.e. keep GLOBALCON.AREN = 0_B).

The baud rate error detection feature in slave mode is of conceptually limited use and is not related to data integrity. Data integrity can be ensured for example by parity, CRC, etc., while clocking problems of an AURIX™ master are detected by mechanisms implemented in the master.

Protection against the effects of high frequency glitches is provided by the spike detection feature in slave mode.

2.102 [QSPI_TC.009] USR Events for PT1=2 (SOF: Start of Frame)

Description

In master mode, when the interrupt on USR event is associated with Start of Frame (i.e. USREN=1_B, PT1=2 in register GLOBALCON1, BACON.UINT=1_B), then flag STATUS.USRF is not set and the interrupt is not triggered for the first frame.

Workaround

In the configuration where the interrupt on USR event is associated with Start of Frame (i.e. USREN=1_B, PT1=2 in GLOBALCON1, BACON.UINT=1_B), first transmit a “dummy” frame with this configuration. Then, for all subsequent frames, flag USRF will be set and the interrupt on USR event will be generated as expected.

2.103 [QSPI_TC.010] Move Counter Mode - USR Events for PT1=4 (RBF: Receive Buffer Filled)

Description

When a master operates in Move Counter Mode (MCCON.MCEN=1_B), and the interrupt on USR event is associated with Receive Buffer Filled (i.e. USREN=1_B, PT1=4 in register GLOBALCON1), the enable signal in BACON.UINT is only evaluated at the start of frame event.

This means in an ongoing frame the status of UINT in the first BACON control word involved determines whether flag STATUS.USRF is set and a user interrupt is generated or not. The status of UINT in following BACON control words in this frames' transmission is not considered.

2 Functional deviations**Workaround**

In case the Receive Buffer Filled event shall only be used as interrupt on USR event for parts of a frame, initialize for example BACON.UINT=1_B and GLOBALCON.PT1=4 before start of frame, and use GLOBALCON1.USREN to selectively disable/enable the user interrupt during frame transmission.

2.104 [QSPI_TC.013] Slave: No RxFIFO write after transmission upon change of BACON.MSB**Description**

While a slave transmission is in progress, and if the BACON.MSB configuration is changed for the subsequent frame, then the RxFIFO write of the currently received frame may not occur.

Also in case of a TxFIFO underflow, the RxFIFO write of the currently received frame may not occur.

Workaround

As a general recommendation, in slave mode the configuration should be done before any transmission starts. In particular to avoid the problem described above, the re-configuration of the BACON has to be done after the RxFIFO write has occurred. This implies the need for a gap between frames if a BACON update occurs.

2.105 [QSPI_TC.014] Slave: Incorrect parity bit upon TxFIFO underflow**Description**

When a slave TxFIFO underflow occurs, the slave transmits only “ones” in response to a request of the master. If parity is enabled, also the parity bit transmitted by the slave is always set to “1”. This may be incorrect, depending on data length and parity type.

Workaround

If parity is enabled, select even parity if data length is odd, and select odd parity if data length is even.

2.106 [QSPI_TC.016] Master: Move Counter Mode - Counter underflows when data is present in the TXFIFO while in the last TRAIL state of the previous transaction**Description**

When a master operates in move counter mode (MCCON.MCEN = 1_B) and is configured for adjacent move counter transactions, the MC.CURRENT counter value underflows when the move counter transaction is in the last TRAIL state of the previous transaction and the TXFIFO is already filled with data for the next move counter transaction. Due to this there is a possibility that the next move counter transaction enters an EXPECT state expecting more frames and stays there until intervened by the software.

Therefore, TXFIFO shall not be filled with the next move counter transaction data before the current transaction is over.

Workaround

The End of Frame (EOF) phase transition interrupt (i.e. GLOBALCON1.PT1 = 101_B or GLOBALCON1.PT2 = 101_B) shall only be used to trigger the CPU/DMA to fill the TXFIFO with the next move counter transaction data.

2 Functional deviations

2.107 [QSPI_TC.017] Slave: Reset when receiving an unexpected number of bits

Description

A deactivation of the slave select input (SLSI) by a master is expected to automatically reset the bit counter of the QSPI module when configured as a slave.

This reset should help slaves to recover from messages where faults in the master or glitches on SCLK lead to an incorrect number of clocks on SCLK (= incorrect number of bits per SPI frame).

However, in this design step, the reset of the bit counter is unreliable.

Workaround

The slave should enable the Phase Transition interrupt (PT2EN = 1_B in register GLOBALCON1) to be triggered after the PT2 event "SLSI deselection" (PT2 = 101_B).

- **TC3xx:** In the interrupt service routine, after ensuring that the receive data has been copied, the software should issue a reset of the bit counter and the state machine via GLOBALCON.RESETS = 01_B
- **TC2xx:** In the interrupt service routine, after ensuring that the receive data has been copied, the software should issue a reset of the bit counter and the state machine via GLOBALCON.RESETS = 0111_B

2.108 [SAFETY_TC.023] MCU infrastructure Safety Related Function - Documentation update

Description

Note: This issue applies to AURIX™ TC3xx Safety Manual version v2.0.

Section 4.3.1 (Introduction) of chapter "Safety Related Functions" in the AURIX™ TC3xx Safety Manual v2.0 mentions in the last bullet point below the table that Safety Related Functions 10, 11 and 12 shall always be correctly implemented in order to reach the ASIL level of the listed Safety Related Functions.

The listed absolute numbers 10, 11, 12 are not correct in this context.

Documentation Update

The MCU infrastructure Safety Related functions **12, 13 and 14** are assumed to be always correctly implemented.

2.109 [SAFETY_TC.024] Clock alive monitor for f_{SPB} - Documentation update

Description

The AURIX™ TC3xx Safety Manual (v2.0 and earlier versions) states in section 6.37 SM[HW]:CLOCK:ALIVE_MONITOR that the clock alive monitor for f_{SPB} is only visible to HSM.

This statement is not correct.

Documentation update

The clock alive monitor for f_{SPB} is visible to all interfaces in the SMU.

2 Functional deviations

2.110 [SAFETY_TC.025] Wrong alarm listed in safety mechanism SM[HW]:SRI:SRI_TRANSACTION_INTEGRITY

Description

In SM[HW]:SRI:SRI_TRANSACTION_INTEGRITY (section 6.477 in AURIX™ TC3xx Safety Manual v1.04 and higher versions), ALM11[12] “(CONVERTER) Phase Synchronizer Error” is listed as fault identification interface of the SM[HW]:SRI:SRI_TRANSACTION_INTEGRITY safety mechanism.

This statement is not correct.

Documentation update

ALM11[12] must not be considered as fault identification interface of the SM[HW]:SRI:SRI_TRANSACTION_INTEGRITY safety mechanism.

2.111 [SAFETY_TC.026] Alarm for SM[HW]:IR:CFG_MONITOR - Documentation update

Description

In SM[HW]:IR:CFG_MONITOR (section 6.268 in AURIX™ TC3xx Safety Manual v1.04 and higher versions) the alarm “ALM8[22] - EDC Configuration & Data Path Error” is listed as fault identification interface of SM[HW]:IR:CFG_MONITOR.

This statement is not correct.

Documentation update

Alarm “ALM10[22] - IR ACCEN Error Event” will be generated if a fault is detected by SM[HW]:IR:CFG_MONITOR.

2.112 [SAFETY_TC.027] Single point fault detection for lockstep CPUs - Documentation update

Description

The following safety mechanisms listed in chapter 6 (Safety Mechanisms) of the AURIX™ TC3xx Safety Manual

- SM[HW]:CPU:CRC
- SM[HW]:CPU:TPS
- SM[HW]:CPU:TPS_EXCEPTION_TIME_MONITOR
- SM[HW]:CPU:CODE_MPU
- SM[HW]:CPU:DATA_MPU
- SM[HW]:CPU:UM0
- SM[HW]:CPU:UM1
- SM[HW]:CPU:SV
- SM[HW]:CPU:STI

mention “Single Point Fault Detection = Yes” in column “lockstep CPU” of the table included in the description of the respective safety mechanism.

This statement is not correct.

The lockstep CPU is protected by SM[HW]:CPU:TRICORE_LOCKSTEP in any case and all the other SMs listed above are only used for freedom from interference.

2 Functional deviations

Documentation update

For the safety mechanisms listed above, the corresponding entry in column “lockstep CPU” shall be corrected to

- “Single Point Fault Detection = N.A.”

2.113 [SCR_TC.015] Bit SCU_PMCN1.WCAN_DIS does not disable WCAN PCLK input

Description

Setting bit SCU_PMCN1.WCAN_DIS to 1_B has no effect – the WCAN clock input (PCLK) is not disabled. Power consumption of the WCAN module will not decrease as expected.

Workaround

In order to keep power consumption at a minimum, the WCAN module must not be enabled (WCAN_CFG.WCAN_EN = 0_B).

2.114 [SCR_TC.016] DUT response to first telegram has incorrect C_START value

Description

Note: *This problem is only relevant for tool development, not for application development.*

The C_START value returned by the SCR OCDS of the DUT (device under test) in response to a first telegram is wrong.

Each monitor processed command starts with sending a telegram containing the CMD (for example READ_BYTE). The response to this telegram should be a telegram containing the C_START value of 0x1. Instead, the value sent by the DUT is a random value.

Workaround

Do not evaluate the return value of the first telegram from the DUT. Even though the returned C_START is wrong, the returned checksum is correct, and should be checked with the theoretical C_START value of 0x01.

2.115 [SCR_TC.018] SSC Receive FIFO not working

Description

The receive FIFO of the SSC module is not working properly. An unexpected receive FIFO full indication can be set.

Workaround

Do not use the receive FIFO.

Read the received data from the receive buffer register SSC_RBL each time a receive interrupt event is signaled (flag IRCON1.RIR).

The received data must be read before the next data is received.

2 Functional deviations

2.116 [SCR_TC.019] Accessing the XRAM while SCR is in reset state

Description

When accessing the XRAM while the SCR is executing a reset, the following erroneous behavior will occur:

- A read access returns 0 instead of the actual XRAM contents
- A write access has no effect, the data will not be written to the XRAM

Workaround

One of the following methods will avoid this problem:

1. Check the SCR reset status bit PMSWSTAT.SCRST before and after any read/write transaction to the XRAM:
 - a. If the bit is set before the transaction, clear bit PMSWSTAT.SCRST and perform the desired XRAM access
 - b. If the bit is set after the transaction, clear bit PMSWSTAT.SCRST and repeat the XRAM read/write access. OR
2. Disable the SCR generated reset sources. OR
3. Disable the entire SCR (no SCR reset can occur) by the following steps:
 - a. Set SCR_RSTCON.ECCRSTEN = 0_B disabling double bit ECC reset before an uncorrectable error is happening in XRAM. Bit ECCRSTEN may be set to 0_B either by explicitly writing to ECCRSTEN, or by triggering a local SCR reset which also clears the ECCRSTEN bit. Alternatively, if ECC reset generation is not disabled and an XRAM ECC error happens later, a periodic reset is triggered to MTU till the reset trigger is serviced. The permanent reset to MTU can be resolved by shortly enabling the SCR and disabling it again to service the pending ECC error triggered reset
 - b. Set PMSWCR0.SCRWKEN = 0_B – wake-up via SCR disabled
 - c. Set PMSWCR4.SCREN = 0_B – SCR disabled

2.117 [SCR_TC.020] Stored address in mon_RETH may be wrong after a break event

Description

Note: *This problem is only relevant for tool development, not for application development.*

When setting a breakpoint via the SCR debugger connection on address XXFE_H of an instruction, the stored address in mon_RETH is wrong if mon_RETL contains 00_H (see also section “Calculation of the return address upon a break event” in the SCR chapter). This effect will happen whenever a carry bit should be propagated from the lower 8 bits to the upper 8 bits of the address.

Workaround

If mon_RETL contains 00_H after a breakpoint was hit, the debugger tool must increment mon_RETH by 1 before performing the calculation of the return address as described in section “Calculation of the return address upon a break event” in the SCR chapter.

2.118 [SCR_TC.021] RTC not counting after reset if P33.10 is high

Description

The Real-Time Clock (RTC) in the SCR module may not reliably start counting if a high level was present on P33.10 (SCR_P01.2) during LVD reset. If enabled, the RTC will only start counting after the first high-to-low transition on P33.10 (SCR_P01.2).

2 Functional deviations

Note: Applications using an external (32 or 32.768 kHz) oscillator on P33.10 as clock source for the RTC are not affected.

Workaround 1

Ensure a low level on P33.10 (SCR_P01.2) during LVD reset, for example via a pull-down.

Workaround 2

Generate a high-to-low transition on P33.10 (SCR_P01.2) after LVD reset (by software or external hardware).

2.119 [SCR_TC.022] Effect of application or system reset and warm PORST on MC77_ECCD and MC78_ECCD for SCR RAMs

Description

Unlike for ECCD registers of other modules, error flags in MC77_ECCD (for SCR_XRAM) and MC78_ECCD (for SCR_RAMINT) are not cleared upon application or system reset.

As consequence the corresponding alarms ALM6[19], ALM6[20] and ALM6[21] in AG6 are not cleared by an application and system reset (if ECCD is not cleared by SW before triggering the reset).

Furthermore, flags in MC77_ECCD are not cleared upon warm PORST.

Workaround

Clear flags in register MC77_ECCD and MC78_ECCD via software by writing '0' to the respective bits.

2.120 [SCR_TC.023] External interrupts EXINT0, EXINT1 may get locked

Description

As described in chapter "Interrupt System" of the SCR chapter in the TC3xx User's Manual, if the external interrupt is positive (negative) edge triggered, the external source must hold the request pin low (high) for at least one CCLK cycle, and then hold it high (low) for at least one CCLK cycle to ensure that the transition is recognized.

However, for external interrupts EXINT0 and EXINT1, respectively, if the time between two triggering edges is shorter than 2 CCLK cycles, no further interrupt request is triggered after the first triggering edge. Further EXINT0 or EXINT1 interrupts are locked until the next application reset.

Note: This problem only occurs if interrupt generation on both rising and falling edge is selected, i.e. for EXINT0 if EXICON0.EXINT0 = 10_B, and for EXINT1 if EXICON0.EXINT1 = 10_B, respectively.

Workaround

If using interrupt generation on both edges, ensure that the time between two triggering edges for EXINT0, EXINT1 is > 2 CCLK cycles. To include some margin for clock jitter and external signal slope asymmetries etc., the external source should hold the request pin low (high) for example for $2.1/f_{\text{CCLK}}$ to ensure that the transitions are correctly recognized.

Otherwise, only use external interrupts EXINT2..15.

2 Functional deviations

2.121 [SCR_TC.024] Field ADRES in register ADCOMP_RES - Documentation correction

Description

In chapter “ADC Comparator Unit (ADCOMP)” of the SCR chapter in the TC3xx User’s Manual, erroneously the term “ADCRES” is used instead of “ADRES” in the text and in figure “ADC Comparator Overview”.

Documentation correction

The term “ADCRES” shall be replaced by “ADRES” within the text of chapter “ADC Comparator Unit (ADCOMP)”, and in figure “ADC Comparator Overview”.

In addition, the text in column “Description” for field ADRES in the ADCOMP Result Register ADCOMP_RES shall be corrected as follows:

Table 11 Field ADRES in register ADCOMP_RES - correction

Field	Bits	Type	Description
ADRES	7:0	rh	ADC Conversion Result
			<p>This register shows the current converted ADC result. Software should ensure that the result is read before starting the next conversion.</p> <ul style="list-style-type: none"> For ADRES > 1: <ul style="list-style-type: none"> VIN = [LSB * (ADRES-1)]; LSB = 23.077 mV. Full Range: 5861.54 mV For ADRES ≤ 1: software shall assume VIN as 0 V

2.122 [SCU_TC.031] Bits SCU_STSTAT.HWCFGx (x=1-5) could have an unexpected value in application if pins HWCFGx are left unconnected

Description

An unexpected value for the HWCFGx pin state (x=1-5) may be latched in register field SCU_STSTAT.HWCFGx after application reset if the corresponding HWCFGx pin is not externally connected to a pull-up or a pull-down and the default reset state of port pins is set to tristate (pin P14.4/HWCFG[6] is pulled to GND).

EVRC start-up function after cold reset is not affected (HWCFG2).

EVR33 start-up function after cold reset is not affected (HWCFG1).

Only the intended function of HWCFG[3-5] pin configuration options in the corresponding reset cases is affected when BMI.PINDIS=0_B and DMU_HF_PROCONTP.BML=00_B (application boot defined by HWCFG[3-5] pins).

Workaround

Do not leave pins HWCFGx (x=1-5) unconnected if the default reset state of port pins is set to tristate (HWCFG[6] pulled to GND).

Note: *This is not a general option for devices in QFP-80 and QFP-100 packages where P14.2/HWCFG2 is internally left unconnected.*

If HWCFG2 is left unconnected, alternatively the application shall not rely on bit SCU_STSTAT.HWCFG[2] and may check for the correct state in the registers PMSWSTAT.HWCFGEVR or EVRSTAT.EVRC.

2 Functional deviations

2.123 [SCU_TC.033] TESTMODE pin shall be held at static level during LBIST

Description

The MISR signatures documented in the product specific TC3xy Appendix to the TC3xx User's Manual are only valid if the TESTMODE pin (P20.2) is always kept at a static **high** level during LBIST execution. This is the recommended LBIST configuration.

For a stable MISR signature, the level on this pin must not change during LBIST execution.

Workaround

For application environments where pin TESTMODE is not held high, but a static **low** level is applied to TESTMODE, a different MISR signature will be received in the LBISTCTRL3.SIGNATURE field, depending on bit LBISTCTRL1.BODY.

Table 12 Contents of LBISTCTRL3 if TESTMODE is low during LBIST

Device	Design step	LBISTCTRL3	
		BODY = 0	BODY = 1
TC39x	BA..BC	0x07EC4205	0xFE614D6
	BD	0x935E836A	0x6A14D5B9
TC38x	AA..AD	0x1E1CD10C	0xA7587528
	AE	0x3AD1859B	0x839521BF
TC37xEXT	AA, AB	0x01E51F27	0xEDB9BD01
TC37x	AA	0x62DD6AB1	0xA373D89F
TC36x	AA	0xD833B421	0xF53338B3
TC35x	AB	0xBA38B3CB	0x1CACD3CE
TC33xEXT	AA	0xD1298927	0x1A824479
TC33x/TC32x	AA	0xC12B66CB	0x3F84CD94
TC3Ex	AA	0x4D0F493B	0xE7764C81

2.124 [SMU_TC.012] Unexpected alarms when registers FSP or RTC are written

Description TC2xx

Due to a synchronization issue, ALM3[27] is sporadically triggered if the PRE2 field of register FSP is written while the SMU is configured in Time Switching protocol (FSP.MODE = 10_B) and FSP[0] is toggling with a defined T_{SMU_FFS} period.

Also, ALM3[27] is sporadically triggered if the PRE1 or TFSP_HIGH fields of register FSP are written while the SMU is in the Fault State and T_{FSP_FS} has not yet been reached (STS.FSTS=0_B) (regardless of the FSP.MODE configuration).

In addition, an unexpected ALM2[29] or ALM2[30] is sporadically triggered if field FSP.PRE1 or RTC.RTD is written, and at least one recovery timer is running based on a defined T_{SMU_FS} period (regardless of the FSP.MODE configuration).

The alarms can only be cleared with cold or warm Power-On reset.

2 Functional deviations

Description TC3xx

Due to a synchronization issue, ALM6[7] and ALM10[21] are sporadically triggered if the PRE2 field of register FSP is written while the SMU is configured either

- in Time Switching protocol (FSP.MODE = 10_B) and FSP[0] is toggling with a defined T_{SMU_FFS} period
- or in Dual Rail protocol (FSP.MODE = 01_B) and FSP[1:0] are toggling with a defined T_{SMU_FFS} period

Also, ALM6[7] and ALM10[21] are sporadically triggered if the PRE1 or TFSP_HIGH fields of register FSP are written while the SMU is in the Fault State and T_{FSP_FS} has not yet been reached (STS.FSTS=0_B) (regardless of the FSP.MODE configuration).

In addition, an unexpected ALM10[16] or ALM10[17] is sporadically triggered if field FSP.PRE1 or RTC.RTD is written, and at least one recovery timer is running based on a defined T_{SMU_FS} period (regardless of the FSP.MODE configuration).

The alarms can only be cleared with cold or warm Power-On reset.

Workaround TC2xx

To avoid unexpected alarms, perform the configuration of the PRE1, PRE2 or TFSP_HIGH fields only when the SMU is not in the Fault State and FSP is in Bi-stable protocol mode (FSP.MODE = 00_B). Mode switching and configuration shall not be done with the same write access to register FSP.

This means that in the Fault Free State:

- before writing to PRE1, PRE2 or TFSP_HIGH while Time Switching protocol is enabled:
 - disable Time Switching protocol by setting FSP in Bi-stable protocol mode (FSP.MODE = 00_B);
 - wait until Bi-stable protocol mode is active (read back register FSP twice);
 - write desired value to PRE1, PRE2 or TFSP_HIGH;
 - then switch FSP.MODE to the desired protocol (optional step)
- If the mode shall be changed after writing to PRE1, PRE2 or TFSP_HIGH while in Bi-Stable protocol mode (FSP.MODE = 00_B):
 - write desired value to PRE1, PRE2 or TFSP_HIGH;
 - then switch FSP.MODE to Time Switching protocol

If field FSP.PRE1 or RTC.RTD shall be written, make sure no recovery timer is running. It is not allowed to write to the PRE1 or RTD field when at least one recovery timer is running (indicated by bits RTS0 and RTS1 in the STS register).

Workaround TC3xx

To avoid unexpected alarms, perform the configuration of the PRE1, PRE2 or TFSP_HIGH fields only when the SMU is not in the Fault State and FSP is in Bi-stable protocol mode (FSP.MODE = 00_B). Mode switching and configuration shall not be done with the same write access to register FSP.

This means that in the Fault Free State:

- before writing to PRE1, PRE2 or TFSP_HIGH while Time Switching or Dual Rail protocol is enabled:
 - disable Time Switching or Dual Rail protocol by setting FSP in Bi-stable protocol mode (FSP.MODE = 00_B);
 - wait until Bi-stable protocol mode is active (read back register FSP twice);
 - write desired value to PRE1, PRE2 or TFSP_HIGH;
 - then switch FSP.MODE to the desired protocol (optional step)
- If the mode shall be changed after writing to PRE1, PRE2 or TFSP_HIGH while in Bi-Stable protocol mode (FSP.MODE = 00_B):
 - write desired value to PRE1, PRE2 or TFSP_HIGH;
 - then switch FSP.MODE to Time Switching or Dual Rail protocol

If field FSP.PRE1 or RTC.RTD shall be written, make sure no recovery timer is running. It is not allowed to write to the PRE1 or RTD field when at least one recovery timer is running (indicated by bits RTS0 and RTS1 in the STS register).

2 Functional deviations

2.125 [SMU_TC.013] Unexpected setting of Alarm Missed Event bit xAEM in Alarm Executed Status register SMU_AEX

Description

Note: *This problem only applies to alarms of Alarm Type: Level (see tables “Alarm Mapping related to ALM* group” in the product specific Appendix to the TC3xx User’s Manual).*

While servicing an alarm with alarm type Level, request status bit xSTS in the SMU_AEX register is set. However, the corresponding alarm missed event bit xAEM is also set, 1 cycle after the xSTS bit is set for the same alarm event (x can be any of IRQ0..2, RST0..5, NMI, EMS).

Workaround

While clearing the xSTS bit the corresponding xAEM bit should also be cleared for the alarm event.

If the xAEM bit is not cleared while clearing xSTS, only the alarm missed event xAEM functionality will not be available for later alarm events, and it does not impact any alarm action generation and xSTS bit functionality.

2.126 [SMU_TC.015] SMU alarm emulation might trigger unwanted active alarm reaction

Description

While the SMU is in START state, an alarm is raised by the hardware. Since the SMU is in START state, the corresponding configured reaction, for example RESET_REQ, is not triggered. In this context, another alarm for which there is no SMU reaction configured, is triggered by the software either by raising a software alarm or by using the alarm emulation function of SMU. The expected behavior is that SMU does not react to the software triggered alarms, however, the alarm reaction of previously set alarm, for example RESET_REQ would unexpectedly be triggered.

Scope

Alarm emulation

Effects

Unintended alarm reaction. The actual reaction will depend on the configuration.

Workaround

While the SMU is in START state, all alarms must be cleared in SMU and at the source safety mechanism before using the alarm emulation function, or before triggering a software alarm.

3 Parametric deviations

3 Parametric deviations

3.1 [ADC_TC.P017] Increased RMS noise for TC33x/32x devices

Description

Note: This problem depends on the package type and affects the variants TC333*/TC323* (devices in TQFP-100 package), TC334*/TC324* (devices in TQFP-144 package), TC337*/TC327* (devices in BGA-292 package), and TC336* (devices in BGA-180 package).

For these devices, on some or all channels the specified RMS noise (EN_{RMS}) increases, independent of the noise reduction mode, as listed in Table 13 below.

Table 13 RMS noise for TC33x and TC32x, independent of noise reduction mode

Device Variant	Package	Analog channel ANx	EN_{RMS} (Max.)
TC333*, TC323*	TQFP-100	AN37, AN38, AN39	1.0 LSB
TC334*, TC324*	TQFP-144	AN0, AN39	1.0 LSB
TC337*, TC327*	BGA-292	all ANx	1.0 LSB
TC336*	BGA-180	AN0	1.2 LSB
		AN2, AN3, AN5, AN6, AN39	1.0 LSB

3.2 [CCU_TC.P001] Back-up clock accuracy after trimming - Disregard datasheet footnote

Description

The following text in the footnote on parameter “Back-up clock accuracy after trimming” in table “Back-up Clock” of the current TC3xx datasheets cannot be met under all operating conditions:

- A short term trimming providing the accuracy required by LIN communication is possible by periodic trimming every 2 ms for temperature and voltage drifts up to temperatures of 125° Celsius

This footnote shall be disregarded.

3.3 [FLASH_TC.P003] Program Flash Erase Time per Multi-Sector Command

Description

The maximum value for parameter “Program Flash Erase Time per Multi-Sector Command” can be

- $t_{MERP} \leq 0.52$ s (instead of 0.5 s as specified in the Data Sheet)

Consequently, the maximum value for parameter “Complete Device Flash Erase Time PFlash and DFlash” can also increase by 0.04 s/Mbyte, resulting in

- TC39x:** $t_{ER_Dev} \leq 19.14$ s (instead of 18.5 s as specified in the Data Sheet)
- TC38x:** $t_{ER_Dev} \leq 11.9$ s (instead of 11.5 s as specified in the Data Sheet)
- TC3Ex:** $t_{ER_Dev} \leq 14.98$ s (instead of 14.5 s as specified in the Data Sheet)
- TC37x, TC37xEXT:** $t_{ER_Dev} \leq 7.24$ s (instead of 7 s as specified in the Data Sheet)
- TC35x, TC36x:** $t_{ER_Dev} \leq 5.16$ s (instead of 5 s as specified in the Data Sheet)
- TC33xEXT, TC33x/TC32x:** $t_{ER_Dev} \leq 3.08$ s (instead of 3 s as specified in the Data Sheet)

The increased values should be considered for example when defining erase timeout limits.

3 Parametric deviations

3.4 [PADS_TC.P014] Electrical characteristics for P20.2/ $\overline{\text{TESTMODE}}$

Description

The buffer type for P20.2/ $\overline{\text{TESTMODE}}$ is defined in column "Buffer Type" of table "Port 20 Functions" in the Data Sheet as "class S/PU / VEXT".

The electrical characteristics specified in table "Class S 5V" and "Class S 3.3V" (if present in the Data Sheet) literally only apply to class S pads on P40 (and P41 if available), as they are connected to V_{DDM} .

Recommendation

Tables "Class S 5V" and "Class S 3.3V" apply analogously to the electrical characteristics of P20.2/ $\overline{\text{TESTMODE}}$, with V_{DDM} replaced by V_{EXT} .

Note: The current Data Sheets for TC35x and TC33xEXT do not include tables for class S pads (they do not have P40). Therefore, please see the Data Sheet for one of the other TC3xx devices.

Note: The current Data Sheet for TC36x does not include table "Class S 3.3V". Therefore, please see the Data Sheet for one of the other TC3xx devices.

3.5 [PORST_TC.P002] V_{IH} and V_{IL} definition for PORST pad - Additional Data Sheet footnote

Description

The following footnote shall be added in column "Note/Test Condition" of Data Sheet table "PORST Pad" to the parameters "Input high voltage level" (symbol V_{IH}) and "Input low voltage level" (symbol V_{IL}):

Note: The levels defined are valid within the operating conditions of $V_{\text{EXT}} = 5\text{ V} \pm 10\%$ or $V_{\text{EXT}} = 3.3\text{ V} \pm 10\%$, respectively.

3.6 [PWR_TC.P015] Power pattern definition - Documentation update to TC33x/TC32x Data Sheet V1.1

Description

The TC33x/TC32x includes one TC1.6.2P core with lockstep (checker) core.

Therefore, the bullet points related to these cores in the description of the real and max power pattern in chapter "Power Supply Current" of the TC33x/TC32x Data Sheet shall be changed as follows:

Documentation update

The real (realistic) power pattern defines the following conditions:

- one core is active with lockstep core (IPC=0.6) (instead of "one cores is active without lockstep core (IPC=0.6)")

The max power pattern defines the following conditions:

- one core is active with lockstep core (IPC=1.2) (instead of "all cores are active including one lockstep core (IPC=1.2)")

3 Parametric deviations

3.7 [VEVRSB_TC.P001] Bonding of VEVRSB pad on LQFP packages - Data Sheet documentation correction

Description

Column “Note/Test Condition” in table “Operating Conditions” for parameter “Digital external supply voltage for EVR and during Standby mode” (symbol V_{EVRSB}) of the Data Sheet contains the following statement:

- VEVRSB is bonded together with VEXT supply pin in smaller LQFP packages

This statement does not apply and shall be deleted.

Note: *Pin VEVRSB is not bonded together with VEXT supply pin and must be supplied accordingly. See also figure “TC33x Supply Pins and Module Connectivity” in the PMSLE chapter of the TC3xx User’s Manual which includes the statement “External supply is separated into sub-domains not connected internally: VEXT, VEVRSB, VFLEX, VDDM & VEBU”.*

4 Application hints

4 Application hints

4.1 [ADC_TC.H026] Additional waiting phase in slow standby mode

Description

When a conversion is requested while slow standby mode is configured and the respective converter currently is in standby state, the extended wakeup time t_{WU} must be added to the intended sample time (see section “Analog Converter Control” in the TC3xx User's Manual).

While idle precharge is disabled ($GxANCFG.IPE = 0_B$), an additional waiting phase of $1.6 \mu s$ ($@f_{ADC} = 160 \text{ MHz}$) is inserted automatically. Operation starts after this phase.

However, if the slow standby state is left after just 1 clock cycle, this waiting phase is omitted.

Recommendation

It is, therefore, recommended to add the specified extended wakeup time (t_{WU}) when leaving the standby state in all cases, to ensure proper operation.

4.2 [ADC_TC.H032] ADC accuracy parameters - Definition

Description

Chapter “VADC Parameters” in the Data Sheet contains the following introduction section:

“The accuracy of the converter results depends on the reference voltage range. The parameters in the table below are valid for a reference voltage range of $(V_{AREF} - V_{AGND}) \geq 4.5 \text{ V}$. If the reference voltage range is below 4.5 V by a factor of k (e.g. 3.3 V), the accuracy parameters increase by a factor of $1.1/k$ (e.g. $1.1 \times 4.5 / 3.3 = 1.5$).”

Accuracy parameters in the context of the statement above are:

- Total Unadjusted Error (TUE)
- INL Error (EA_{INL})
- DNL Error (EA_{DNL})
- Gain Error (EA_{GAIN})
- Offset Error (EA_{OFF})
- RMS Noise (EN_{RMS})
- Converter diagnostics voltage accuracy (dV_{CSD})
- Deviation of IVR output voltage V_{DDK} (dV_{DDK})

4.3 [ADC_TC.H033] Basic initialization sequence for primary and secondary EVADC groups

Description

For consistency, to ensure that the maximum value for the settling time of the analog module is always considered in the basic initialization sequence, the start-up calibration should be started **after** a waiting time equal or higher than the extended wakeup time (t_{WU}). The related basic initialization sequence is described in the following execution scheme.

Note: Compared to the sequence listed in chapter “Basic Initialization Sequence” in the EVADC chapter of TC3xx User's Manual V1.2.0 and earlier versions, step “WAIT” (third step below) has been shifted **before** the begin of the start-up calibration.

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```
EVADC_GxANCFG = 0x00300000
;Analog clock frequency is 160 MHz / 4 = 40 MHz (example)
;CALSTC = 00
EVADC_GxARBCFG = 0x00000003 ;Enable analog block
WAIT ;Pause for extended wakeup time (≥ 5 μs)
;(other operations not related to EVADC can be executed in the meantime)
EVADC_GLOBCFG = 0x80000000 ;Begin start-up calibration
EVADC_GxARBPR = 0x01000000 ;Enable arbitration slot 0
EVADC_GxQMR0 = 0x00000001 ;Enable request source 0
EVADC_GxICLASS0 = 0x00000002
;Select 4 clocks for sampling time: 4 / 40 MHz = 100 ns
;The default setting stores results in GxRES0,
;service requests are issued on GxSR0
EVADC_GxRCR0 = 0x80000000
;Enable result service requests, if required
EVADC_GxQINR0 = 0x00000020
;Request channel 0 in auto-repeat mode
WAIT ;Wait for start-up calibration to complete *)
;(other operations not related to EVADC can be executed in the meantime)
;=> This starts continuous conversion of the channel
*)time tSUCAL or flag GxARBCFG.CAL=0
```

4.4 [ADC_TC.H035] Effect of input leakage current on Broken Wire Detection

Description

The Broken Wire Detection (BWD) feature uses the sample capacitor of the ADC input to discharge (BWG: Broken Wire Detection against V_{AGND}) or to charge (BWR: Broken Wire Detection against V_{AREF}) the input node of the ADC.

This mechanism can be seen as small current sink (BWG) or current source (BWR). When the BWD feature is enabled, in case the ADC input is not connected to an external voltage source (i.e. the wire is broken), the ADC input voltage is drifting down or up. When a defined voltage level (i.e. the detection threshold) is reached, “broken wire detected” is claimed.

Broken Wire Detection currents I_{BWG} , I_{BWR} are quite small and must overwhelm input leakage currents I_{OZ} on the same node. Input leakage currents depend exponentially on junction temperature.

It is therefore required to check whether an application using Broken Wire Detection can deal with leakage currents also under worst case conditions.

Application considerations

1. Get the input leakage current (I_{OZ}) limits from the Data Sheet, depending on used ADC pins and maximum junction temperature T_J of your application
2. Compare this limit against the Broken Wire Detection currents I_{BWG} , I_{BWR} , which can be calculated as follows:
 - Broken Wire Detection against V_{AGND} (BWG):
 - $I_{BWG} = V_{AIN} * C_{AINS} * CR$
 - Broken Wire Detection against V_{AREF} (BWR):
 - $I_{BWR} = (V_{AIN} - V_{AREF}) * C_{AINS} * CR$

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where

- V_{AIN} : ADC input voltage at the detection threshold (typ. 10% of full scale for BWD, 80% of full scale for BWR)
- C_{AINS} : ADC input sampling capacitance, typ. 2.5 pF
- CR : Conversion Rate, that is number of conversions per second per input

Recommendation

The absolute value of the Broken Wire Detection current (I_{BWG} or I_{BWR}) at the BWD threshold shall be at least 2x the maximum input leakage current I_{OZ} (absolute value).

Examples

1. Typical case example

Assuming that $T_J \leq 150^\circ\text{C}$ (max) and ADC inputs are used in a configuration where $I_{OZ} \leq 150$ nA (see Data Sheet), I_{BWG} should be ≥ 300 nA according to the recommendation above.

With $C_{AINS} = 2.5$ pF and $V_{AIN} = 0.5$ V (10% of full scale) it can be calculated from the formula for I_{BWG} above that CR should be $\geq 240\,000$ samples per second and input.

2. Worst case example

Assuming that $T_J \leq 170^\circ\text{C}$ (max) and ADC inputs are used in a configuration where $I_{OZ} \leq 800$ nA (see Data Sheet), I_{BWG} should be ≥ 1600 nA according to the recommendation above.

With $C_{AINS} = 2.5$ pF and $V_{AIN} = 0.5$ V (10% of full scale) it can be calculated from the formula for I_{BWG} above that CR should be $\geq 1\,280\,000$ samples per second and input.

Recommendations for increasing the Broken Wire Detection current

In order to increase the Broken Wire Detection current,

1. Relax the detection threshold, for example for BWG from 10% to 20% of the full scale voltage
2. Increase the conversion rate CR per input by introducing additional conversions

4.5 [ADC_TC.H040] Selection of masters for synchronization groups - Documentation update to TC33x/TC32x Appendix

Description

The 4 converter kernels of the TC33x/TC32x can be connected to synchronization groups to achieve parallel conversion of several input channels.

Figure “Synchronization via ANON and Ready Signals” in the EVADC chapter of the TC3xx User’s Manual shows how a master is selected via bit-field $GxSYNCTR.STSEL$. In this figure, kernels ADC0 and ADC1 relate to converter group G0 and G1, while ADC2 and ADC3 relate to G8 and G9 of the TC33x/TC32x, respectively.

However, the mapping in the rows for G8 and G9 in the corresponding table “Synchronization Groups” in the EVADC chapter of the TC33x/TC32x Appendix V2.0.0 and earlier versions is incorrect and shall be updated as follows.

Documentation Update

The following table summarizes which kernels can be synchronized for parallel conversions in the TC33x/TC32x (corrections in rows for G8 and G9 shown in **bold**).

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Table 14 Synchronization Groups of TC33x/TC32x

ADC Kernel	Synchr. Group	Master selected by control input Clx ¹⁾			
		CI0 ²⁾	CI1	CI2	CI3
G0 (Prim.)	A	G0	G1	G8	G9
G1 (Prim.)	A	G1	G0	G8	G9
G8 (Sec.)	A	G8	G0	G1	G9
G9 (Sec.)	A	G9	G0	G1	G8

- 1) The control input is selected by bit-field STSEL in register GxSYNCTR. Select the corresponding ready inputs accordingly by bits EVALRx.
- 2) Control input CI0 always selects the own control signals of the corresponding ADC kernel. This selection is meant for the synchronization master or for stand-alone operation.

4.6 [ADC_TC.H043] Information on supervision signal $V_{ANACOMM}$ not relevant - Documentation update

Description

The functionality of supervision signal $V_{ANACOMM}$ listed in table “Supervision Signals” of the EVADC chapter in the TC3xx User’s Manual V2.0.0 (and earlier versions) can only be used during the Infineon production test. It cannot be used in a customer application.

Documentation update

Disregard the first line about $V_{ANACOMM}$ in table “Supervision Signals” in the EVADC chapter of the TC3xx User’s Manual.

4.7 [ADC_TC.H044] Start-up calibration timing in synchronized mode - Documentation update

Description

The formula for the start-up calibration duration t_{SUCAL} in the EVADC chapter of the TC3xx user manual is not valid for all of the different configurations:

- In the synchronized mode (GLOBCFG.USC=0, default after reset), each calibration step is waiting for a valid starting point and this prolongs the total calibration time

Documentation update

In section “Start-Up Calibration Timing” in the EVADC chapter of the TC3xx user manual, a second footnote ²⁾ shall be added to the formula for t_{SUCAL} :

- ²⁾ In the synchronized mode (USC=0), t_{SUCAL} can increase up to 200%

4.8 [ADC_TC.H045] Level selection for broken wire detection feature

Description

The broken wire detection (BWD) feature uses the sample capacitor of the ADC input to discharge (BWD against V_{AGND}) or to charge (BWD against V_{AREF}) the input node of the EVADC. The level (V_{AREF} or V_{AGND}) is selected in the bit-field BWDCH as documented in the description of register GxCHCTry in the EVADC chapter of the TC3xx user manual.

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However, the text in the EVADC chapter only describes BWD against V_{AGND} , it does not explicitly describe BWD against V_{AREF} .

Documentation update

The description related to broken wire detection (BWD) in the following parts of the EVADC chapter shall be updated to reflect both BWD against V_{AGND} and BWD against V_{AREF} :

- Section "Safety Features"

Broken wire detection (BWD) preloads the converter network with a selectable level before sampling the input channel. The result will then reflect the preload value if the input signal is no more connected

- Chapter "Broken Wire Detection"

To test the proper connection of an external analog sensor to its input pin, the converter's capacitor can be precharged to a selectable value before the regular sample phase. If the connection to the sensor is interrupted, the subsequent conversion value will rather represent the precharged value than the expected sensor result. By using a precharge voltage outside the expected result range (broken wire detection uses V_{AGND} or V_{AREF}) a valid measurement (sensor connected) can be distinguished from a failure (sensor detached)

Broken wire detection can be enabled for each channel separately by the bit-field BWDEN in the corresponding channel control register (GxCHCTRY). The bit-field BWDCH selects the level for the preparation phase

4.9 [ADC_TC.H046] Incorrect number of EVADC kernels in TC33x/TC32x Datasheet

Description

In the TC33x/TC32x Datasheet, the section "Summary of features" contains the following statement:

- Cluster of 2 independent ADC kernels

The number of ADC kernels listed in the bullet point is incorrect. TC33x and TC32x have 2 primary and 2 secondary groups, as described in the table "Platform Feature Overview" in the TC33x/TC32x Datasheet.

Documentation update

For TC33x and TC32x, the number of independent ADC kernels mentioned in the section "Summary of Features" must be corrected to 4 instead of 2.

4.10 [ASCLIN_TC.H001] Bit field FRAMECON.IDLE in LIN slave tasks

Description

For LIN performing slave tasks, bit-field FRAMECON.IDLE has to be set to 000_B (default after reset), i.e. no pause will be inserted between transmission of bytes.

If FRAMECON.IDLE $> 000_B$, the inter-byte spacing of the ASCLIN module is not working properly in all cases in LIN slave tasks (no bit errors are detected by the ASCLIN module within the inter-byte spacing).

4.11 [ASCLIN_TC.H006] Sample point position when using three samples per bit

Description

As documented in the description of field BITCON.SAMPLEPOINT, "... if three sample points at position 7, 8, 9 are required, this bit-field would contain 9".

In general, if three samples per bit are selected (BITCON.SM = 1_B), field BITCON.SAMPLEPOINT defines the position of the last sample point.

4 Application hints**Documentation update**

The text related to three sample points in figure “ASCLIN Bit Structure” in the ASCLIN chapter of the user manual should be updated as follows:

- 16x Oversampling, 3 sample points, relevant sample position 7, 8, 9 (BITCON.OVERSAMPLING = 16, BITCON.SM = 1, BITCON.SAMPLEPOINT = 9)
 - instead of “16x Oversampling, 3 sample points, relevant sample position 8”
- 8x Oversampling, 3 sample points, relevant sample position 3, 4, 5 (BITCON.OVERSAMPLING = 8, BITCON.SM = 1, BITCON.SAMPLEPOINT = 5)
 - instead of “8x Oversampling, 3 sample points, relevant sample position 4”

4.12 [ASCLIN_TC.H007] Handling TxFIFO and RxFIFO interrupts in single move mode**Present description for TxFIFO single move mode**

As described in section “Single Move Mode” of chapter “TxFIFO interrupt generation” in the user manual, the purpose of the Single Move Mode is to keep the TxFIFO as full as possible, refilling the TxFIFO by writing to it as soon as there is a free element. The single move mode supports primarily a DMA operation using single move per TxFIFO interrupt.

See also the note at the end of this section in the user manual.

"In Single Move Mode multiple software writes or block DMA moves would lead to multiple interrupts and (false) transaction lost events. Therefore they should be avoided - only single moves should be used."

To complement the above description, the following two sentences shall be added to the section before the reference to figure “Interrupt generation in the single move mode” in the user manual.

Documentation update for TxFIFO single move mode

If TxFIFO can handle new data, it generates an interrupt but expects just one data of the defined frame width. The DMA or the user should not write multiple data at once to avoid unexpected behavior.

Present description for RxFIFO single move mode

As described in section “Single Move Mode” of chapter “RxFIFO interrupt generation” in the user manual, the purpose of the Single Move Mode is to keep the RxFIFO as empty as possible, by fetching the received elements one by one as soon as possible. The single move mode supports primarily a DMA operation using single move per RxFIFO interrupt.

See also the note at the end of this section in the user manual.

"In Single Move Mode multiple software reads or block DMA moves lead to multiple interrupts and (false) transaction lost events. Therefore they should be avoided - only single moves should be used."

To complement the above description, the following two sentences shall be added to the section before the reference to figure “RxFIFO - Interrupt Triggering in the Single Move Mode” in the user manual.

Documentation update for RxFIFO single move mode

If RxFIFO can handle new data, it generates an interrupt but fetches just one data of the defined frame width. The DMA or the user should not read multiple data at once to avoid unexpected behavior.

4.13 [ASCLIN_TC.H008] SPI master timing – Additional information to Data Sheet characteristics**Description**

The following note shall be added to chapter “ASCLIN SPI Master Timing” in the Data Sheet:

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Note: *The specified timings describe the pad capabilities for the respective driver strength configuration. For the maximum achievable baud rate in a given application, the MRST input timings need to be considered in particular.*

Background information

Chapter “ASCLIN SPI Master Timing” in the Data Sheet contains separate tables for different output driver configurations. As can be seen from these tables, the master output timings directly depend on the selected driver strength. The corresponding parameters are marked as controller characteristics with symbol “CC”.

The setup and hold timings for input data received from the slave are marked as system requirements with symbol “SR”. They must be provided by the system in which the device is designed in.

In a given application, the maximum rate at which data can be received from a slave on the master receive input MRST may be limited by the required setup time t_{52} (MRST setup to ASCLKO latching edge). As data is shifted by the slave on one edge of ASCLKO and latched by the master on the opposite edge, one phase of ASCLKO must always be greater than the minimum required MRST setup time (assuming the sampling point is in the middle). This means the ASCLKO period t_{50} must be $> 2 \times t_{52}$.

4.14 [BROM_TC.H009] Re-enabling lockstep via BMHD

Description

For all CPUs with lockstep option, the lockstep functionality is controlled by Boot Mode Headers (BMHD) loaded during boot upon a reset trigger.

If lockstep is disabled for a CPUx with lockstep functionality, re-enabling (for example via a different BMHD) is not reliably possible if warm PORST, System or Application reset is executed.

Recommendation

Use cold PORST if lockstep is disabled and shall be re-enabled upon the reset trigger.

4.15 [BROM_TC.H014] SSW behavior in case of wrong state or uncorrectable error in UCBs - Documentation Update

Description

The boot sequence terminates and the device is put into error state (endless loop) in the following cases:

- **Wrong state** - i.e. different from CONFIRMED or UNLOCKED (in case an UCB has ORIGINAL and COPY: wrong state of the both) – for the following UCBs:
 - UCB_BMHDx, UCB_SWAP, UCB_SSW, UCB_USER, UCB_PFLASH, UCB_DFLASH, UCB_DBG, UCB_HSM, UCB_HSMCOTP0...1, UCB_HSMCFG, UCB_ECPRIO, UCB_OTP0...7, UCB_REDSEC, UCB_TEST, UCB_RETEST
- **Uncorrectable ECC error** within the used locations when state valid (CONFIRMED or UNLOCKED) – for the following UCBs:
 - UCB_SSW, UCB_PFLASH, UCB_DFLASH, UCB_DBG, UCB_HSM, UCB_HSMCOTP0...1, UCB_ECPRIO, UCB_OTP0...7, UCB_REDSEC, UCB_RETEST
- For UCB_SWAP ORIGINAL/COPY – according to the descriptions in user manual

Recommendation

Instructions to be followed for UCB-reprogramming (in order to avoid unexpected boot termination):

- Always verify the changed contents before confirming the UCB state
- Strictly follow the sequence in section “UCB Confirmation” in the “Non Volatile Memory (NVM)” chapter of the user manual

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4.16 [BROM_TC.H020] Processing in case no valid BMHD found

Description

The section "Processing in case no valid BMHD found" in the Firmware chapter of the TC3xx user manual states in step 4 as follows:

- 4. instal the address with offset 0x0020 in logical sector S40 in PFLASH0 (I.e. 0xA000A020) as user code start address into BOOT_ADDR

The absolute address specified in the above sentence is incorrect. It must be 0xA00A0020 instead of 0xA000A020.

Documentation update

The absolute address specified in step 4 in the section "Processing in case no valid BMHD found" in the Firmware chapter of the TC3xx user manual shall be corrected as follows:

- 4. Install the address with offset 0x0020 in logical sector S40 in PFLASH0 (that is 0xA00A0020) as user code start address into BOOT_ADDR

4.17 [CCU6_TC.H001] CCU6 module clock source information - Documentation Update

Description

In the CCU6 module chapter of the AURIX™ TC3xx User's manual, the CCU6 module clock source information is missing.

Documentation update

The CCU6 module is clocked with the SPB clock, so $f_{CC6} = f_{SPB}$.

See also figures "Clocking System example" in the Clocking System chapter of the TC3xx User's manual, where the CCU6 module is connected to f_{SPB} .

4.18 [CCU_TC.H012] Configuration of the Oscillator- Documentation Update

Description

As described in chapter „Configuration of the Oscillator" in the CCU chapter of the User's Manual, configuration of the oscillator is always required before an external crystal / ceramic resonator can be used as clock source.

Depending on the supply voltage ramp-up characteristics the behavior described in the following note may be observed:

Note: *If VEXT is present then the oscillator could start oscillating (crystal/resonator connected). As soon as Cold PORST of AURIX™ is released, the oscillator is set to External Input Mode and the oscillation decays. This characteristic behavior has no impact on the oscillator start-up as initiated by software.*

4.19 [CLC_TC.H001] Description alignment for bits DISR, DISS, EDIS in register CLC - Documentation Update

Description

For the description of bits DISR, DISS, and EDIS (if available) in register CLC (and CLC1 for I2C), different styles are used in the current version of the TC3xx user manual.

4 Application hints

For the following modules, the function of these bits depending on their status (0_B or 1_B) is not explicitly described:

- ASCLIN, CIF, E-RAY, FCE, GETH, GTM, HSPDM, HSSL (incl. HSCT), I2C, MCMCAN, MSC, PSI5, PSI5-S, QSPI, SDMMC, SENT, STM

For these modules, the missing parts of the bit description can be taken from the following general description:

Table 15 General description of bits DISR, DISS, EDIS in register CLC

Field	Bits	Type	Description
DISR	0	rw	Module Disable Request Bit Used for enable/disable control of the module 0 _B No disable requested 1 _B Disable requested
DISS	1	rh	Module Disable Status Bit Bit indicates the current status of the module 0 _B Module is enabled 1 _B Module is disabled
EDIS	3	rw	Sleep Mode Enable Control Used for module Sleep Mode control 0 _B Sleep Mode request is regarded. Module is enabled to go into Sleep Mode on a request. 1 _B Sleep Mode request is disregarded: Sleep Mode cannot be entered on a request.

Notes:

1. Bit EDIS is not implemented for the following of the modules listed above: CIF, GETH, I2C, SDMMC
2. In the FCE module, the bit at position of EDIS is of type 'rw', but without function and not shown in the user manual
3. In the EDSADC, GTM, STM modules bit DISS is of type 'rh', but shown as 'r' in the user manual

4.20 [CPU_TC.H022] Store buffering and the effect of bit SMACON.IODT

Description

To increase performance, the TC1.3.1, TC1.6.*, and TC1.8 CPUs implement store buffering. In normal operation, with bit SMACON.IODT=0_B (default after reset), non-dependent loads may bypass store operations. To improve the performance of load operations, the CPU will snoop the content of the store buffer for a matching address. If a match is found, the load data is retrieved from the store buffer before the store is committed to memory. For further details, see the chapter "Store Buffers" in the TC3xx user manual.

In this context, the following statements included in the CPU chapter of TC3xx user manual may be misleading:

- In the chapter "Store Buffers": Store buffer operation may be disabled by setting the SMACON.IODT bit
- In the description of register SMACON in the chapter "Memory Integrity Registers" for IODT=1_B: In-order operation, loads always flush preceding stores, processor store buffer disabled

Recommendation

Effectively, setting SMACON.IODT=1_B results in memory operations to be performed in program order, where loads always flush preceding stores.

4 Application hints

As described in the user manual, setting `SMACON.IODT=1B` should not be done in normal execution, but should only be performed by test routines at start-up or shut-down, as it will severely limit performance.

If there is a requirement that data is written to local memory prior to execution of a subsequent instruction then a `DSYNC` instruction may be used to flush the store buffers.

4.21 [CPU_TC.H023] CPU_SYSCON register safety protection description clarification

Description

The usage of `SAFETY_ENDINIT` protection of the CPU system control register (`CPU_SYSCON`) is configurable by the application software. From system reset, as well as after any kernel reset, the register is not subject to `SAFETY_ENDINIT` protection. This information is not conveyed in the register overview table which states that the register is always subject to `SAFETY_ENDINIT` protection. Clearing the compatibility control register safety protection field (`COMPAT.SP=0B`) enables the `SAFETY_ENDINIT` protection of `CPU_SYSCON[31:1]`.

Note: *`CPU_SYSCON[0]` is never subject to `SAFETY_ENDINIT` protection.*

Scope

This problem is limited to the `CPU_SYSCON` register.

Effects

After kernel reset, the `CPU_SYSCON` register is not subject to the `SAFETY_ENDINIT` protection; which is compatible with the earlier devices.

Workaround

To ensure that `CPU_SYSCON[31:1]` is subject to `SAFETY_ENDINIT` protection, the application software must clear `COMPAT.SP`.

4.22 [DMA_TC.H018] Maximum size of circular buffers is 32 Kbytes

Description

Section "Circular Buffer" in the DMA chapter of the user manual states:

- "Possible buffer sizes of the circular buffers can be 2^{CBLS} or 2^{CBLD} bytes (= 1, 2, 4, 8, 16, ... up to 64k bytes)"
The maximum size specified in that sentence is incorrect.

Documentation update

The maximum size of the circular buffers is 32 Kbytes. The corresponding sentence in the user manual shall be corrected as follows:

- Possible buffer sizes of the circular buffers can be 2^{CBLS} or 2^{CBLD} bytes (= 1, 2, 4, 8, 16, ... up to 32 Kbytes)

4.23 [DTS_TC.H002] Unexpected alarms after start-up/wake-up when temperature is close to lower/upper limit

Description

The result of the first temperature measurement received from the Die Temperature Sensor (DTS) after start-up from cold PORST or wake-up from standby mode is inaccurate due to parallel processing of sensor trimming.

4 Application hints

Effect

If temperature is close ($< 10\text{ K}$) to the thresholds defined in register DTSLIM, alarms ALM9[0] or ALM9[1] in SMU_core and ALM21[9] or ALM21[8] in SMU_stdby can be triggered falsely indicating lower temperature limit underflow (ALM9[1], ALM21[8]) or upper limit overflow (ALM9[0], ALM21[9]). Also, the corresponding flag DTSLIM.LLU or DTSLIM.UOF is set.

Recommendation

The application software shall clear the respective flag in DTSLIM and **afterwards** clear related SMU alarms. In case alarms are retriggered, application SW shall consider these as real alarms, and trigger a reaction within the FTTI (Fault Tolerant Time Interval) of the respective application.

4.24 [EVR_TC.H001] External input capacitor value - Additional Data Sheet footnote

Description

The following footnote shall be added to parameter “External input capacitor value” (symbol C_{IN}) in table “EVRC SMPS External components” in the TC3yx Data Sheets:

Note: *From EVRC view there is no defined hard limit for the maximum value of the input capacity, the specified upper limit is determined by the measurement setup. From EVRC view, the typical value of C_{IN} can be up to $\sim 4\times$ higher compared to the value listed in the Data Sheet.*

4.25 [FLASH_TC.H021] Flash Wait State configuration

Description

Configuring flash wait states in your application is critical for correct operation.

Refer to these parts of the documentation of the respective TC3*x design step for guidance on avoiding data read errors over the lifetime of the device:

- Data Sheet, chapter “Flash Target Parameters”:
 - minimum access times t_{PF} / t_{PFECC} for PFLASH
 - and t_{DF} / t_{DFECC} for DFLASH
- AURIX™ TC3xx User’s Manual, NVM chapter “Configuring Flash Read Access Cycles” (6.5.2.1.2 in TC3xx User's Manual V2.0.0)
- Application Note AP32381 (AURIX™ 2nd Generation startup and initialisation)

When **increasing** the SRI and FSI clock frequencies: first set registers HF_PWAIT and HF_DWAIT to the correct values, and then change the clock configuration.

When **decreasing** the SRI and FSI clock frequencies: first change the clock configuration, and then set registers HF_PWAIT and HF_DWAIT to the correct values.

Note: *Applications that omit configuration of HF_PWAIT and HF_DWAIT may work in the development phase, but encounter data read errors in the field.*

4 Application hints

4.26 [FLASH_TC.H024] PFLASH erase and program time is affected by time slicing but not clearly documented

Description

In the NVM chapter in the TC3xx user manual, the sub-section "Time Slice Control and Flash Parameters" describes the erase and program time increase due to time slicing. It is mentioned only for DFLASH in the user manual. However, this is applicable for PFLASH also.

Documentation update

The timing penalty of time slicing described in the sub-section "Time Slice Control and Flash Parameters" of the NVM chapter in the TC3xx user manual is applicable not only for DFLASH but it is also applicable for PFLASH operations when running concurrently to HSM operations.

4.27 [FlexRay_AI.H004] Only the first message can be received in External Loop Back mode

Description

If the loop back (TXD to RXD) will be performed via external physical transceiver, there will be a large delay between TXD and RXD.

A delay of two sample clock periods can be tolerated from TXD to RXD due to a majority voting filter operation on the sampled RXD.

Only the first message can be received, due to this delay.

To avoid that only the first message can be received, a start condition of another message (idle and sampling '0' -> low pulse) must be performed.

The following procedure can be applied at one or both channels:

- wait for no activity (TEST1.AOx = 0 -> bus idle)
- set Test Multiplexer Control to I/O Test Mode (TEST1.TMC = 2), simultaneously TXDx = TXENx = 0
- wait for activity (TEST1.AOx = 1 -> bus not idle)
- set Test Multiplexer Control back to Normal signal path (TEST1.TMC = 0)
- wait for no activity (TEST1.AOx = 0 -> bus idle)

Now the next transmission can be requested.

4.28 [FlexRay_AI.H005] Initialization of internal RAMs requires one eray_bclk cycle more

Description

The initialization of the E-Ray internal RAMs as started after hardware reset or by CHI command CLEAR_RAMs (SUCC1.CMD[3:0] = 1100_B) takes 2049 eray_bclk cycles instead of 2048 eray_bclk cycles as described in the E-Ray Specification.

Signalling of the end of the RAM initialization sequence by transition of MHDS.CRAM from 1_B to 0_B is correct.

4.29 [FlexRay_AI.H006] Transmission in ATM/Loopback mode

Description

When operating the E-Ray in ATM/Loopback mode there should be only one transmission active at the same time. Requesting two or more transmissions in parallel is not allowed.

4 Application hints

To avoid problems, a new transmission request should only be issued when the previously requested transmission has finished. This can be done by checking registers TXRQ1/2/3/4 for pending transmission requests.

4.30 [FlexRay_AI.H007] Reporting of coding errors via TEST1.CERA/B

Description

When the protocol engine receives a frame that contains a frame CRC error as well as an FES decoding error, it will report the FES decoding error instead of the CRC error, which should have precedence according to the non-clocked SDL description.

This behavior does not violate the FlexRay protocol conformance. It has to be considered only when TEST1.CERA/B is evaluated by a bus analysis tool.

4.31 [FlexRay_AI.H009] Return from test mode operation

Description

The E-Ray FlexRay IP-module offers several test mode options

- Asynchronous Transmit Mode
- Loop Back Mode
- RAM Test Mode
- I/O Test Mode

To return from test mode operation to regular FlexRay operation we strongly recommend to apply a hardware reset via input eray_reset to reset all E-Ray internal state machines to their initial state.

Note: *The E-Ray test modes are mainly intended to support device testing or FlexRay bus analyzing. Switching between test modes and regular operation is not recommended.*

4.32 [FlexRay_AI.H010] Driver software must launch CLEAR_RAMs command before reading from E-Ray RAMs

Description

After a Power-on-Reset, the RAMs used by the E-Ray module must be written once. Reading from RAM locations before at least writing once to them may cause a Parity Error Trap (AUDO* microcontroller family) or an ECC Error Trap.

Recommendation

The recommended solution is to trigger a CLEAR_RAMs command (via register SUCC1). CLEAR_RAMs fills a defined value into all memory locations. A safe initialization sequence of the E-Ray RAM blocks using the CLEAR_RAMs command is described in section "CLEAR_RAMs Command" of the E-Ray chapter in the corresponding AURIX™ user manual.

An alternate solution is to write explicitly by software to all RAM locations, which are intended to be read later, for example by writing the complete configuration and writing into all allocated message buffers, including receive buffers. The latter activity may be required if buffers are configured to store frames sent in the dynamic segment. The sent frames may be smaller than the configured buffer size. If the software reads the amount of configured data (not the amount of received data), it may read from non-activated RAM locations.

For AURIX™ devices, as a further option, the MBIST auto-initialization algorithm may be used. See section "Filling a Memory with Defined Contents" in the corresponding AURIX™ user manual.

4 Application hints

4.33 [FlexRay_AI.H011] Behavior of interrupt flags in FlexRay™ Protocol Controller (E-Ray)

Description

In the corner case described below, the actual behavior of the interrupt flags of the FlexRay™ Protocol Controller (E-Ray) differs from the expected behavior.

Note: *This behaviour only applies to E-Ray interrupts INT0 and INT1. All other E-Ray interrupts are not affected.*

Expected behavior

When clearing an interrupt flag by software, the resulting value of the flag is expected to be zero.

A hardware event that occurs afterwards then leads to a zero to one transition of the flag, which in turn leads to an interrupt service request.

Actual behavior in corner case

When the interrupt flag is being cleared by software in the same clock cycle as a new hardware event sets the flag again, then the hardware event wins and the flag remains set without being cleared.

As interrupt requests are generated only upon zero to one transitions of the flag, no interrupt request will be generated for this flag until the flag is successfully cleared by software later on.

Workaround

After clearing the flag, the software shall read the flag and repeat clearing until the flag reads zero.

4.34 [FlexRay_TC.H003] Initialization of E-Ray RAMs - Documentation update

Description

After Power-On reset, the E-Ray RAMs hold arbitrary values which causes ECC errors (MHDS) when a read operation is performed on an E-Ray RAM location. Hence the E-Ray RAMs should be initialized always after a Power-On reset.

Recommendation

The E-Ray RAMs initialization can be performed using the CLEAR_RAMs command of the E-Ray module. A safe initialization sequence of the E-Ray RAM blocks using the CLEAR_RAMs command is described in section "CLEAR_RAMs Command" of chapter "FlexRay™ Protocol Controller (E-Ray)" in the AURIX™ TC3xx User's Manual.

Documentation update

Note: *In order to ensure proper FlexRay communication, RAM test mode must be explicitly disabled via TEST1.TMC = 00b at the end of the initialization sequence.*

Therefore, Step16 in section "CLEAR_RAMs Command" of the TC3xx User's Manual must be updated from

- 16. Switch off Test Mode: TEST1.WRTEN = 0b
- to
- 16. Switch off Test Mode: **TEST1.TMC = 00b and** TEST1.WRTEN = 0b

4 Application hints

4.35 [FlexRay_TC.H004] Bit WRECC in register TEST2 has no function

Description

In the AURIX™ implementation of the E-Ray module, bit WRECC in register TEST2 has no function.

Recommendation

The value read from WRECC should not be evaluated by software, the value written (0_B or 1_B) to it is irrelevant. For new software projects, keep bit WRECC at its reset value (0_B) for easier migration to future AURIX™ generations.

4.36 [FlexRay_TC.H005] E-Ray OTGB2 trigger set active even if disabled

Description

The trigger set TS32_SCSC of the E-Ray IP-module is associated with OTGB2. An internal “valid” signal should be asserted only in case the trigger set is selected via OTSS.OTGB2.

Expected behavior

The OTGB2 trigger set valid signal should be gated by the bit-field OTSS.OTGB2.

Actual behavior

The E-Ray IP does not gate the valid signal with the OTSS.OTGB2 state, but only the data are gated. Meaning the OTGB2 trigger valid signal is only dependent on the slot counter and transfer buffer state changes, irrespective of the OTSS.OTGB2 value.

Recommendation

Ignore all OTGB2 E-Ray triggers when data reported is only 0s.

4.37 [FPI_TC.H003] Burst write access may lead to data corruption

Description

For the FPI slave modules listed below, if a write burst access is aborted on the last beat, this may lead to data corruption of all future accesses. No error is generated when the burst access is aborted.

This problem only affects the following modules:

- CONVCTRL, EVADC, PMS, SCR XRAM

Recommendation

Do not perform burst accesses to registers in CONVCTRL, EVADC, PMS, and to SCR XRAM.

4.38 [GPT12_TC.H002] Bits TxUD and TxUDE in incremental interface mode - Additional information

Description

The present description of the incremental interface mode for timers T2, T3, T4 in the User's Manual, including figures and tables, implicitly refers to the following configuration of bits TxUD and TxUDE (x = 2, 3, 4):

- TxUD = 0_B
- TxUDE = 1_B

4 Application hints

This is the recommended and validated setting for these bits in incremental interface mode.

Additional information

When bit TxUD = 1_B, the count direction of timer Tx is inverted compared to the setting with TxUD = 0_B in incremental interface mode.

The setting of bit TxUDE is irrelevant in incremental interface mode, the behavior of Tx for TxUDE = 0_B and TxUDE = 1_B is identical. The figures related to incremental interface mode shall be interpreted as if TxUDE is permanently tied to 1_B.

4.39 [GTM_AI.H480] SPEC-TIM: Wrong action description for TPIM mode

Description

In TIM Pulse Integration Mode (TPIM) with External Capture (TIM[i]_CH[x]_CTRL.EXT_CAP_EN = 1), the capture is done only with the external capture signal and not with the rising or falling edge of the TIM input signal.

Therefore in the chapter describing the TPIM mode the action description in the table "Operation depending ..." (GTM4.1 spec.: TIM_2138) rows 2 and 4 are wrong.

In both rows it is described that if inc_cnt == true, a capture as well as a TIM_NEWVAL_IRQ has to be executed. But this is not the case and has to be removed. Only the last line in both rows of the table ("inc_cnt = false") is correct.

Table 16 TC3xx - Operation depending on CMU clock, DSL and the input signal value (inc_cnt = false if TIM channel is enabled)

Input signal F_OUTx	Selected CMU clock	External capture	ISL	DSL	Action description
Falling edge	-	0	-	0	inc_cnt = true
Rising edge	-	0	-	0	inc_cnt = false
Rising edge	-	0	-	1	inc_cnt = true
Falling edge	-	0	-	1	inc_cnt = false
-	1	0	-	-	If inc_cnt == true then CNT++;
-	-	Rising edge	-	-	Do capture GPRx, CNTs; issue NEWVAL_IRQ; CNT=0
-	0	0	-	-	No

Scope

TIM

Effects

Contrary to the description, neither a capture nor an interrupt is triggered by a rising or falling edge of the input signal.

Recommendation

Consider the information in the corresponding table above.

4 Application hints

4.40 [GTM_AI.H481] SPEC-TIM: Wrong description for TBCM mode

Description

Note: Register names in the text follow the TC3xx syntax conventions. Correlation of register names:

- **TC3xx:** TIM[i]_CH[x]_CTRL
- **TC2xx:** TIMi_CHx_CTRL

In TIM Bit Compression Mode with External Capture (TIM[i]_CH[x]_CTRL.EXT_CAP_EN=1), the capture is done only with the external capture signal without dependency to the input signal level. Therefore the bit-field TIM[i]_CH[x]_CTRL.ISL must be set to 1. The value 0 for TIM[i]_CH[x]_CTRL.ISL is prohibited. The bit-field TIM[i]_CH[x]_CTRL.DSL is not relevant.

The following parts in section "External capture Bit Compression Mode (TBCM)" in the TBCM chapter have to be adapted as follows:

- In the prose text
 "If external capture is enabled, capturing is done for TIM[i]_CH[x]_CTRL.ISL=1 as defined in the next table. The value 0 for TIM[i]_CH[x]_CTRL.ISL is prohibited."
- In the table
 - In the action description of row 1 the part "TIM[i]_CH[x]_CNT++" has to be removed
 - All rows starting with row 3 have to be replaced with only one row where the content for the column of TIM[i]_CH[x]_CTRL.ISL has to be filled with "0 - prohibited". All other columns in row 3 have to be marked with "-" (don't care)

Table 17 Resulting table for TC3xx and TC2xx

- TC3xx - Capturing depended on the DSL, ISL and the input signal value, if external capture is enabled
- TC2xx - TIM Input Event Mode

Input signal F_OUTx	External capture	ISL	DSL	Action description
-	Rising edge	1	-	do capture; issue NEWVAL_IRQ
-	0	1	-	No
-	-	0 - prohibited	-	-

Scope

TIM

Effects

The input signal level defined by TIM[i]_CH[x]_CTRL.DSL with TIM[i]_CH[x]_CTRL.ISL = 0 is not taken into account.

Recommendation

Consider the information given above. Do not configure TIM[i]_CH[x]_CTRL.ISL to 0.

4.41 [GTM_AI.H482] SPEC-TIM: Wrong description in TBCM mode regarding TIM[i]_CH[x]_CTRL.GPR1_SEL bit field

Description

In TIM Bit Compression Mode it is described that the bit field TIM[i]_CH[x]_CTRL.GPR1_SEL is not applicable. That is not the case and therefore the sentence mentioning that the bit field TIM[i]_CH[x]_CTRL.GPR1_SEL " is

4 Application hints

not applicable in TBCM mode." in the section "TIM Bit Compression Mode" (GTM4.1 spec.: TIM_1055) has to be ignored.

Scope

TIM

Effects

The captured value depends on the bit field TIM[i]_CH[x]_CTRL.GPR1_SEL in contrast to the notion in the specification.

Recommendation

The value of the bit field TIM[i]_CH[x]_CTRL.GPR1_SEL must be taken into account.

4.42 [GTM_AI.H497] SPEC-SPE wiring in figure is wrong

Description

In the GTM chapter of the corresponding user manual, the usage of the SIE inputs SIE0 and SIE2 must be swapped in the following figure:

- TC3xx: figure "SPE[i]_IN_PAT register representation"

In the GTM chapter of the corresponding user manual, the usage of the SIE inputs is missing in the following figure:

- TC2xx: figure "SPE[i]_IN_PAT register representation"

Scope

SPE

Effects

The enabling of the affected TIM input signals of the SPE is not working as expected when considering the figure as basis.

Recommendation

For the correct functionality, see the description of bits SIE0..2 in the following register:

- TC3xx, TC2xx: SPEi_CTRL_STAT

4.43 [GTM_AI.H803] Missing feature aspect in the user manual

Description

The following behavior is part of the ATOM and also TOM. In the clock cycle in which ATOM_CTRL_TRIG (see yellow highlight in the attached figure) is active, a simultaneous bus write access to register ATOM[i]_AGC_ENDIS_STAT or also ATOM[i]_AGC_OUTEN_STAT is ignored, regardless of the update value from the associated registers ATOM[i]_AGC_ENDIS_CTRL/ATOM[i]_AGC_OUTEN_CTRL.

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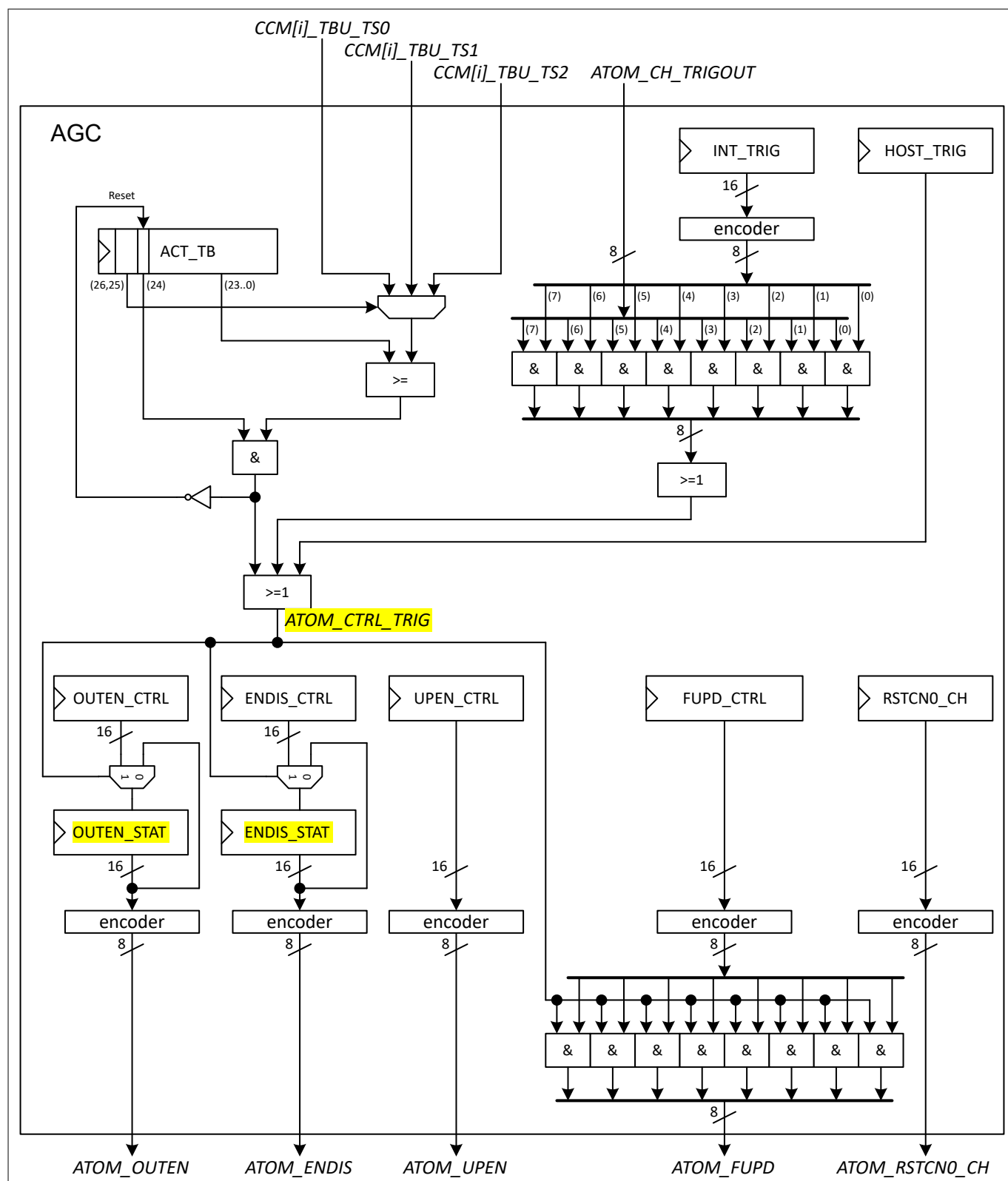


Figure 6 ATOM Global channel control mechanism

Scope

TOM, ATOM

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Effects

The write access to ATOM[i]_AGC_ENDIS_STAT (respectively ATOM[i]_AGC_OUTEN_STAT) is ignored for the clock cycle, where ATOM_CTRL_TRIG is active, even if ATOM[i]_AGC_ENDIS_CTRL=0 (respectively ATOM[i]_AGC_OUTEN_CTRL=0).

Workaround

No workaround available.

4.44 [GTM_TC.H010] Trigger Selection for EVADC and EDSADC

Description

If the GTM output selection in the SELz bit-fields for ADC triggers (registers ADCTRIGxOUTy, DSADCOUTSELxy) is changed during SW runtime, multi-bit changes may lead to unintended ADC triggering.

Recommendation

Before changing the trigger source in the GTM output selection fields SELz, ensure that the ADCs at the trigger destination will not react on intermediate state changes of the trigger signals.

4.45 [GTM_TC.H019] Register GTM_RST - Documentation Update

Description

In the current documentation, bit 0 in register GTM_RST is described as

- **Type:** r
- **Description:** Reserved - Read as zero, should be written as zero

Documentation Update

Actually, bit 0 in register GTM_RST is implemented as follows:

- **Type:** rw
- **Description:** Reserved - Read as zero, **shall** be written as zero

Note: This Application Hint relates to problem GTM-IP-316 reported by the GTM IP supplier. On this AURIX™ TC3xx device step, the reported problem has no effect, independent of the value written to bit GTM_RST.0. However, GTM_RST.0 shall always be written with 0_B as documented in the register description to ensure compatibility with future versions.

4.46 [GTM_TC.H021] Interrupt strategy mode selection in IRQ_MODE

Description

The default setting for field IRQ_MODE in register IRQ_MODE is Interrupt Level mode (00_B).

Figure “GTM interrupts” in chapter “GTM Implementation” of the TC3xx User’s Manual shows how the interrupt signal (GTM_IRQ_XXX) triggers an interrupt towards the Interrupt Router (IR), depending on IRQ_MODE.

As described in the text below this figure, while using Level mode, if more internal “interrupt” events are generated (i.e. two TOM channels generating a CCU0 interrupt), just one interrupt signal is sent to the IR, and no more interrupts are triggered until the SW clears the GTM_IRQ_XXX line towards the IR.

Hence, in Level Mode, in some scenarios where another interrupt request is generated by GTM while the ISR handle also requests a SW clear, then, as the interrupt event is dominant over the clear event (for simultaneous interrupt and clear events), GTM_IRQ_XXX is not cleared and remains high. As a consequence, the IR observes

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no transition on GTM_IRQ_XX. Thus, any forthcoming interrupt events in this scenario are lost as there is no chance to release the CPU IRQ when a collision happens as shown in Figure below.

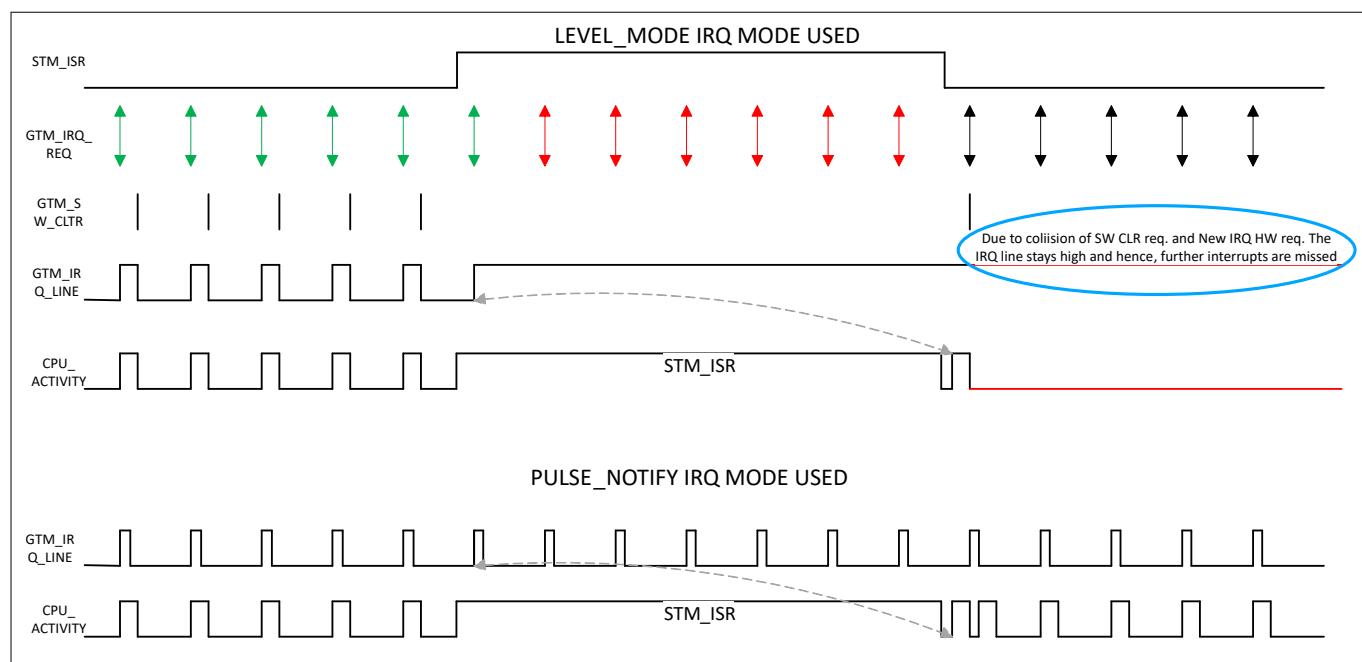


Figure 7 Interrupt Level vs. Pulse-Notify mode - Corner Case Example

If Pulse-Notify mode is selected, every internal trigger will be forwarded to the IR, irrespective of the time of occurrence and the clear event, as the pulse-notify leads to set and reset of GTM_IRQ_XXX as compared to only setting of the GTM_IRQ_XXX line in Level mode.

Recommendation

Therefore, it is recommended to use the Pulse-Notify mode to ensure that none of the interrupts might be lost by the IR even in corner timing cases.

As described above, this scenario in Level mode is only a corner case due to the timing of the SW and ISR handle. If using a different IRQ_MODE setting, evaluate your system performance for sufficient timing margin.

4.47 [GTM_TC.H027] Register ODA (OCDS Debug Access) - Documentation update

Description

In the GTM chapter of the TC3xx User's Manual, the following note is located below the description of register ODA in section "OCDS Debug Access Register":

- 6. TIM[i]_CH[x]_GPR0/1: Reading these register will reset the ECNT counter

Documentation update

Note 6. (see above) does not apply and shall be deleted.

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4.48 [INT_TC.H006] Number of SRNs supporting external interrupt/service requests – Documentation update

Description

SCU chapter “Output Gating Unit” of the TC3xx User’s Manual (V1.6 and newer versions) contains the following statement:

- “Interrupt/service requests can be generated only by the ERU OGU[0-3] via its outputs ERU_IOUT[0-3].”
Actually, all ERU OGUs [0-7] can generate interrupts/service requests by outputs ERU_IOUT[0-7]. As only 4 interrupt nodes are available for ERU interrupts/service requests, multiple sources share interrupt nodes as shown in [Table 18](#) below.

The following statement in the IR chapter “External Interrupts” of the TC3xx User’s Manual is conflicting with the description above:

- “Eight SRNs (Int_SCUSRC[7:0]) are reserved to handle external interrupts.”

Documentation update

The statement in the IR chapter shall be changed as follows:

- “**Four** SRNs (SRC_SCUERUx (x=0-3)) are implemented to handle external interrupts.”

Table “OGU to SRC connection” in the SCU chapter shall be changed as follows:

Table 18 OGU to SRC connection

OGUy.ERU_IOUTy (OGU I-output signal)	SRC_SCUERUx (interrupt SRC register)
OGU0.ERU_IOUT0, OGU4.ERU_IOUT4	SRC_SCUERU0
OGU1.ERU_IOUT1, OGU5.ERU_IOUT5	SRC_SCUERU1
OGU2.ERU_IOUT2, OGU6.ERU_IOUT6	SRC_SCUERU2
OGU3.ERU_IOUT3, OGU7.ERU_IOUT7	SRC_SCUERU3

In the SCU chapter, all references regarding the relation between ERU_IOUT*, ERU_INT* and SRC_SCUERU* shall be interpreted according to the table above:

The ERU_IOUTi and ERU_IOUTi+4 outputs are signaled through the ERU_INTi signals to the service request control registers SRC_SCUERUi in the interrupt router module (IR); i=0-3.

4.49 [ISTANDBY_TC.H001] Characteristics of standby current I_{STANDBY} on TC33x/TC32x in QFP-80 and QFP-100 packages

Description

Note: *This effect only applies to TC332 and TC322 in QFP-80 and TC333* and TC323* in QFP-100 packages, and only affects the use case where V_{EXT} is not switched off during Standby mode.*

As pin P33.12 is unavailable on TC33x/TC32x in QFP-80 and QFP-100 packages, and the internal pad is floating in Standby mode in these variants and no pull devices are active when V_{EXT} is not switched off, during Standby entry the Standby current value I_{STANDBY} as specified in the Data Sheet is reached after a transient delay of 10 - 100 ms (typical).

The Standby current has a higher value during the transient phase of 200 μA – 600 μA @ -40°C and <170 μA @ 25°C after which it settles to the I_{STANDBY} target value as specified in the Data Sheet.

Note: *If V_{EXT} is switched off during Standby mode the internal pull-up at pad P33.12 is activated, this means no floating state at this pad and therefore no additional cross current.*

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Note: *If pin P33.12 is available in higher pin-count packages, the pin level can be driven either using external pull devices or internal port IO functions and also be controlled by the PMSWCR5.TRISTREQ function.*

4.50 [LBIST_TC.H003] Update reset behavior of LBISTCTRL0 and LBISTCTRL3 register - Additional information

Description

Even though the LBISTCTRL3.[31:0] and LBISTCTRL0.28 register bits are cleared by a power-on reset they will automatically recover their values from stored contents of the central LBIST controller in the TCU (Test Control Unit) afterwards.

So on first software access the user will never see the initial reset values, but the updated LBIST done status and MISR result from the TCU LBIST controller.

The stored LBIST done status and MISR result in the central TCU LBIST controller will be cleared only through an externally applied warm power-on reset, during any cold power-on reset (triggered from EVR voltage monitors), or through the LBISTCTRL0.1 register bit (LBISTRES).

4.51 [LBIST_TC.H005] Effects of LBIST execution on P33.8

Description

As described in the chapter "LBIST Support" in the SCU chapter of the TC3xx user manual, the static GPIO behavior during LBIST execution is selectable through the LBISTCTRL1.BODY bit. This bit allows to select between tristate (BODY=1_B) and a weak pull-up (BODY=0_B).

Note: *P33.8 will be pulled up if BODY=0_B during LBIST execution, which is different from the behavior during cold reset where P33.8 is always in tristate.*

Recommendation

If bit BODY=0_B, and a low level is required on P33.8 during LBIST execution, add an external pull-down (in the range of > 2 kOhm and < 4.7 kOhm) to this pin.

In order to quantify the strength of such an external pull-down, the parameter "Pull-up current" (I_{PUH}) for the respective pin may be used as a reference, and the value for the external pull-down can be calculated accordingly.

4.52 [MBIST_TC.H001] Destructive MBIST requires DSPR0 initialization

Description

When performing a destructive MBIST, the DSPR0 content might be corrupted (meaning it contains ECC uncorrectable errors). For this reason, after the execution of that test, the user has to completely initialize DSPR0 with ECC correct data.

However, if a power interruption happens during the execution of a destructive MBIST and DSPR0 is configured to be not initialized during startup (see "RAM Configuration" register HF_PROCONRAM in TC3xx User's Manual), the device may hang and it will not be able to execute user code; ESR0 pin remains permanently low. From this state, it can only be unblocked by a power-off/-on cycle.

Recommendation

Ensure when performing a destructive MBIST of DSPR0 that this memory is under all possible conditions initialized before being used by software. This can be achieved by applying the following measures:

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- Take care that all error conditions cause either a cold or warm power-on reset. Configure DSPR0 initialization by SSW after cold and warm power-on-reset (see "RAM Configuration" register HF_PROCONRAM in TC3xx User's Manual)
- After finishing the MBIST the software can perform the RAM initialization by itself or can trigger a cold or warm power-on reset to let SSW perform the needed initialization

4.53 [MBIST_TC.H002] Time for 4N non-destructive test

Description

Section "Usage of GANGs" in the MTU chapter of the TC3xx user manual mentions that the total time for the 4N non-destructive test is specified in the datasheet of each device.

Documentation update

This information can be found in the corresponding device datasheet in the table "Module Core Current Consumption" in column "Note/Test Condition" for parameter " I_{DD} core dynamic current added by MBIST" (symbol $I_{DDMBIST}$).

4.54 [MCMCAN_AI.H001] Behavior of interrupt flags in CAN Interface (MCMCAN)

Description

In the corner case described below, the actual behavior of the interrupt flags of the CAN Interface (MCMCAN) differs from the expected behavior as follows.

Expected Behavior

When clearing an interrupt flag by software, the resulting value of the flag is expected to be zero.

A hardware event that occurs afterwards then leads to a zero to one transition of the flag, which in turn leads to an interrupt service request.

Actual Behavior in Corner Case

When the interrupt flag is being cleared by software in the same clock cycle as a new hardware event sets the flag again, then the hardware event wins and the flag remains set without being cleared.

As interrupt requests are generated only upon zero to one transitions of the flag, no interrupt request will be generated for this flag until the flag is successfully cleared by software later on.

Note: This behavior applies to all Interrupt flags of MCMCAN, with the exception of the receive timeout event (flag $NTRTRi.TE$).

Workaround

After clearing the flag, the software shall read the flag and repeat clearing until the flag reads zero.

4.55 [MCMCAN_AI.H002] Bus off recovery

Description

Note: The following text is copied from Application Note M_CAN_AN004 V1.1 by Robert Bosch GmbH and describes the bus off recovery handling in the MCMCAN module used in AURIX™ devices.

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The M_CAN enters bus off state according to CAN protocol conditions. The bus off state is reported by setting PSRi.BO. Additionally, the M_CAN sets CCCRi.INIT to stop all CAN operation.

To restart CAN operation, the application software needs to clear CCCRi.INIT.

After CCCRi.INIT is cleared, the M_CAN's CAN state machine waits for the completion of the bus off recovery sequence according to CAN protocol (at least 128 occurrences of Bus Idle condition, which is the detection of 11 consecutive recessive bits).

In the MCMCAN chapter of the user manual the description of bus off recovery states that "Once CCCRi.INIT has been cleared by the CPU, the device will then wait for 129 occurrences of Bus Idle (129 * 11 consecutive recessive bits) before resuming normal operation. At the end of the Bus_Off recovery sequence, the Error Management Counters will be reset". See Note in description of field LEC and footnote 1) in description of bit BO in Protocol Status Register (PSRi).

The M_CAN uses its Receive Error Counter to count the occurrences of the Bus Idle condition. If need be, that can be monitored at ECRi.REC. Additionally, each occurrence of the Bus Idle condition is flagged by PSRi.LEC = 5 = Bit0Error, which triggers an interrupt (IRi.PEA) when IEi.PEAE is enabled.

While the bus off recovery proceeds, the CAN activity is reported as "Synchronizing", PSRi.ACT = 0 and PSRi.BO remains set. The time from resetting CCCRi.INIT to the clearing of PSRi.BO will be (in the absence of dominant bits on the CAN bus) 1420 (11 * 129 + 1) CAN bit times plus synchronization delay between clock domains.

The M_CAN does not receive messages while the bus off recovery proceeds.

The M_CAN does not start transmissions while the bus off recovery proceeds. When a transmission is requested while the bus off recovery proceeds, it will be started after the recovery has completed and CAN activity entered Idle state, PSRi.ACT = 1.

When the Busoff Recovery has completed, PSRi.BO, ECRi.TEC, and ECRi.REC are cleared, and one CAN bit time later PSRi.ACT is set to Idle.

After PSRi.ACT reaches Idle, it will remain in Idle for at least one CAN bit time. The M_CAN's CAN state machine will become receiver (PSRi.ACT = 2) when it samples a dominant bit during idle state or it will become transmitter (PSRi.ACT = 3) when it detects a pending transmission request during idle state.

4.56 [MCMCAN_TC.H001] Behavior of undefined data bytes read from Receive Buffer

Description

During CAN reception, the corresponding Receive Buffer in MCMCAN RAM is written only with number of bytes specified in DLC of the received frame, while the remaining bytes of the receive buffer retain the old/undefined values. Unlike MultiCAN+ in AURIX™ TC2xx devices, the additional bytes of the receive buffer are not overwritten with zeros.

Recommendation

When reading from the Receive Buffer of the MCMCAN RAM, the application software should ensure that only the number of bytes as specified in DLC of the received CAN frame are considered as valid data. The remaining bytes read should be ignored.

4.57 [MCMCAN_TC.H006] Unintended behavior of receive timeout interrupt

Description

On following conditions:

1. Receive timeout feature is enabled (NTRTRi.RELOAD != 0), and

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2. Received CAN frames are stored in RxFIFO 0/1 or dedicated Rx buffers, and
3. Respective New CAN frame received interrupts are disabled (i.e. bits IEi.RF0NE, IEi.RF1NE or IEi.DRXE are 0)

then an unintended receive timeout interrupt (if enabled, NTRTRi.TEIE = 1) is triggered, although a valid CAN frame is newly received and stored in the respective RxFIFO 0/1 or dedicated Rx buffers.

Recommendation

Enable the corresponding receive interrupt via bits IEi.RF0NE, IEi.RF1NE, or IEi.DRXE, depending on the usage of RxFIFO0/1 or dedicated Rx buffers for proper function of the receive timeout interrupt.

Example:

If RxFIFO 0 is used, set IEi.RF0NE = 1.

4.58 [MCMCAN_TC.H007] Delayed time triggered transmission of frames

Description

The value written in the bit-field RELOAD of register NTATTRi, NTBTRi, NTCTTRi represents the reload counter value for the timer used for triggered transmission of message objects (Classical CAN or CAN FD frames).

The timer source and the prescaler value is defined in the NTCCRi register.

Once a value is written to bit-field RELOAD with bit STRT = 1 the timer starts counting. This timer counts one value more than the written value in bit-field RELOAD, then it triggers the transmission of a message object.

Effect

The message object transmission is delayed by one counter cycle with respect to the desired count time written in bit-field RELOAD.

Recommendation

In order to transmit a message object at a specific time, when using one of these registers:

- NTATTRi, NTBTRi, NTCTTRi

set bit-field RELOAD to one value less than the calculated counter value.

4.59 [MCMCAN_TC.H008] Parameter “CAN Frequency” - Documentation update to symbol in Data Sheet

Description

As described in chapter “Clocking System” of the AURIX™ TC3xx User’s Manual,

- f_{MCANH} defines the frequency for the internal clocking of the MCMCAN module
- f_{MCAN} defines the basic frequency for the MCMCAN module used for the baud rate generation

Documentation Update

For consistency with the description in the TC3xx User’s Manual, the symbol for parameter “CAN frequency” in table “Operating Conditions” in the Data Sheet shall be changed from “ f_{CAN} ” to “ f_{MCAN} ” as shown below:

Table 19 Operating Conditions - CAN Frequency: symbol update

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
CAN Frequency	f_{MCAN} SR	-	-	80	MHz	

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4.60 [MTU_TC.H015] ALM7[0] may be triggered after cold PORST

Description

During firmware start-up after cold PORST, alarm status flag AG7.SF0 (correctable SRAM error) may erroneously be set to 1, although no error occurred. This is due to a dummy read to an uninitialized SRAM by firmware.

Note: No entry into any of the ETRR registers is made due to this issue.

Recommendation

As alarms for correctable errors are uncritical in general, no action is required (alarm can be ignored). The application may only react on the error overflow.

In addition, to ensure that SMU alarm ALM7[0] does not correspond to a real SRAM correctable error, the user may refer to the ESM MCU_FW_CHECK described in the Safety Manual.

4.61 [MTU_TC.H016] MCI_FAULTSTS.OPERR[2] may be triggered at power-up in case LBIST is not run

Description

After power-up and before initialization by the SSW the safety flip-flops in the SSH can indicate a fault since some internal registers are not initialized. As a consequence MCI_FAULTSTS.OPERR[2] could be set and result in an alarm.

This is not a real error. LBIST does initialize the internal registers and clears the error.

Recommendation

Alarms resulting from MCI_FAULTSTS.OPERR[2] should be ignored during start-up and cleared right after execution of the SSW in case LBIST was not run.

Note/Documentation correction

In the corresponding text at the beginning of section “SSH Safety Faults Status Register” in the MTU chapter of the TC3xx User Manual (V1.2.0 and later versions), the term MCI_FAULTSTS.MISCERR[2] shall be replaced by MCI_FAULTSTS.OPERR [2].

4.62 [MTU_TC.H019] Application reset value of register SRC_MTUDONE different to documentation

Description

The application reset value for the MTU Done Service Request control register SRC_MTUDONE is defined as 00000000_H in the Interrupt Router (IR) chapter of the appendix to the TC3xx user manual.

For design reasons, after reset, the value of bit SRC_MTUDONE.SRR is 1_B, although there was no MTUDONE interrupt event in the respective MTU.

Recommendation

Software must clear bit SRC_MTUDONE.SRR when configuring the SRC register before enabling the service request.

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4.63 [NVM_TC.H001] References to DMU_HP_PROCONT_P – Typo in TC3xx user manual

Description

The register name DMU_HP_PROCONT_P mentioned in the TC3xx user manual must be replaced with DMU_HF_PROCONT_P.

Documentation Update

The term DMU_HP_PROCONT_P must be replaced by the correct register name DMU_HF_PROCONT_P in the following parts of the NVM chapter:

- "Safety Endinit protection" ("Safety Measures" chapter)
- "Handling Errors During Operation" (DMU chapter)
- "UCB_OTPy_ORIG and UCB_OTPy_COPY (y = 0 - 7)" (UCB chapter)

4.64 [OCDS_TC.H014] Avoiding failure of key exchange command due to overwrite of COMDATA by firmware

Description

Note: *This problem is only relevant for tool development, not for application development.*

After PORST the UNIQUE_CHIP_ID_32BIT is written to the COMDATA register by firmware (time point T1). Then, firmware evaluates whether a key exchange request (CMD_KEY_EXCHANGE) is contained inside of the COMDATA register at a time point (T2). If yes, firmware will expect the 8 further words (password) from the COMDATA. If no, firmware will write again the UNIQUE_CHIP_ID_32BIT value for external tools to identify the device.

If the key exchange request cannot arrive between time points T1 and T2, firmware will skip the unlock procedure and will not unlock the device. For example, the device is locked and the external tool writes the CMD_KEY_EXCHANGE value to COMDATA before T1. Then, this value is overwritten by firmware at T1. After this, firmware doesn't see the CMD_KEY_EXCHANGE value and skips the unlock procedure. The device stays locked.

Recommendation

The external tool shall write the CMD_KEY_EXCHANGE to the COMDATA register between T1 and T2. As different derivatives and firmware configurations may have different execution time, it is recommended to poll the content of COMDATA after PORST until the UNIQUE_CHIP_ID_32BIT is available. Then, the external tool shall write the CMD_KEY_EXCHANGE immediately. In this way, the overwrite of key exchange request by firmware can be avoided.

When LBIST is activated during startup, the execution time stays the same after the PORST triggered by LBIST. Therefore, the end of LBIST should be detected by the external tool. This can be achieved by polling the device state via JTAG/DAP. During LBIST, the debug interface is disabled and no response can be received. After LBIST, the response can be received normally. This symptom can be utilized to determine whether LBIST is done. The details are described in the section "Halt after PORST with DAP" in the OCDS chapter of the device documentation.

4.65 [OCDS_TC.H015] System or Application Reset while OCDS and lockstep monitoring are enabled

Description

After a System or Application Reset the Lockstep Alarm ALMx[0] gets activated if all of the following conditions are met (x = index of CPU with checker core):

1. Lockstep monitoring is enabled by BMI.LSENAX = 1_B for CPU_x, AND

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2. Debug System is enabled (CBS_OSTATE.OEN = 1_B), AND
3. a) CPUx is halted (either in boot-halt state or stopped by debugger tool or in idle mode) when reset is triggered, OR b) CPUx Performance Counters are enabled and CPUx Clock Cycle Count register CCNT is read

Recommendation

To avoid the unintended ALMx[0] under the conditions described above, either:

- Keep the debug system disabled. OR
- Ensure all CPUs that have lockstep monitoring enabled are out of halted state AND CPUx Performance Counters are disabled before executing a System or Application reset. OR
- Use PORST instead of a System or Application reset

4.66 [OCDS_TC.H016] Release of application reset via OJCONF may fail

Description

Note: *This problem is only relevant for tool development, not for application development.*

The OJCONF.OJC7 bit-field can be used to send an application reset request to the SCU. The tool sets the bit to request an application reset and has to clear the bit to release the request otherwise the device will remain in reset state.

If JTAG is used in the above case and the frequency of JTAG is very low, there is a risk that the tool is not able to release the application reset request. If DAP is used, there is a low risk that the first release of reset request may fail but the second will always work.

Recommendation

It is recommended to run JTAG above 1 MHz and execute the following instructions back to back:

IO_SUPERVISOR + IO_SET_OJCONF (release) + IO_SUPERVISOR + IO_SET_OJCONF (release).

This double releasing ensures that the reset request is released reliably.

4.67 [OCDS_TC.H018] Unexpected stop of Startup Software after system or application reset

Description

Note: *this problem is only relevant for tool development, not for application development.*

As documented in the TriCore™ Architecture Manual, the settings in the Debug Status Register (DBGSR) are only cleared upon a debug or power-on reset. This may lead to unexpected behavior in the following scenario:

If CPU0 is in HALT mode, and a system or application reset is triggered, the Startup Software (SSW) starts execution on CPU0, but it is stopped again (due to the settings in DBGSR) before the SSW has finished the boot procedure.

Recommendation

The tool should switch the device from HALT to RUN mode through the DBGSR register.

Alternatively, a power-on reset may be performed instead of a system or application reset.

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4.68 [PACKAGE_TC.H003] Exposed pad dimensions and package outlines for QFP packages - Updates to TC33x/TC32x Data Sheet

Description

In the scope of the harmonization of the package drawings, the drawings for the TQFP packages of the TC33x/TC32x have been updated. No change of form, fit or function is implied.

The dimensions for the exposed diepads are included in the respective figures.

Furthermore, for the exposed die pads, the maximum boundary of the structural corner protrusions to be considered during system design and integration has been added.

This information shall substitute the corresponding information in the TC33x/TC32x AA-step Data Sheet V1.1.

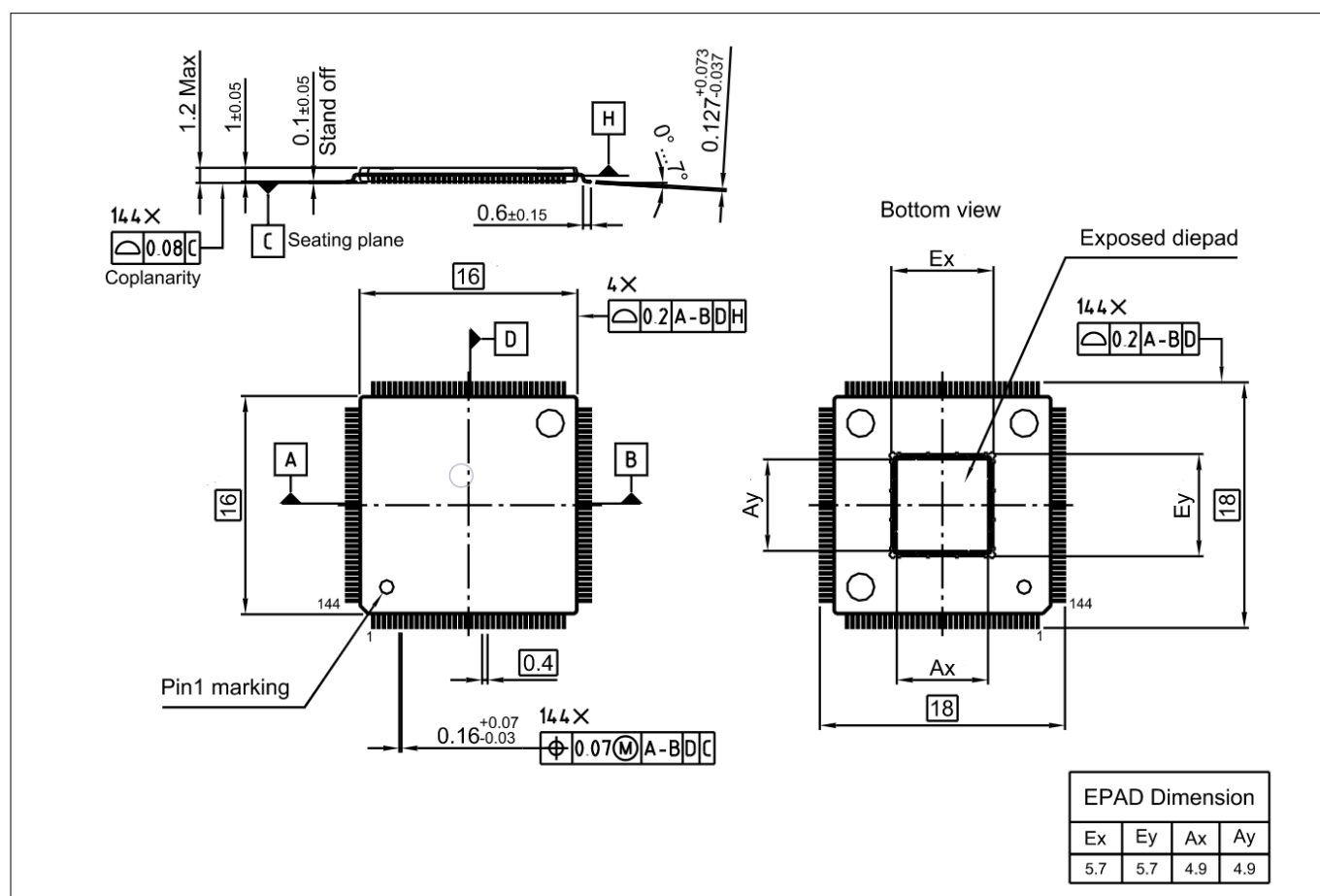


Figure 8 Package Outlines TQFP-144 for TC33x/TC32x

Note: For the exposed diepad of the TQFP-144 package of the TC33x/TC32x, structural corner protrusions have to be considered for purposes of system design and integration with a maximum boundary of 6.2 mm.

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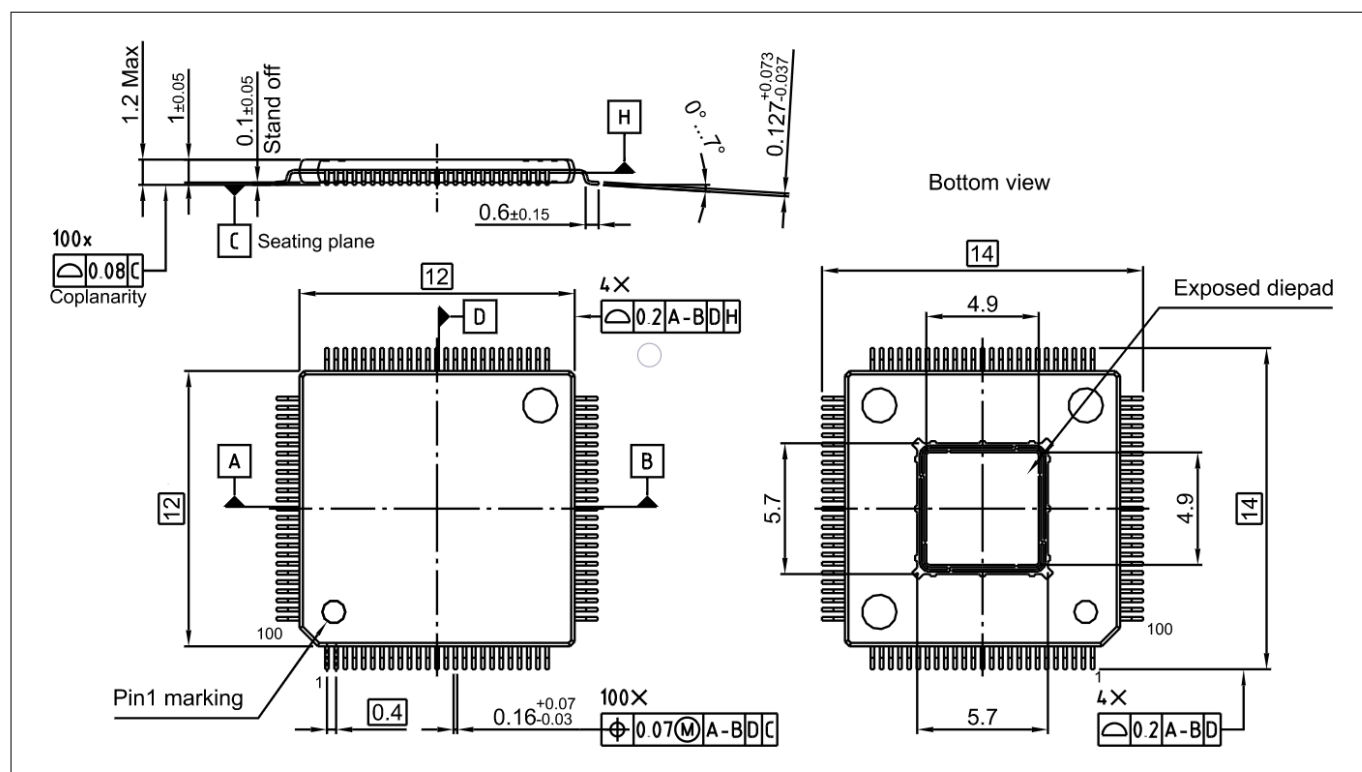


Figure 9 Package Outlines TQFP-100 for TC33x/TC32x

Note: For the exposed diepad of the TQFP-100 package of the TC33x/TC32x, structural corner protrusions have to be considered for purposes of system design and integration with a maximum boundary of 6.3 mm.

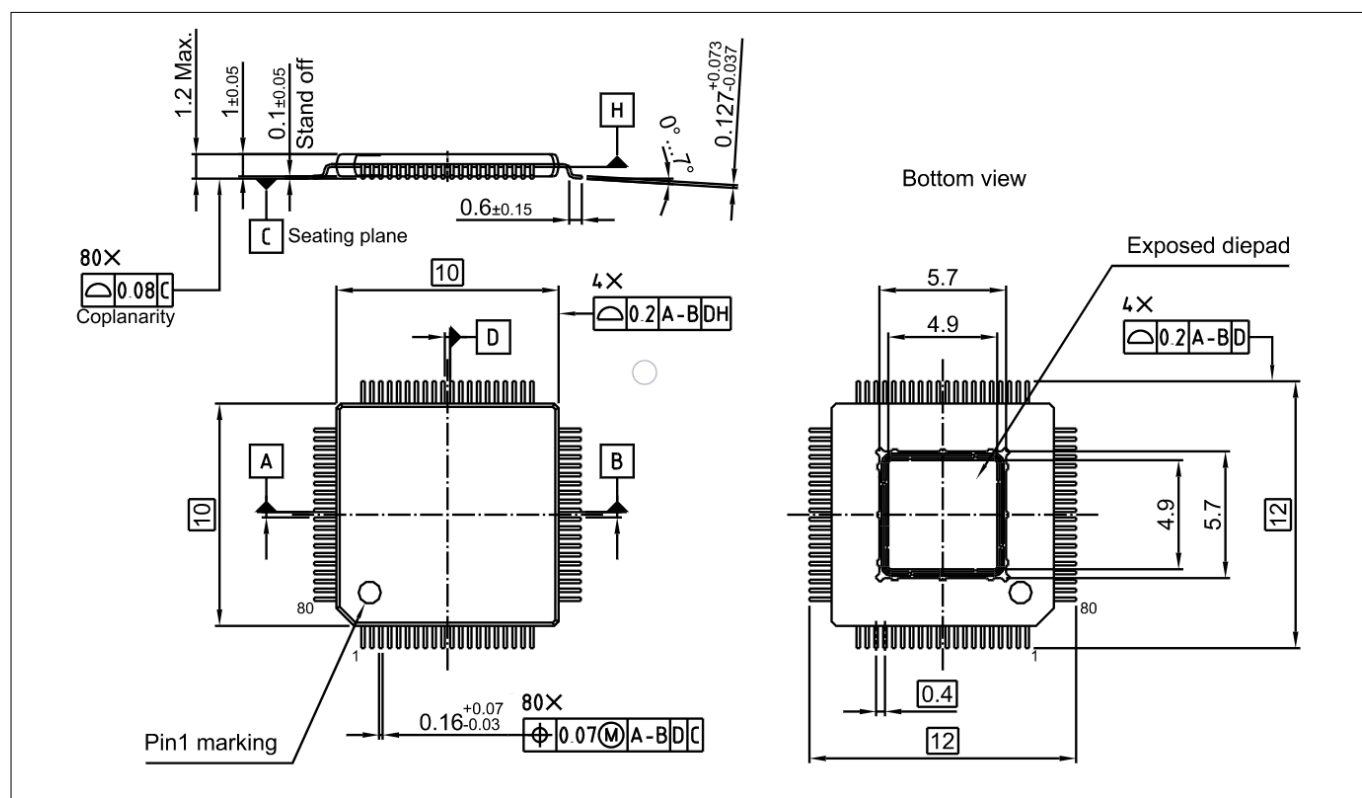


Figure 10 Package Outlines TQFP-80 for TC33x/TC32x

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Note: For the exposed diepad of the TQFP-80 package of the TC33x/TC32x, structural corner protrusions have to be considered for purposes of system design and integration with a maximum boundary of 6.2 mm.

You can find all of our packages, sorts of packing and others on our Infineon Internet Page <http://www.infineon.com/products>

4.69 [PADS_TC.H007] Connection of HWCFG[6] pad in QFP-80 and QFP-100 packages – Explanation to Data Sheet history

Description

In QFP80 and QFP100 packages, HWCFG[2] and HWCFG[6] pins are not available. Internally, the corresponding pads are handled as follows:

- HWCFG[2] is tied to 1 (via internal pull-up) to ensure EVRC is enabled;
- HWCFG[6] is tied to 0 (connected to V_{SS} via E-PAD) to ensure pins are in tristate

This is also documented in Note 2.) in figure “Hardware Configuration (HWCFG) pins” in the PMSLE chapter of the TC3xx User’s Manual in version V1.3.0 and later versions.

In V0.6 of the TC33x/TC32x Data Sheet, the E-PAD was listed as VSS pin 81 for QFP-80, pin 101 for QFP-100, and pin 145 for QFP-144 packages, respectively. The E-PAD is explicitly listed in the supply tables in TC33x/TC32x Data Sheet V0.7 and following (see also chapter “History” in corresponding Data Sheets).

4.70 [PMSLE_TC.H001] Typo in SHVL formula for EVRSDCTRL9 in the PMSLE chapter

Description

For the register EVRSDCTRL9 in the PMSLE chapter of the TC3xx user manual, the formula " $V_{OUT} + SHVL \times 5 \text{ mV}$ " mentioned in the description of bit-field SHVL is incorrect.

Documentation update

For EVRSDCTRL9, the formula mentioned in the description of bit-field SHVL must be corrected as " $V_{OUT} - SHVL \times 5 \text{ mV}$ " instead of " $V_{OUT} + SHVL \times 5 \text{ mV}$ ".

4.71 [PMS_TC.H003] V_{DDPD} voltage monitoring limits

Description

The EVR pre-regulator (EVRPR) generates the internal V_{DDPD} voltage. Its upper and lower threshold limits are monitored by the V_{DDPD} secondary monitor, while the minimum $V_{LVD RSTC}$ voltage (LVD reset level) is monitored by the V_{DDPD} detector with built-in reference.

The secondary voltage monitor’s upper and lower voltage thresholds for the V_{DDPD} channel may be adapted in software for better centering across the nominal set point with sufficient margin accounting for static regulation and dynamic response of the V_{DDPD} internal voltage regulator.

Note: The PREOVVAL and PREUVVAL values of EB_H and $C7_H$, respectively, mentioned in column “Note/Test Conditions” for V_{DDMON} in the Data Sheet are only examples used to characterize the V_{DDMON} accuracy under the specified conditions and shall not be used for the configuration of the EVROVMON2.PREOVVAL and EVRUVMON2.PREUVVAL fields in an application.

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Recommendation

- The over-voltage alarm threshold setting in EVROVMON2.PREOVVAL needs not to be modified. The register reset value 0xFE = 1.460 V is appropriate (as well as the next lower value 0xFD = 1.454 V)
- For the under-voltage alarm threshold setting in EVRUVMON2.PREUVVAL:
 - The register reset value 0xBC = 1.079 V (typical) may be kept. It matches the LVD reset level ($V_{LVDRSTC}$) which is at 1.074 V (typical). In this case, the reset will occur concurrently with the alarm, therefore either the reset, or the alarm and the reset will be triggered
 - The threshold value might be set higher to the value 0xC4 = 1.125 V (typical), in order for the software to have some time to react on the alarm before the reset occurs

In V1.4.0 and newer versions of the TC3xx User's Manual, the part for the V_{DDPD} voltage monitor in figure "Voltage Monitoring - VEVR SB, VDDM & VDDPD" in the PMS and PMSLE chapter has been updated accordingly:

- PREOVVAL range = 1.43 V - 1.48 V
 - Register reset value: SMU alarm generated at PREOVVAL ~ 1.46 V
- PREUVVAL range = 1.1 V - 1.15 V
 - Register reset value: SMU alarm generated at PREUVVAL ~ 1.08 V

4.72 [PMS_TC.H008] Interaction of interrupt and power management system - Additional information

Description

- **TC2xx:** The description of steps to enter Idle, Sleep and Standby Mode in chapter "Power Management Overview" of the PMC chapters in the current TC2xx User's Manuals is not comprehensive in explaining the dependency on pending interrupts as well as received interrupts. Hence, more explanation is provided here.
- **TC3xx:** The description of steps to enter Idle, Sleep and Standby Mode in chapter "Power Management Overview" of the PMS and PMSLE chapters in the current TC3xx User's Manual is not comprehensive in explaining the dependency on pending interrupts as well as received interrupts. Hence, more explanation is provided here.

For a CPU to enter Idle Mode, it must have no interrupts pending. If it is in Idle Mode it will stay in Idle Mode until one of the specified wake-up events occurs – one of these is to have a pending interrupt.

Any SRN targeting a specific CPU (i.e. TOS set to that CPU), which is enabled, i.e. has SRE set, and has received a trigger event, i.e. has SRR set (whether by a received trigger from a peripheral or a master using the SETR control bit in the SRN) is a pending interrupt. Thus, even if a peripheral is shut down by having its clocks gated off, if it has presented a trigger event to the IR, and the SRE bit for that SRN is set, there will be a pending interrupt to the specified CPU.

It is not necessary for the priority of the pending interrupt to allow it to be taken, nor is it necessary for the CPU to have interrupt servicing enabled. It is possible and valid for Idle Mode to be entered with interrupts disabled, and to only re-enable interrupt acceptance subsequent to resuming execution. Equally, the CPU's priority may well dictate that the interrupt cannot be serviced immediately on re-enabling interrupts.

There may be some interrupts in a system that a CPU will be required to service and must exit Idle Mode (or Sleep Mode) or prevent entry to Idle Mode (or Sleep or Standby Mode) on their arrival. If one of these interrupts is raised prior to, or just as Idle Mode, Sleep Mode or Standby Mode is requested then that mode will not be entered.

The description for the REQSLP field states

- "In Idle Mode or Sleep Mode, these bits are cleared in response to an interrupt for the CPU, or when bit 15 of the corresponding CPU Watchdog Timer register (bit WDTCPUXSR.TIM[15]) changes from 0 to 1."

For clarity, this also means, if a write to PMCSRx.REQSLP occurs while the IR has a pending interrupt for CPUx the write data will be ignored and the REQSLP value will remain as 00_B "Run Mode".

For the system to enter Sleep or Standby Mode by writing to PMCSRx.REQSLP (as opposed through an external low voltage condition), all CPUs must be in Idle Mode. Typically, first other CPUs will be brought into Idle Mode

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and then the master CPU will be the last to enter to Idle Mode as a transitional state of the request for the system mode Sleep or Standby. Consequently any pending interrupts for any CPU will prevent the entry into Sleep or Standby Mode.

Recommendation

To ensure the transition to a power save mode, for a CPU intended to enter Idle Mode or for a system entering Sleep or Standby mode, all interrupts that are not intended to cause Run Mode to be re-entered or retained, should either have the SRE bit cleared in the respective SRN or be guaranteed to have the SRR bit clear.

- **TC2xx:** If modifying the SRE bit of an SRN, to ensure the new state is reflected in IR arbitration information conveyed to the PMC and CPUs, sufficient time for an arbitration must have elapsed. Hence, a subset of the synchronisation described in subsection “Changing the SRN configuration” of the IR chapter in the corresponding TC2xx User’s Manual is required.
- **TC3xx:** If modifying the SRE bit of an SRN, to ensure the new state is reflected in IR arbitration information conveyed to the PMS and CPUs, sufficient time for an arbitration must have elapsed. Hence, a subset of the synchronisation described in subsection “Changing the SRN configuration” of the IR chapter in the TC3xx User’s Manual is required.

After the last SRN (for CPUx) has been updated

- Read back the last SRN
- Read the LWSRx register

Clearing the SRR bit or disabling the source of the trigger can also be used if there are no timing hazards; i.e. no risk of a trigger being raised just before reconfiguring the peripheral (to not raise triggers), or no risk of an SRN that has had SRR cleared being set again while other SRNs are accessed. If the timing behaviour of these interrupt sources allows them to be disabled at source or in the SRN these are also valid methods. So long as the SRE bit and SRR bit are not both set, there will not be a pending interrupt. If the SRR bits are cleared, after the last SRN is modified there also needs to be a synchronisation step for the IR outputs to reflect the update before the PMCSRx is written.

Once there are no pending interrupts, request the power saving mode by writing to the respective PMCSRx.

Note: **TC2xx:** *There will still be several system clock cycles till the power saving mode is enabled by the PMC during which the CPU will continue to execute instructions.*

Note: **TC3xx:** *There will still be several system clock cycles till the power saving mode is enabled by the PMS during which the CPU will continue to execute instructions.*

To ensure a deterministic boundary for execution to end after the power saving mode request, the write to PMCSRx should be followed by a DSYNC and a WAIT instruction.

4.73 [PMS_TC.H009] Interaction of warm reset and standby mode transitions

Description

Chapter “Power Management” in the PMS and PMSLE chapters of the TC3xx User’s Manual in general describes how the standby mode transitions are performed from the AURIX™ system point of view (see also figure “Power down modes and transitions”).

This application hint addresses the specific use cases

- when a standby request by VEXT ramp down is issued during warm reset, or
- when a warm reset is triggered when a standby mode transition is ongoing

The PMS and PMSLE modules have a separate state machine operating independently from the rest of the AURIX™ system. The PMS and PMSLE modules and states are not affected by warm resets (for example application reset). Table “Effect of Reset on Device Functions” in the SCU chapter of the TC3xx User’s Manual shows how the AURIX™ modules are affected by different reset types. The PMS and PMSLE modules behave in the same way as the EVR module listed in this table.

4 Application hints

Therefore standby mode entry is achieved even in the reset state of the AURIX™ system modes.

4.74 [PMS_TC.H010] “EVR13” to be replaced by “EVRC” in table titles of TC33x/TC32x Data Sheet - Documentation update

Description

For consistency with the User's Manual, the term “EVR13” shall be replaced by “EVRC” in the table titles of the following two tables in the EVR chapter of the TC33x/TC32x Data Sheet V1.1 (and earlier versions):

- Title of table “EVR13 SMPS” shall be replaced by “EVRC SMPS”
- Title of table “EVR13 SMPS external components” shall be replaced by “EVRC SMPS external components”

4.75 [PMS_TC.H011] Supply mode and topology selection - Allowed combinations of VEXT and VDDM - Documentation update

Description

Tables “Allowed Combinations of Nominal External Supply Voltages between Voltage Rails” in the PMS and PMSLE chapters of the TC3xx User's Manual define the allowed combinations of the external supply voltages for the target applications and verified use cases of the TC3xx family.

These tables do not include the combination VEXT = 5V and VDDM = 3.3V.

Documentation update

For consistency, in tables “Supply Mode and Topology selection” in the same chapters, for the configurations with “VEXT & VEVR SB = **5.0V** external supply” in column “Supply Pin Voltage/Level”, the term “VDDM = VAREF_x = 5V **or** 3.3V” shall be replaced by

- VDDM = VAREF_x = 5V

4.76 [PMS_TC.H015] Update of figures showing VCAP0 and VCAP1 pin labels to correct polarity for EVRC SC-DCDC flying capacitor

Description

In the following figures included in the PMSLE chapter of the TC3xx user manual V2.0 (and earlier versions)

- Figure "VCAP behavior during start-up when EVRC regulator is used"
- Figure "EVRC Step down regulator"

there is a mismatch between the figures and the actual HW implementation: the VCAP0 and VCAP1 pin labels are inverted.

In the figures listed above, VCAP0 is shown as the higher voltage node (at the flying capacitor), whereas in actual HW and package implementation, VCAP1 is the higher voltage node.

The incorrect labeling of the VCAP pins has no impact on functionality (the flying capacitor has no polarity restriction, as this is a ceramic MLCC component).

Note: In the following supply pin package figures in section "EVRC Supply Pins", the description is correct:

- Figure "EVRC SC-DCDC Supply Pins for QFP Packages"
- Figure "EVRC SC-DCDC Supply Pins for BGA Package (LFBGA292)"

Documentation update

See corrected figures included below.

4 Application hints

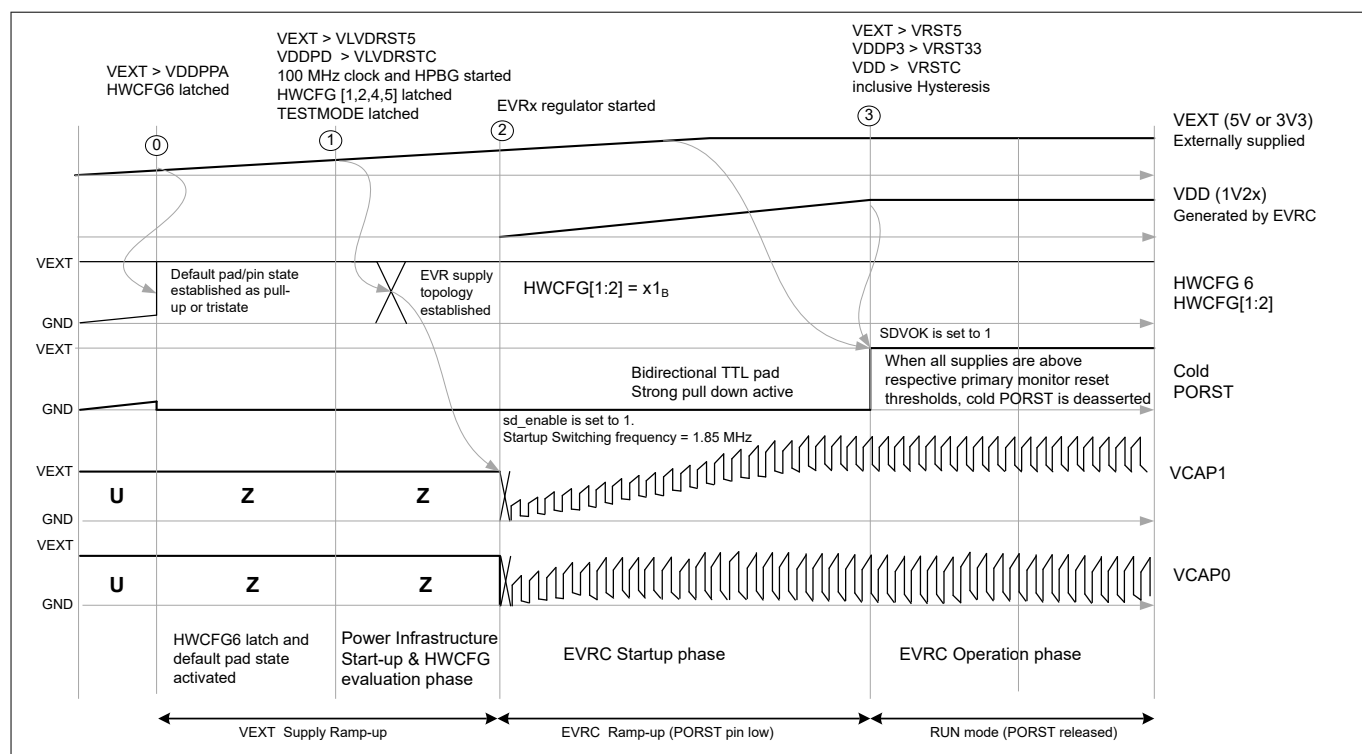


Figure 11 VCAP behavior during start-up when EVRC regulator is used - corrected

4 Application hints

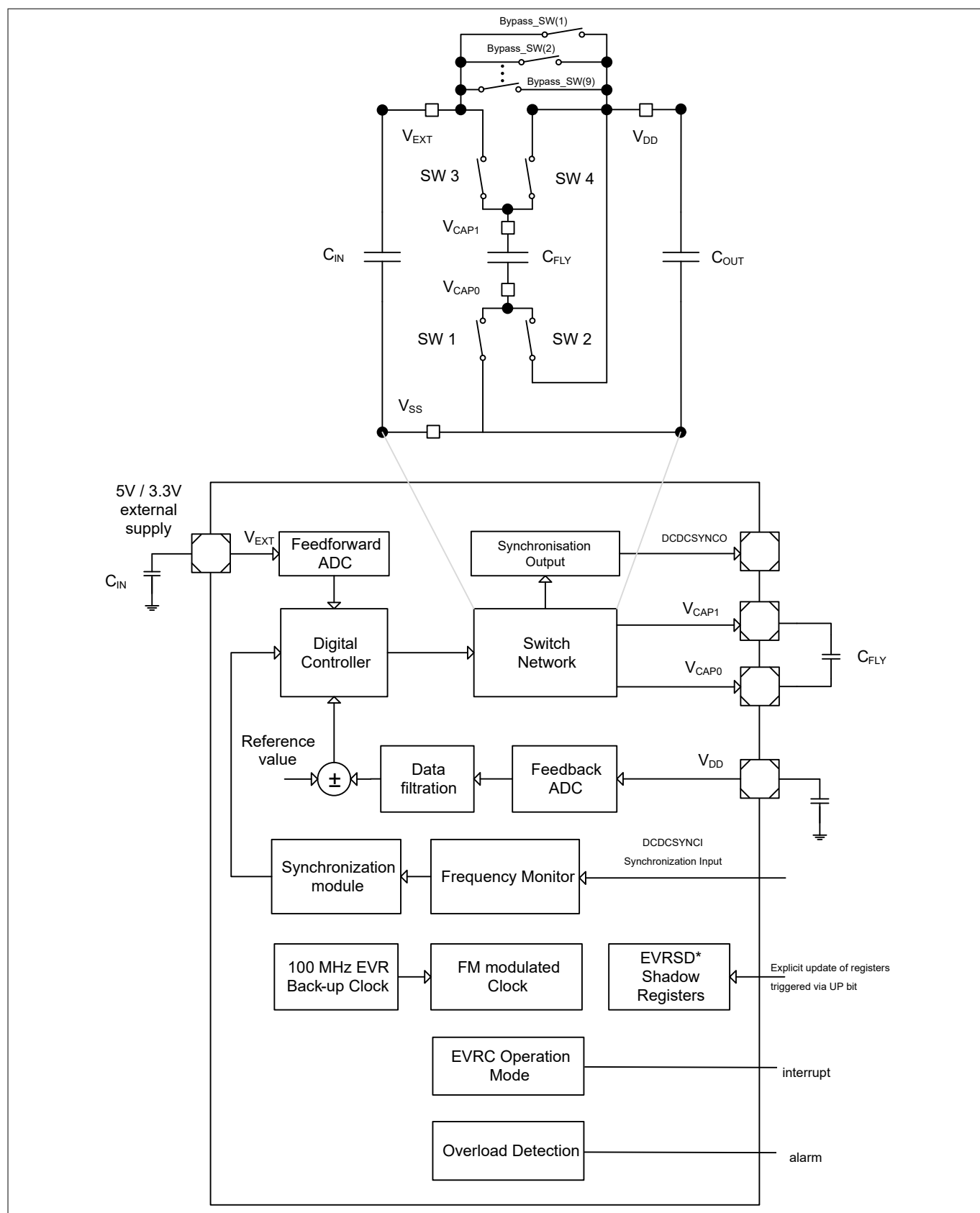


Figure 12 EVRC Step down regulator - corrected

4 Application hints

4.77 [PMS_TC.H018] Bit SWDLVL in register EVRSTAT is always 1 when EVRC is OFF

Description

The text in the section "EVR Status Register" (EVRSTAT) in the PMS and PMSLE chapters of the TC3xx user manual states in the description of the bit SWDLVL (VEXT external supply level status):

- "This bit indicates that the VEXT voltage has dropped below ~4 V to indicate EVRC parameter switch to differentiate 5 V or 3.3 V external supply. A hysteresis of ~120 mV is implemented on this detector.
 - 0_B VEXT external supply is above the threshold
 - 1_B VEXT external supply is below the threshold"

The statement "0_B VEXT external supply is above the threshold" is incorrect when EVRC is disabled and the VEXT voltage is above 4 V threshold.

Documentation update

When the EVRC is disabled by HWCFG pin and VEXT voltage is above 4 V threshold, the bit SWDLVL will be 1_B, which means the bit takes the reset state as the EVRC is inactive.

4.78 [PMS_TC.H019] Limitation of power-cycles - Additional datasheet footnote

Description

In the table "Supply Ramp" in the sub-chapter EVR of the TC39x datasheet, a statement is described as:

- "Up to 1000000 power-cycles, matching the limits defined in the table "Supply Ramp", are allowed for TC39x, without any restriction to reliability"

The statement with reference to the limitation of power-cycles up to 1000000 can be omitted if the device is operated within the nominal operating conditions during the device start-up phase. This AppHint is applicable to all TC3xx corresponding device datasheet.

Documentation update

In the table "Supply Ramp" in the sub-chapter EVR or PMS of the TC3xx datasheet, the following footnote shall be added to the statement "Up to 1000000 power-cycles, matching the limits defined in the table "Supply Ramp", are allowed for TC39x, without any restriction to reliability":

- ¹⁾ If the MCU supply voltages are within the nominal operating conditions as specified in the datasheet during the device start-up phase, then there is no restriction on the number of power-cycles for all TC3xx devices in the latest design steps

4.79 [PORTS_TC.H018] Misleading footnote on pad driver mode selection table

Description

The table "Pad Driver Mode Selection for Slow Pads" in the PORTS chapter of the TC3xx user manual contains the following footnote:

1) This setting is marked "sm" as the electrical characteristics are identical to the strong driver medium edge setting. The Data Sheet contains also only common "sm" tables.
--

This footnote is inaccurate. Please read the recommendation that follows.

4 Application hints

Recommendation

The electrical characteristics of the medium driver with sharp setting are explicitly documented in the datasheet. They are generally not identical to the characteristics of the strong driver with medium setting. However, the documentation of timing parameters for communication interfaces in the datasheet has "sm" tables that are valid for both types of output driver settings.

4.80 [QSPI_TC.H008] Details of the baud rate and phase duration control - Documentation update

Description

To enhance readability, the last part of the second paragraph in the QSPI chapter “Details of the Baud Rate and Phase Duration Control”, starting with “Variations in the baud rates of the slaves ..”, shall be rephrased as shown below.

For further details see also the formulas in the chapter mentioned above and in the figures in chapter “Calculation of the Baud Rates and the Delays” in the User’s Manual.

Documentation update

Variations in the baud rates of slaves of one module are supported by the ECONz.Q and the ECONz.A/B/C bit-field settings allowing for a flexible bit time variation between the channels in one module.

4.81 [RESET_TC.H006] Certain registers may have different reset values than documented in TC3xx User’s Manual - Documentation update

Description

The following registers may show different reset values compared to those documented in the TC3xx User’s Manual or TC3yx appendix. During device start-up, the initial hardware reset values of certain registers may be updated. Consequently, user software may read different values. Please refer to the table below for further details.

Note: The TC3xx User’s Manual chapters and/or register bit-field descriptions may contain information in addition to reset values/tables.

Note: The registers listed in the following table apply to TC39x, TC38x, TC37x, TC37xEXT, TC36x, TC35x, TC33xEXT and TC3Ex. For TC33x/32x see separate table below. Presence of CPU*_PCON1 registers depends on number of available CPUs.

Table 20 TC39x, TC38x, TC37x, TC37xEXT, TC36x, TC35x, TC33xEXT and TC3Ex registers that may have different reset values than documented in TC3xx User’s Manual

Register	Initial reset value	Reset value defined in User’s Manual	Remark
P20_IOCRO	0x0010 0000	0x0000 0000 (HWCFG6 = tri-state)	TESTMODE pin is PU (input pull-up), even with HWCFG6 = tri-state, as described in Data Sheet.
EMEM_TILECONFIG	0x0000 0000	0x5555 5555	This is a write-only (“w”) register. For tile mode information do not read EMEM_TILECONFIG; instead, read EMEM_TILESTATE.

(table continues...)

4 Application hints

Table 20 (continued) TC39x, TC38x, TC37x, TC37xEXT, TC36x, TC35x, TC33xEXT and TC3Ex registers that may have different reset values than documented in TC3xx User's Manual

Register	Initial reset value	Reset value defined in User's Manual	Remark
SBCU_DBCNTL	0x0000 7002	0x0000 7003	Bit EO is "Status of BCU Debug Support Enable" and only set after reset when OCDS is enabled. This bit is controlled by Cerberus.
CPU1_PCON1	0x0000 0001	0x0000 0000	Bit PCINV of PCON1 is set when CPU is in boot halt mode, it is cleared when CPU starts execution
CPU2_PCON1	0x0000 0001	0x0000 0000	
CPU3_PCON1	0x0000 0001	0x0000 0000	
CPU4_PCON1	0x0000 0001	0x0000 0000	
CPU5_PCON1	0x0000 0001	0x0000 0000	
HSSL0_MFLAGS	0xA000 0000	0x8000 0000	Bit TEI indicates the state of CTS (Clear To Send) signal from HSCT module. The default state of this bit is 1.
HF_OPERATION	0x0000 0X00	0x0000 0000	RES bits shall be ignored.
PMS_EVRSDCTRL0	0x3039 0001	0xF039 0001	LCK and UP bits are cleared.
PMS_EVRSDCTRL1	0x0669 0708	0x8669 0708	LCK bit is cleared.
PMS_EVRSDCTRL6	0x0023 1C94	0x8023 1C94	LCK bit is cleared.
PMS_EVRSDCTRL7	0x0000 00FE	0x8000 00FE	LCK bit is cleared.
PMS_EVRSDCTRL8	0x1121 048E	0x9121 048E	LCK bit is cleared.
PMS_EVRSDCTRL9	0x0000 0434	0x8000 0434	LCK bit is cleared.
PMS_EVRSDCTRL11	0x1207 0909	0x9207 0909	LCK bit is cleared.
PMS_EVRSDCOEFF0	0x3508 73B6	0xB508 73B6	LCK bit is cleared.
PMS_EVRSDCOEFF1	0x2294 6C46	0xA294 6C46	LCK bit is cleared.
PMS_EVRSDCOEFF6	0x0097 1802	0x8097 1802	LCK bit is cleared.
PMS_EVRSDCOEFF7	0x0000 D8F7	0x8000 D8F7	LCK bit is cleared.
PMS_EVRSDCOEFF8	0x0017 1002	0x8017 1002	LCK bit is cleared.
PMS_EVRSDCOEFF9	0x0000 A0AF	0x8000 A0AF	LCK bit is cleared.
SCU_OSCCON	0x0000 0258 for UCB_DFLASH.OSCCFG = 0; 0x0XX0 XXXX otherwise	0x0000 0X1X	SCU_OSCCFG setting is recovered from UCB_DFLASH

Note: The registers listed in the following table apply to TC33x/TC32x.

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Table 21 TC33x/32x registers that may have different reset values than documented in TC3xx User's Manual

Register	Initial reset value	Reset value defined in User's Manual	Remark
P20_IOCRO	0x0010 0000	0x0000 0000 (HWCFG6 = tri-state)	TESTMODE pin is PU (input pull-up), even with HWCFG6 = tri-state, as described in Data Sheet.
SBCU_DBCNTL	0x0000 7002	0x0000 7003	Bit EO is "Status of BCU Debug Support Enable" and only set after reset when OCDS is enabled. This bit is controlled by Cerberus.
HF_OPERATION	0x0000 0X00	0x0000 0000	RES bits shall be ignored.
PMS_EVRSDCTRL0	0x0000 0003	0xC000 0003	LCK and UP bits are cleared.
PMS_EVRSDCTRL1	0x0012 0012	0x8012 0012	LCK bit is cleared.
PMS_EVRSDCTRL2	0x140A 0909	0x940A 0909	LCK bit is cleared.
PMS_EVRSDCTRL3	0x0000 0001	0x8000 0001	LCK bit is cleared.
PMS_EVRSDCTRL4	0x2000 2209	0xA000 2209	LCK bit is cleared.
PMS_EVRSDCTRL5	0x001B 7566	0x801B 7566	LCK bit is cleared.
PMS_EVRSDCTRL6	0x0081 0000	0x8081 0000	LCK bit is cleared.
PMS_EVRSDCTRL7	0x2061 0400	0xA061 0400	LCK bit is cleared.
PMS_EVRSDCTRL8	0x1070 0000	0x9070 0000	LCK bit is cleared.
PMS_EVRSDCTRL9	0x0000 4040	0x8000 4040	LCK bit is cleared.
PMS_EVRSDCTRL10	0x130C 0719	0x930C 0719	LCK bit is cleared.
PMS_EVRSDCOEFF0	0x0052 0083	0x8052 0083	LCK bit is cleared.
PMS_EVRSDCOEFF1	0x17B2 6996	0x97B2 6996	LCK bit is cleared.
PMS_EVRSDCOEFF2	0x4924 8BD9	0xC924 8BD9	LCK bit is cleared.
PMS_EVRSDCOEFF3	0x0780 00A3	0x8780 00A3	LCK bit is cleared.
SCU_OSCCON	0x0000 0258 for UCB_DFLASH.OSCCFG = 0; 0x0XX0 XXXX otherwise	0x0000 0X1X	SCU_OSCCFG setting is recovered from UCB_DFLASH

4.82 [RESET_TC.H007] Cold Power on Reset Boot Time – Additional information

Description

Parameter "Cold Power on Reset Boot Time" (symbol t_{BP}) in chapter "Reset Timing" of the Data Sheet is specified as a "Max." value.

Additional information

The term "Firmware execution time" used in column "Note/Test Condition" for this parameter includes the execution time of both Startup Software (SSW) and Checker Software (CHSW).

4 Application hints

4.83 [SAFETY_TC.H013] ESM[SW]:SYS:MCU_FW_CHECK - Access to MC40 FAULTSTS register – Additional information

Description

The FSI RAM is used to configure the PFLASH. For security related reason, the access to this RAM is restricted. Therefore, in order to avoid accesses to this RAM through its SSH, the MBIST Controller 40 (MC40) is not disclosed in the AURIX™ TC3xx User's Manual.

However, according to Appendix A of the Safety Manual, for SSH(40) register MC40_FAULTSTS must be compared to an expected value by ESM[SW]:SYS:MCU_FW_CHECK after reset.

Recommendation

When implementing ESM[SW]:SYS:MCU_FW_CHECK, the register address listed below has to be used to access the FAULTSTS register of MBIST Controller 40:

- MC40_FAULTSTS (0xF006 38F0)

4.84 [SAFETY_TC.H017] Safety Mechanisms requiring initialization - Documentation update

Description

In chapter “Safety Mechanisms” of the AURIX™ TC3xx Safety Manual, safety mechanisms that need to be initialized by Application SW have a link in the “Init Conditions” field to a Safety Mechanism Configuration (SMC). This SMC provides a description of what has to be implemented to activate the respective safety mechanism (SM).

This is not valid for all safety mechanisms. Some of them have no SMC as “Init Conditions”, although they need to be activated.

Documentation update

Following is the list of safety mechanisms that have to be activated with the respective “Init Conditions”, in addition to the SMs that are already listed with a link to a SMC in field “Init Conditions” in the Safety Manual:

SM[HW]:CLOCK:ALIVE_MONITOR

Init conditions

The application SW shall enable the clock alive monitoring by setting the corresponding bit in CCUCON3 register after PLLs have been set up and are running.

SM[HW]:CPU:TPS

Init conditions

The application SW shall enable the temporal protection system (configure CPU_SYSCON.TPROTEN = 1_B).

SM[HW]:CPU:TPS_EXCEPTION_TIME_MONITOR

Init conditions

The application SW shall enable the temporal protection system (configure CPU_SYSCON.TPROTEN = 1_B).

SM[HW]:CPU:CODE_MPU

Init conditions

The application SW shall configure the Code MPU according to TriCore™ TC1.6.2 Core Architecture Manual Volume 1 V1.2.2 - Chapter 10 “Memory Protection System”.

4 Application hints**SM[HW]:CPU:DATA_MPU****Init conditions**

The application SW shall configure the Data MPU according to TriCore™ TC1.6.2 Core Architecture Manual Volume 1 V1.2.2 - Chapter 10 “Memory Protection System”.

SM[HW]:CPU:UM0**Init conditions**

The application SW shall configure the CPU access privilege level control to User-0 Mode (CPU_PSW.IO = 00_B).

SM[HW]:CPU:UM1**Init conditions**

The application SW shall configure the CPU access privilege level control to User-1 Mode (CPU_PSW.IO = 01_B).

SM[HW]:CPU:SV**Init conditions**

The application SW shall configure the CPU access privilege level control to Supervisor Mode (CPU_PSW.IO = 10_B). (Default configuration).

SM[HW]:CPU:STI**Init conditions**

The application SW shall configure the safe task identifier (CPU_PSW.S = 1_B).

SM[HW]:DMA:TIMESTAMP**Init conditions**

The application SW shall enable the appendage of a DMA timestamp (configure DMA_ADICRc.STAMP = 1_B).

SM[HW]:EMEM:CONTROL_REDUNDANCY**Init conditions**

The application SW shall enable the EMEM module SRI control redundancy logic (EMEM_SCTRL.LSEN = 10_B).

SM[HW]:EMEM:READ_WRITE_MUX**Init conditions**

The application SW shall configure the mode of the EMEM tiles via EMEM_TILECONFIG and enable access to the EMEM tiles via EMEM_TILEECC and EMEM_TILEECT.

SM[HW]:LMU:CONTROL_REDUNDANCY**Init conditions**

The application SW shall enable the LMU control redundancy logic (LMU_SCTRL.LSEN = 10_B).

SM[HW]:NVM.PFLASH:ERROR_CORRECTION**Init conditions**

The application SW shall enable the ECC error correction (CPUx_FLASHCON2.ECCCORDIS = 10_B).
Enabled after reset.

SM[HW]:NVM.PFLASH:ERROR_MANAGEMENT**Init conditions**

4 Application hints

The application SW shall enable address buffer recording (CPUx_FLASHCON2.RECDIS = 10_B).
Enabled after reset.

SM[HW]:NVM.PFLASH:FLASHCON_MONITOR

Init conditions

The application SW shall initialize CPUx_FLASHCON2.

SM[HW]:SPU:REDUNDANCY_SCC

Init conditions

SM[HW]:SPU:REDUNDANCY_SCC is enabled when either of SM[HW]:SPU:PARTIAL_REDUNDANCY or SM[HW]:SPU:REDUNDANCY are enabled.

SM[HW]:SCU:EMERGENCY_STOP

Init conditions

By default after reset, the Synchronous mode is selected; in this mode, the application SW shall enable (via EMSR.ENON = 1_B) the setting of the Emergency stop flag (EMSR.EMSF) on an inactive-to-active level transition of the port input.

Alternatively, the application SW can:

- Select the Asynchronous mode (EMSR.MODE = 1); in this mode the occurrence of an active level at the port input immediately activates the emergency stop signal
- Configure Alarm(s) in SMU to trigger an Emergency Stop

SM[HW]:SMU:RT

Init conditions

The application SW shall enable the Recovery Timers (RTy, where y = 0,1) via RTC.RTyE = 1_B.

Recovery Timers (RTy, where y = 0,1) are enabled after Application Reset to service the WDT timeout alarms.

SM[HW]:SMU:FSP_MONITOR

Init conditions

FSP Monitor is enabled after Power-on Reset. The application SW shall ensure that the FSP is in the Fault Free State (SMU_ReleaseFSP()) before entering the RUN state with the SMU_Start() command.

SM[HW]:PMS:VDDM_MONITOR

Init conditions

SMC[SW]:PMS:Vx_MONITOR_CFG

4.85 [SAFETY_TC.H019] SM[HW]:NVM.FSIRAM:REG_MONITOR_TEST should not be considered

Description

The SM[HW]:NVM.FSIRAM:REG_MONITOR_TEST is defined in the AURIX™ TC3xx Safety Manual as a self-test mechanism for the FSI.RAM SFFs.

Recommendation

The system integrator has to consider the FSI.RAM SFFs as not testable, as in fact there are no means to trigger this test.

4 Application hints

Note: *SM[HW]:NVM.FSIRAM:REG_MONITOR_TEST is not part of the FMEDA and will not impact the FIT rate.*

4.86 [SAFETY_TC.H020] Test of SM[HW]:VMT:REG_MONITOR is missing - Documentation update

Description

The “Tests” field of SM[HW]:VMT:REG_MONITOR (section 6.500 in AURIX™ TC3xx Safety Manual v1.04 and higher versions) is empty. Users may think that the safety flip-flops mechanism is not testable, which is not true.

Documentation update

SM[HW]:VMT:REG_MONITOR is testable through SMU by ESM[SW]:SMU:REG_MONITOR_TEST.

4.87 [SCR_TC.H009] RAM ECC Alarms in Standby Mode

Description

During Standby mode, every ECC error in the RAMs of the Standby Controller (SCR) can be detected but the respective alarm signal is not propagated and not triggered by the SMU (ALM6[19], ALM6[20] and ALM6[21]).

Note: *If not in Standby mode, alarm signals for ECC errors from the SCR RAMs are propagated and triggered by the SMU.*

Recommendation

ECC errors from the RAMs of SCR can be checked by the application software via bit SCRECC of PMS register PMSWCR2 (Standby and Wake-up Control Register).

4.88 [SCR_TC.H010] HRESET command erroneously sets RRF flag

Description

Note: *This problem is only relevant for tool development, not for application development.*

The HRESET command (to reset the SCR including its OCDS) erroneously sets the RRF flag (which signals received data to the FW).

Recommendation

With the following three additional commands (1-3) after an HRESET, the issues with the HRESET command can be solved:

- Execute HRESET
 1. Execute HSTATE to remove reset bit from shift register
 2. Perform JTAG tool reset to remove flag RRF (receive register flag)
 3. Execute HCOMRST to remove flag TRF (transmit register flag)

4.89 [SCR_TC.H011] Hang-up when warm PORST is activated during Debug Monitor Mode

Description

Note: *This problem is only relevant for debugging.*

4 Application hints

When a debugger is connected and the device is in Monitor Mode (MMODE), the activation of a warm PORST will result in a hang-up of the SCR controller.

Recommendation

Perform an LVD reset (power off/on) to terminate this situation.

4.90 [SCR_TC.H012] Reaction in case of XRAM ECC Error

Description

When the double-bit ECC reset is enabled via bit ECCRSTEN in register SCR_RSTCON, and a RAM double-bit ECC error is detected, bit RSTST.ECCRST in register SCR_RSTST is set, but no reset is performed.

Recommendation

The reset of the SCR module in case of a double-bit ECC error must be performed via software.

The following steps need to be done:

- Enable the double-bit ECC reset by setting bit ECCRSTEN in register SCR_RSTCON to 1_B
- Enable the RAM ECC Error for NMI generation by setting bit NMIRAMECC in register SCR_NMICON to 1_B

When a RAM double-bit ECC error is detected, an NMI to the TriCore™ is generated, and bit RSTST.ECCRST in register SCR_RSTST is set.

The TriCore™ software first has to check the cause of the NMI wakeup by checking register SCR_RSTST. If bit ECCRST is set, a double-bit ECC error has occurred. In this case, do the following steps:

- Fill the XRAM memory with 0
- Check whether an ECC error has occurred
- If no ECC error has occurred after filling the XRAM with 0, then:
 - Reload the contents of the XRAM
 - Perform a reset of the SCR module: Set bit SCRSTREQ in register PMSWCR4 to 1_B

4.91 [SCR_TC.H014] Details on WDT pre-warning period

Description

The pre-warning interrupt request (FNMIWDT) of the SCR Watchdog Timer (WDT) means that a WDT overflow has just occurred, and in 32 cycles of the SCR WDT clock there will be a reaction to this overflow – a reset of the SCR.

After this pre-warning interrupt it is not possible to stop the WDT, as it has already overflowed, and it is not possible to stop this reaction (reset).

4.92 [SCR_TC.H016] SCR current consumption in IDLE mode and 70 kHz clock

Description

The data sheet specifies SCR current values for the different modes like STANDBY and IDLE. Additionally, the SCR CPU clock speed can be configured and is another parameter for the variance of the module current consumption.

The value for $I_{SCRIDLE}$ specified in the data sheet is based on the real power pattern and covers the use case $f_{SYS_SCR} = 20\text{ MHz}$, $T_J = 150^\circ\text{C}$ and SCR CPU in IDLE mode.

4 Application hints

Documentation update

For the use case with $f_{\text{SYS_SCR}} = 70 \text{ kHz}$, $T_J = 25^\circ\text{C}$ and SCR CPU in IDLE mode, we estimate I_{SCRIDLE_70} CC of 90 μA .

4.93 [SCU_TC.H020] Digital filter on ESRx pins - Documentation update

Description

As described in the SCU and PMS chapters of the TC3xx User's Manual, the input signals $\overline{\text{ESR0}}$ / $\overline{\text{ESR1}}$ can be filtered. The filter for $\overline{\text{ESR}x}$ is enabled via bit PMSWCR0.ESRxDFEN = 1_B (default after reset).

If the digital filter is enabled then pulses less than 30 ns will not result in a trigger.

For pulses longer than 100 ns, the following dependency on f_{SPB} should be noted:

Note: Pulses longer than 100 ns will always result in a trigger for $f_{\text{SPB}} \geq 20 \text{ MHz}$ in RUN mode.

4.94 [SCU_TC.H021] LBIST execution affected by TCK/DAP0 state

Description

The TCK/DAP0 pad includes an internal pull down (marked "PD2" in column "Buffer Type" in table "System I/O of the Data Sheet).

If TCK/DAP0 is pulled up by an external device, LBIST execution will be stalled.

Recommendation

TCK/DAP0 pad shall be left open or pulled down if no tool is connected.

4.95 [SCU_TC.H023] Behavior of bit RSTSTAT.PORST after wake-up from standby mode

Description

After cold-power on (power up from no power supply), bit RSTSTAT.PORST is always set independent of PORST pad level (pulled high or low by user).

After wake-up from standby, bit RSTSTAT.PORST indicates if the PORST pad was asserted after the wake-up trigger.

Recommendation

If the user expects that bit RSTSTAT.PORST is always set after wake-up from standby, the PORST pad should be kept low externally until all supplies are in operating condition.

4.96 [SCU_TC.H025] Field EEA in register CHIPID - Additional information

Description

In the SCU chapter of the TC3xx User's Manual, field EEA in register CHIPID is described as follows:

Table 22 Field EEA in register CHIPID

Field	Bits	Type	Description
EEA	16	rh	Emulation or ADAS Extension Available

(table continues...)

4 Application hints

Table 22 (continued) Field EEA in register CHIPID

Field	Bits	Type	Description
			Indicates if the emulation or ADAS extension hardware is available or not. 0_B EEC is not available (SAK-TC3xxxU or SAK-TC3xxxP) 1_B EEC is available (SAK-TC3xxxE or SAK-TC3xxxF)

The product names/feature packages (SAK-TC3xxxU, ...) mentioned in this description shall only be understood as examples; they may not exist for each TC3yx device variant.

Recommendation

For a summary of the functionality available in each TC3yx device variant see the TC3yx Data Sheet Addendum. As can be seen from the Chip ID values defined in this document, bit EEA = 1_B in TC39x, TC37xEXT, TC35x and TC33xEXT devices, and bit EEA = 0_B in TC3Ex, TC38x, TC37x, TC36x and TC33x/TC32x devices.

For a summary of the functionality of TC3xx emulation devices and their Chip ID values see the TC3xx_ED Data Sheet.

4.97 [SCU_TC.H026] Unexpected alarm ALM0[1] during warm reset

Description

For any warm reset, the shutdown request handler described in section “Shutdown request handler” in the Firmware chapter of the TC3xx User’s manual requires access to a specific region in the DSPR of CPU0.

For the following configuration

- access to a specific region of CPU0 DSPR (see recommendation below) is disabled for one or all n of the implemented CPUs (CPU x , $x = 0..n-1$) in registers SPR_SPROT_RGNACCENAI_W and SPR_SPROT_RGNACCENAI_R, which means the access enable bits for the corresponding master TAG IDs are ‘0’

an unexpected alarm ALM0[1] (CPU0 Bus-level MPU violation/Access Protection violation) will occur when an application reset, system reset or warm PORST is requested, and the corresponding flag DF1 in register SMU_AD0 will remain set after the reset if it was a system or application reset.

Recommendation

To avoid these effects, enable read and write access for all available CPUs in the address range 0x70000200 - 0x700003EF in registers SPR_SPROT_RGNACCENAI_W and SPR_SPROT_RGNACCENAI_R.

4.98 [SCU_TC.H027] Bit field INP0 and INP1 in register EICRi - Documentation correction

Description

In the SCU chapter of the current user manual, for settings INP0 = 100_B to 111_B and INP1 = 100_B to 111_B in the description of register EICRi, the last index y of signal TRxy is erroneously shown a 0.

In the description for INP0, the enable bit is erroneously referenced as EIEN(2i) instead of EICRi.EIEN0, and as EIEN(2i+1) instead of EICRi.EIEN1 in the description for INP1.

Documentation correction

The last index y of signal TRxy shall be identical to the OGUy index. The corrected description for INP0 and settings INP0 = 100_B to 111_B and for INP1 and settings INP1 = 100_B to 111_B is shown in the following table.

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Table 23 **Field INP0 and INP1 in register EICRi (i=0-3) - Correction**

Field	Bits	Type	Description
INP0	14:12	rw	Input Node Pointer This bit-field determines the destination (output channel) for trigger event (2i) (if enabled by EICRi.EIEN0). 100 _B An event from input ETL 2i triggers output OGU4 (signal TR(2i) 4) 101 _B An event from input ETL 2i triggers output OGU5 (signal TR(2i) 5) 110 _B An event from input ETL 2i triggers output OGU6 (signal TR(2i) 6) 111 _B An event from input ETL 2i triggers output OGU7 (signal TR(2i) 7)
INP1	30:28	rw	Input Node Pointer This bit-field determines the destination (output channel) for trigger event (2i+1) (if enabled by EICRi.EIEN1). 100 _B An event from input ETL 2i+1 triggers output OGU4 (signal TR(2i+1) 4) 101 _B An event from input ETL 2i+1 triggers output OGU5 (signal TR(2i+1) 5) 110 _B An event from input ETL 2i+1 triggers output OGU6 (signal TR(2i+1) 6) 111 _B An event from input ETL 2i+1 triggers output OGU7 (signal TR(2i+1) 7)

Note: *In the table above, only rows that include corrections are shown.*

4.99 **[SCU_TC.H028] ERU configuration changes may lead to ERU reactions**

Description

The External Request Unit (ERU) may react on changes of control registers even if there is no edge at its inputs. For example, if one of the inputs of an input channel x is '1' and this is switched to another input of this channel (by EICRy.EXISz) that is '0', then ERU recognizes an edge if configured for this input channel x and the corresponding EIFR.INTFx is set and the trigger is propagated to the ERU output as configured.

Recommendation

Clear EIFR.INTFx bits after (re-)configuration.

If an ERU reaction is to be suppressed on configuration changes (and you suspect there might be two different levels at the two ERU inputs to be switched), then:

- Clear bits EICRy.RENZ, EICRy.FENZ without changing EICRy.EXISz (so potential edges are swallowed at the 'Detect Event (edge)' block)
- With a 2nd write access to EICRy set bits EICRy.EXISz as needed without changing the EICRy.RENZ, EICRy.FENZ
- Wait long enough

The wait time depends on the ERU input filter setting

In case the filter is active, the 3rd access to EICRy has to happen after EIFILT.DEPTH * (EIFILT.FILTDIV + 1) SPB (100 MHz) clock cycles, otherwise the edge is still traveling through the filter and has not arrived at the 'Detect Event (edge)' block yet, to be swallowed as intended

- Then with a 3rd write access set EICRy.RENZ, EICRy.FENZ as needed without changing the EICRy.EXISz

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4.100 [SENT_TC.H006] Parameter V_{ILD} on pads used as SENT inputs

Description

Some port pins may have restrictions when used as SENT inputs, depending on the number of active neighbor pins (on the pad frame) and their output driver setting.

In the implementation of the SENT module and product integration within Infineon Technologies products there are never negative values for V_{ILD} , so V_{ILDmin} is 0 mV. Considering the same tolerance as the SENT standard V_{ILDmax} is 100 mV.

Note: All SENT port pins not listed in the tables below have no restrictions on their application usage as SENT inputs.

Table 24 SENT input pads and considered neighbors

Device	Considered left neighbors		SENT input		Considered right neighbors	
			Pad	Channel		
TC39x	P15.1	P15.3	P15.4	11D	P15.6	P20.9
	P31.6	P31.7	P31.8	20C	P31.9	P31.10
	P31.7	P31.8	P31.9	21C	P31.10	P31.11
	P31.8	P31.9	P31.10	22C	P31.11	P31.14
	P31.9	P31.10	P31.11	23C	P31.14	P31.12
	P31.11	P31.14	P31.12	24C	P31.13	P31.15
TC38x	P15.0	P15.2	P15.4	11D	P15.1	P15.3
	P31.6	P31.7	P31.8	20C	P31.10	P31.9
	P31.8	P31.10	P31.9	21C	P31.12	P31.11
	P31.7	P31.8	P31.10	22C	P31.9	P31.12
	P02.13	P02.11	P02.12	23B	P02.4	P02.15
	P31.9	P31.12	P31.11	23C	P31.14	P31.13
	P31.10	P31.9	P31.12	24C	P31.11	P31.14
TC3Ex	P02.6	P02.7	P02.8	0C	P02.9	P02.10
	P02.4	P02.6	P02.7	1C	P02.8	P02.9
	P02.11	P02.4	P02.6	2C	P02.7	P02.8
	P15.0	P15.2	P15.4	11D	P15.1	P15.3
	P02.3	P02.11	P02.4	12B	P02.6	P02.7
	P02.1	P02.5	P02.3	13B	P02.11	P02.4
	P15.1	P15.3	P14.0	17D	P15.6	P15.7

(table continues...)

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Table 24 (continued) SENT input pads and considered neighbors

Device	Considered left neighbors		SENT input		Considered right neighbors	
			Pad	Channel		
TC37x and TC37xEXT	P02.6	P02.7	P02.8	0C	P02.9	P02.10
	P00.0	P00.1	P00.2	1B	P00.3	P00.4
	P02.5	P02.6	P02.7	1C	P02.8	P02.9
	P02.4	P02.5	P02.6	2C	P02.7	P02.8
	P02.3	P02.4	P02.5	3C	P02.6	P02.7
	P15.0	P15.1	P15.2	10D	P15.3	P15.4
	P15.2	P15.3	P15.4	11D	P15.5	P15.6
	P02.2	P02.3	P02.4	12B	P02.5	P02.6
	P02.1	P02.2	P02.3	13B	P02.4	P02.5
	P02.0	P02.1	P02.2	14B	P02.3	P02.4
TC36x	P02.8	P00.0	P00.1	0B	P00.2	P00.3
	P02.6	P02.7	P02.8	0C	P00.0	P00.1
	P00.0	P00.1	P00.2	1B	P00.3	P00.4
	P02.5	P02.6	P02.7	1C	P02.8	P00.0
	P02.4	P02.5	P02.6	2C	P02.7	P02.8
	P02.3	P02.4	P02.5	3C	P02.6	P02.7
TC33xEXT	P02.8	P00.0	P00.1	0B	P00.2	P00.7
	P02.7	P02.6	P02.8	0C	P00.0	P00.1
	P00.0	P00.1	P00.2	1B	P00.7	P00.3
	P02.2	P02.3	P02.7	1C	P02.6	P02.8
	P02.4	P02.1	P02.5	3C	P02.2	P02.3
TC33x/TC32x	P02.8	P00.0	P00.1	0B	P00.2	P00.3
	P02.6	P02.6	P02.8	0C	P00.0	P00.1
	P00.0	P00.1	P00.2	1B	P00.3	P00.4
	P02.5	P02.6	P02.7	1C	P02.8	P00.0
	P02.4	P02.5	P02.6	2C	P02.7	P02.8
	P02.3	P02.4	P02.5	3C	P02.6	P02.7
	P33.4	P33.5	P33.6	4C	P33.7	P33.8

Note: The table above is sorted by SENT channel numbers in ascending order. The same sorting is also used in the tables below.

The following tables summarize the results of the V_{ILD} measurements of the SENT input pads potentially exceeding the V_{ILD} limits with different neighbor (2N/4N) and different edge strength/driver strength configurations.

- **VILD(DIST4N):** V_{ILD} measurements with four neighbor pads (two on the left and two on the right hand side of the SENT input) used in output mode alongside the SENT input pad on the pad frame
- **VILD(DIST2N):** V_{ILD} measurements with two neighbor pads (one on the left and one on the right hand side of the SENT input) used in output mode alongside the SENT input pad on the pad frame

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Table 25 Effect of Driver Settings Fss, Sms, Sm on SENT inputs

Device	SENT Channel			Neighbors: Fast pads configured as Fss, others Sms/Sm	
	Name	Number	Pin	VILD(DIST4N)	VILD(DIST2N)
TC39x	SENT:SENT11D	11D	P15.4	x	x
	SENT:SENT20C	20C	P31.8	x	x
	SENT:SENT21C	21C	P31.9	x	x
	SENT:SENT22C	22C	P31.10	x	x
	SENT:SENT23C	23C	P31.11	x	x
	SENT:SENT24C	24C	P31.12	x	x
TC38x	SENT:SENT11D	11D	P15.4	x	OK
	SENT:SENT20C	20C	P31.8	x	x
	SENT:SENT21C	21C	P31.9	x	OK
	SENT:SENT22C	22C	P31.10	x	x
	SENT:SENT23B	23B	P02.12	x	OK
	SENT:SENT23C	23C	P31.11	x	x
	SENT:SENT24C	24C	P31.12	x	x
TC3Ex	SENT:SENT0C	0C	P02.8	x	x
	SENT:SENT1C	1C	P02.7	x	OK
	SENT:SENT2C	2C	P02.6	x	x
	SENT:SENT11D	11D	P15.4	x	OK
	SENT:SENT12B	12B	P02.4	x	OK
	SENT:SENT13B	13B	P02.3	x	OK
	SENT:SENT17D	17D	P14.0	x	OK
TC37x and TC37xEXT	SENT:SENT0C	0C	P02.8	x	OK
	SENT:SENT1B	1B	P00.2	x (TC37xEXT) OK (TC37x)	OK
	SENT:SENT1C	1C	P02.7	x	OK
	SENT:SENT2C	2C	P02.6	x	x (TC37xEXT) OK (TC37x)
	SENT:SENT3C	3C	P02.5	x	OK
	SENT:SENT10D	10D	P15.2	x (TC37xEXT) OK (TC37x)	OK
	SENT:SENT11D	11D	P15.4	x	OK
	SENT:SENT12B	12B	P02.4	x	OK
	SENT:SENT13B	13B	P02.3	x	x (TC37xEXT) OK (TC37x)
	SENT:SENT14B	14B	P02.2	x	OK

(table continues...)

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Table 25 (continued) Effect of Driver Settings Fss, Sms, Sm on SENT inputs

Device	SENT Channel			Neighbors: Fast pads configured as Fss, others Sms/Sm	
	Name	Number	Pin	VILD(DIST4N)	VILD(DIST2N)
TC36x	SENT:SENT0B	0B	P00.1	x	OK
	SENT:SENT0C	0C	P02.8	x	OK
	SENT:SENT1B	1B	P00.2	x	OK
	SENT:SENT1C	1C	P02.7	x	OK
	SENT:SENT2C	2C	P02.6	x	x
	SENT:SENT3C	3C	P02.5	x	x
TC33xEXT	SENT:SENT0B	0B	P00.1	x	x
	SENT:SENT0C	0C	P02.8	x	OK
	SENT:SENT1B	1B	P00.2	x	OK
	SENT:SENT1C	1C	P02.7	x	OK
	SENT:SENT3C	3C	P02.5	x	OK
TC33x/TC32x	SENT:SENT0B	0B	P00.1	x	OK
	SENT:SENT0C	0C	P02.8	x	OK
	SENT:SENT1B	1B	P00.2	x	OK
	SENT:SENT1C	1C	P02.7	x	OK
	SENT:SENT2C	2C	P02.6	x	x
	SENT:SENT3C	3C	P02.5	x	x
	SENT:SENT4C	4C	P33.6	x	OK

Table 26 Effect of Driver Settings Fsm, Fm, Sms, Sm on SENT inputs

Device	SENT Channel			Neighbors: Fast pads configured as Fsm or Fm, others Sms/Sm	
	Name	Number	Pin	VILD(DIST4N)	VILD(DIST2N)
TC39x	SENT:SENT11D	11D	P15.4	OK	OK
	SENT:SENT20C	20C	P31.8	x	OK
	SENT:SENT21C	21C	P31.9	x	OK
	SENT:SENT22C	22C	P31.10	x	OK
	SENT:SENT23C	23C	P31.11	x	OK
	SENT:SENT24C	24C	P31.12	x	OK

(table continues...)

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Table 26 (continued) Effect of Driver Settings Fsm, Fm, Sms, Sm on SENT inputs

Device	SENT Channel			Neighbors: Fast pads configured as Fsm or Fm, others Sms/Sm	
	Name	Number	Pin	VILD(DIST4N)	VILD(DIST2N)
TC38x	SENT:SENT11D	11D	P15.4	OK	OK
	SENT:SENT20C	20C	P31.8	x	OK
	SENT:SENT21C	21C	P31.9	x	OK
	SENT:SENT22C	22C	P31.10	x	OK
	SENT:SENT23B	23B	P02.12	OK	OK
	SENT:SENT23C	23C	P31.11	x	OK
	SENT:SENT24C	24C	P31.12	x	OK
TC3Ex	SENT:SENT0C	0C	P02.8	OK	OK
	SENT:SENT1C	1C	P02.7	OK	OK
	SENT:SENT2C	2C	P02.6	OK	OK
	SENT:SENT11D	11D	P15.4	OK	OK
	SENT:SENT12B	12B	P02.4	OK	OK
	SENT:SENT13B	13B	P02.3	OK	OK
	SENT:SENT17D	17D	P14.0	OK	OK
TC37x and TC37xEXT	SENT:SENT0C	0C	P02.8	OK	OK
	SENT:SENT1B	1B	P00.2	OK	OK
	SENT:SENT1C	1C	P02.7	OK	OK
	SENT:SENT2C	2C	P02.6	OK	OK
	SENT:SENT3C	3C	P02.5	OK	OK
	SENT:SENT10D	10D	P15.2	OK	OK
	SENT:SENT11D	11D	P15.4	OK	OK
	SENT:SENT12B	12B	P02.4	OK	OK
	SENT:SENT13B	13B	P02.3	OK	OK
	SENT:SENT14B	14B	P02.2	OK	OK
TC36x	SENT:SENT0B	0B	P00.1	OK	OK
	SENT:SENT0C	0C	P02.8	OK	OK
	SENT:SENT1B	1B	P00.2	OK	OK
	SENT:SENT1C	1C	P02.7	OK	OK
	SENT:SENT2C	2C	P02.6	OK	OK
	SENT:SENT3C	3C	P02.5	OK	OK

(table continues...)

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Table 26 (continued) Effect of Driver Settings Fsm, Fm, Sms, Sm on SENT inputs

Device	SENT Channel			Neighbors: Fast pads configured as Fsm or Fm, others Sms/Sm	
	Name	Number	Pin	VILD(DIST4N)	VILD(DIST2N)
TC33xEXT	SENT:SENT0B	0B	P00.1	OK	OK
	SENT:SENT0C	0C	P02.8	OK	OK
	SENT:SENT1B	1B	P00.2	OK	OK
	SENT:SENT1C	1C	P02.7	OK	OK
	SENT:SENT3C	3C	P02.5	OK	OK
TC33x/TC32x	SENT:SENT0B	0B	P00.1	OK	OK
	SENT:SENT0C	0C	P02.8	OK	OK
	SENT:SENT1B	1B	P00.2	OK	OK
	SENT:SENT1C	1C	P02.7	OK	OK
	SENT:SENT2C	2C	P02.6	OK	OK
	SENT:SENT3C	3C	P02.5	OK	OK
	SENT:SENT4C	4C	P33.6	OK	OK

Table 27 Effect of Driver Settings Fm, Sms, Sm on SENT inputs

Device	SENT Channel			Neighbors: Fast pads configured as Fm, others Sms/Sm	
	Name	Number	Pin	VILD(DIST4N)	VILD(DIST2N)
TC39x	SENT:SENT11D	11D	P15.4	OK	OK
	SENT:SENT20C	20C	P31.8	OK	OK
	SENT:SENT21C	21C	P31.9	OK	OK
	SENT:SENT22C	22C	P31.10	OK	OK
	SENT:SENT23C	23C	P31.11	OK	OK
	SENT:SENT24C	24C	P31.12	OK	OK
TC38x	SENT:SENT11D	11D	P15.4	OK	OK
	SENT:SENT20C	20C	P31.8	OK	OK
	SENT:SENT21C	21C	P31.9	OK	OK
	SENT:SENT22C	22C	P31.10	OK	OK
	SENT:SENT23B	23B	P02.12	OK	OK
	SENT:SENT23C	23C	P31.11	OK	OK
	SENT:SENT24C	24C	P31.12	OK	OK

Table 28 Abbreviations used for pad configuration

Symbol	Pad type	Driver Strength / Edge Mode
Fss	Fast	strong driver, sharp edge
Fsm	Fast	strong driver, medium edge
Fm	Fast	medium driver

(table continues...)

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Table 28 (continued) Abbreviations used for pad configuration

Symbol	Pad type	Driver Strength / Edge Mode
Sms	Slow	medium driver, sharp edge
Sm	Slow	medium driver

Recommendation

From the tables above, following is the conclusion based on the measured V_{ILD} values for each pad in different configurations:

Table 29 Conclusion for SENT application usage

Symbol	Conclusion for SENT application usage
OK	V_{ILD} is below the standard threshold (100mV) and hence pin can be used in the mentioned configuration.
x	<p>V_{ILD} is above the standard threshold (100mV) and hence pin cannot be used in the mentioned configuration. Following are possible alternatives to use the SENT pad (marked as “OK” in the tables above):</p> <ul style="list-style-type: none"> Configure the neighboring pads have to weaker edge mode / driver strength (Fsm or Fm instead of Fss) Use SENT input with 2N neighbors instead of 4N

4.101 [SENT_TC.H007] Range for divider value DIV - Documentation correction

Description

In section “Baud Rate Generation” and in the description of register CFDRx in the SENT chapter of the TC3xx User’s Manual, the range for the divider value DIV is documented as

- DIV = [2200, 49100]

The upper limit of this range is incorrect.

Documentation correction

The correct range that can be used for the divider value DIV is

- DIV = [2200, 52428]

4.102 [SMU_TC.H010] Clearing individual SMU flags: use only 32-bit writes

Description

The SMU registers shall only be written via 32-bit word accesses (i.e. ST.W instruction), as mentioned in table “Registers Overview” of the SMU chapter in the User’s Manual.

If any other instruction such as LDMST or SWAPMSK.W is used to modify only a few bits in the 32-bit register, then this may have the effect of modifying/clearing unintended bits.

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Recommendation (Examples in C Language)

- **Example 1:** To clear status flag SF2 in register AG0, use:
 - `SMU_AG0.U = 0x0000 0004;`
- **Example 2:** To clear status flags EF2 in register RMEF and RMSTS, use:
 - `SMU_RMEF.U = 0xFFFF FFFB;`
 - `SMU_RMSTS.U = 0xFFFF FFFB;`

Here the <REGISTER>.U implies writing to the register as an unsigned integer, which normally results in a compiler translation into an ST.W instruction.

Safety Considerations

As long as software uses only 32-bit writes to the SMU registers, there is no risk of malfunction.

In case the software does not use 32-bit writes (and for example uses bit-wise operations such as LDMST instructions instead) – then potentially unintended flags may be written and modified in the SMU registers. Depending on the application, this may potentially have an impact on safety and/or diagnostics.

Note: *The SMU reaction itself (for example alarm action triggering) is not affected even if the software unintentionally clears additional bits by not using a 32-bit write as recommended.*

4.103 [SMU_TC.H012] Handling of SMU alarms ALM7[1] and ALM7[0]

Description

The FSI RAM is used to configure the PFLASH. For security related reason, the access to this RAM is restricted. Therefore, in order to avoid accesses to this RAM through its SSH, the MBIST Controller 40 is not disclosed in the AURIX™ TC3xx User's Manual.

However, the SMU alarms ALM7[1] and ALM7[0] are set intentionally after PORST and system reset and shall be cleared by the application SW (cf. ESM[SW]:SYS:MCU_FW_CHECK in Safety Manual).

Also, in order to clear the SMU alarms ALM7[1] and ALM7[0], it is necessary to clear the alarms within this MC40.

Recommendation

The following register addresses have to be written to clear the FSI RAM Fault Status and ECC Detection Register:

`MCi_FAULTSTS (i=40, 0xF00638F0) = (16-bit write) 0x0`

`MCi_ECCD (i=40, 0xF0063810) = (16-bit write) 0x0`

4.104 [SMU_TC.H013] Increased Fault Detection for SMU Bus Interface (SMU_CLC Register)

Description

Transient faults can possibly affect the SMU_CLC register and lead to disabling the SMU_core. This unintended switching off of SMU_core cannot be detected if the FSP protocol is not used at all or used in FSP bi-stable mode.

Recommendation

In order to increase the capability of the microcontroller to detect such faults it is recommended to:

- Option 1:
Use FSP Dynamic dual-rail or Time-switching protocol only, don't use FSP bi-stable protocol
- Option 2:

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In case FSP protocol is not used at all or Recommendation Option 1 is not possible, the [Application SW] shall read periodically, once per FTTI, the SMU_CLC register to react on unintended disabled SMU

4.105 [SMU_TC.H016] SMU_stdby restriction for using P33.8 as Emergency Stop input

Description

SMU_core can be configured to report the presence of faults on port pin P33.8 using the Fault Signaling Protocol. However, SMU_stdby in combination with SMU_core can also be configured for handling common cause faults in a diverse way.

On the detection of faults, the SMU_STDBY sets P33.8 in high impedance state (fault state). In order to recognize the high impedance state of the P33.8 as the fault state, an external pull-down is needed if bi-stable FSP is used (see for example section “Interface to the Pads (ErrorPin)” in the SMU chapter of the User’s Manual). When the SMU_stdby sets P33.8 in high impedance state (fault state), the SMU_STS.FSP[0] bit-field as well as P33_IN.P8 bit-field do not reflect the actual logic level of the pin P33.8.

While SMU_stdby sets P33.8 to high impedance the port triggered emergency stop function on this port will be disabled and no emergency stop event will be generated as consequence.

Recommendation

Therefore it is recommended to use port pin P21.2 (PORT B) as Emergency Stop input when SMU_stdby is configured to report fault on P33.8.

4.106 [SMU_TC.H017] Handling of ALM21[7] when safety flip-flop self-test is executed

Description

After execution of the Safety flip-flop self-test when the PMS or PMSLE module is enabled (SMU_RMCTL[5] = 1), the alarm ALM21[7] might not be reported. This is due to the fact that the clock of the SMU_stdby (where the ALM21[7] belongs to) is slower than the alarm pulse, therefore the alarm might not be reported.

This happens only during the Safety flip-flop self-test, because in case of a real error during run mode, the alarm signal will persist longer and it will be caught also by a slower clock.

Furthermore, flags used to signal the end of the test (SMU_RMSTS[5]) or a failure in the test (SMU_RMEF[5]) are working properly.

A more detailed view shows that the error signal coming out from the PMS/PMSLE Safety flip-flop is connected to both SMU_core and SMU_stdby for diverse processing during run mode. During the Safety flip-flop self-test of the PMS/PMSLE module, it is expected that the error signal should trigger an alarm in the SMU_core only, which means that the ALM21[7] is superfluous.

Recommendation

When the Safety flip-flop self-test is executed and the PMS/PMSLE module is enabled (SMU_RMCTL[5] = 1), ignore alarm ALM21[7] and clear it when the test is completed.

4.107 [SRI_TC.H001] Using LDMST and SWAPMSK.W instructions on SRI mapped peripheral registers (range 0xF800 0000-0xFFFF FFFF)

Description

The LDMST and SWAPMSK.W instructions in the AURIX™ microcontrollers are intended to provide atomicity as well as bit-wise operations to a targeted memory location or peripheral register. They are also referred to as Read-Modify-Write (RMW) instructions.

4 Application hints

The bit-manipulation functionality is intended to provide software a mechanism to write to individual bits in a register, without affecting other bits. The bits to be written can be selected through a mask in the instruction. Please refer to the TriCore™ Architecture Manual for further information about these instructions and their formats.

Restrictions for SRI mapped Peripherals

The bit-manipulation functionality is supported only on registers accessed via the SPB bus, and is not supported on the SRI mapped peripheral range, that is address range 0xF800 0000 to 0xFFFF FFFF

The SRI mapped peripheral range includes the following units (if available):

- In **TC2xx**: EBU, PMU0, SRI Crossbar, LMU, DAM, FFT, CPUx SFRs and CSFRs, MCDS, miniMCDS; see table “On Chip Bus Address Map of Segment 15” in chapter “Memory Map”
- In **TC3xx**: DMU, LMU, EBU, DAM, SRI Crossbar, SPU, CPUx SFRs and CSFRs, AGBT, miniMCDS, ...; see table “On Chip Bus Address Map of Segment 15” in chapter “Memory Map”

On the SRI mapped peripherals, usage of these instructions always results in all the bits of a register being written, and not just specific individual bits.

Note: *The instructions are still executed atomically on the bus – that is, the SRI is locked between the READ and the WRITE transaction.*

4.108 [SSW_TC.H001] Security hardening measure for the startup behavior

Description

In order to increase the robustness of the debug protection mechanism against malicious attacks, it is strongly suggested to always apply another layer of protection in combination with it.

Recommendation

On top of the debug protection mechanism, enabled via UCB_DBG through the HF_PRONCONDBG.DBGIFLCK bit using a 256-bit password, you must set the global PFLASH or DFLASH read protection.

Both protections can be enabled individually or together. It is not mandatory to set both protections at the same time.

In most cases PFLASH will be the preferred option since standard drivers for DFLASH (for example for EEPROM emulation) do not support DFLASH protection.

In order to enable the global PFLASH read protection, HF_PROCONPF.RPRO has to be set to 1 inside the UCB_PFLASH_ORIG/COPY.

In order to enable the global DFLASH read protection, HF_PROCONDF.RPRO has to be set to 1 inside the UCB_DFLASH_ORIG/COPY.

Be aware that the global read protection will apply also a write protection over the entire PFLASH or DFLASH memory respectively.

The enabled read protection is always effective for the startup hardening. For the Flash read access by CPUs it has only an effect in case the device is not booting from internal Flash.

In case a software update is needed, the write protection, inherited as side effect from the global read protection, can be temporarily disabled executing the “Disable Protection” command sequence.

The PFLASH write protection is also contained in the same UCB_PFLASH_ORIG/COPY, so this leads to have only one password (different from the Debug password) to disable write and read protection mechanisms at the same time.

If you remove the global PFLASH read protection this will remove also the PFLASH write protection at the same time.

4 Application hints

Same for the DFLASH write protection, which is included in the UCB_DFLASH_ORIG/COPY. Another single password is used to disable write and read protection over Data Flash 0 at the same time. Data Flash 1 and HSM PFLASH sectors are protected with another security mechanism through “exclusive protection”.

The disabled protection is valid until the next reset or executing the “Resume Protection” command sequence.

For further details please refer to AP32399 “TC3xx debug protection (with HSM)” or to chapter “Non Volatile Memory (NVM) Subsystem” in the AURIX™ TC3xx User’s Manual.

4.109 [STM_TC.H004] Access to STM registers while STMDIV = 0

Description

If accesses to STM kernel registers are performed while bit-field STMDIV = 0_H in the corresponding CCU Clock Control register (that is, clock f_{STM} is stopped),

- the SPB bus gets locked after the first access until a timeout (defined in BCU Control register field SBCU_CON.TOUT) occurs;
- after the second access the STM slave will answer with RTY (retry) until the STM is clocked again with STMDIV > 0_H

The corresponding CCU Clock Control register including STMDIV is:

- CCUCON1 in **TC2xx**
- CCUCON0 in **TC3xx**

Recommendation

- In **TC2xx**, do not access any STM kernel register while CCUCON1.STMDIV = 0_H
- In **TC3xx**, do not access any STM kernel register while CCUCON0.STMDIV = 0_H

Revision history

Revision history

Document version	Date of release	Description of changes
1.0	2020-01-17	First version for TC33x step AA
1.1	2020-03-31	Update: <ul style="list-style-type: none"> • TC32x included • New/updated text modules see column “Change” in tables 3..5 of errata sheet V1.1 • Removed: <ul style="list-style-type: none"> - CPU_TC.H016 (List of OS and I/O Privileged Instructions - Documentation Update): updated description in TriCore™ TC1.6.2 Core Architecture Manual V1.2.1, Vol. 2 Instruction Set, table 14 - GTM_TC.H020 (GTM can cause unintended bus errors after enabling when SPB or GTM frequency is very low): does not apply to this design step
1.2	2020-07-06	Update: <ul style="list-style-type: none"> • New/updated text modules see column “Change” in tables 3..5 of errata sheet V1.2
1.3	2020-10-23	Update: <ul style="list-style-type: none"> • New/updated text modules see column “Change” in tables 3..5 of errata sheet V1.3 • Text module SCR_TC.022 (Effect of application or system reset and warm PORST on MC77_ECCD and MC78_ECCD for SCR RAMs) moved from chapter “Application Hints” to chapter “Functional Problems” • Removed: <ul style="list-style-type: none"> - SAFETY_TC.H001 (Features intended for development only – Documentation update to Safety Manual) - SAFETY_TC.H003 (ESM[SW]:EDSADC: VAREF_PLAUSIBILITY and ESM[SW]: EVADC:VAREF_ PLAUSIBILITY – Additional information) - SAFETY_TC.H004 (ESM[HW]:PMS: VEXT_VEVRSB_OVERVOLTAGE – Wording update) <p>>> updated description in TC3xx Safety Manual V1.11</p>
1.4	2021-01-22	Update: <ul style="list-style-type: none"> • New/updated text modules see column “Change” in tables 3..5 of errata sheet V1.4
1.5	2021-04-22	Update: <ul style="list-style-type: none"> • New/updated text modules see column “Change” in tables 3..5 of errata sheet V1.5 <ul style="list-style-type: none"> - Text modules already published in TC3xx Errata Advance Information 2021_02: MCMCAN_AI.022, SMU_TC.H012 - Text modules already published in TC3xx Errata Advance Information 2021_03: FlexRay_TC.H004, SCR_TC.023, SENT_TC.H007 • Removed SCU_TC.032, included description in update of SCU_TC.031 (Bits SCU_STSTAT.HWCFGx (x=1-5) could have an unexpected value in application if pins HWCFGx are left unconnected)

Revision history

Document version	Date of release	Description of changes
1.6	2021-07-23	Update: <ul style="list-style-type: none"> New/updated text modules see column “Change” in tables 3..5 of errata sheet V1.6 <ul style="list-style-type: none"> Text modules already published in TC3xx Errata Advance Information 2021_05: GTM_AI.364, GTM_AI.370, GTM_AI.374..376 Text modules already published in TC3xx Errata Advance Information 2021_06: FLASH_TC.055, MCMCAN_TC.H008, MTU_TC.018, PMS_TC.015
1.7	2021-11-04	Update: <ul style="list-style-type: none"> New/updated text modules see column “Change” in tables 3..5 of errata sheet V1.7 <ul style="list-style-type: none"> Text modules already published in TC3xx Errata Advance Information 2021-09: FLASH_TC.056, GTM_AI.358, MCMCAN_AI.023, MEMMAP_TC.001, PADS_TC.H007, SAFETY_TC.023, SAFETY_TC.024 Table 2 (History List) of errata sheet V1.6: corrected “GTM.AI.*” to “GTM_AI.*”
1.8	2022-03-25	Update: <ul style="list-style-type: none"> New/updated text modules see column “Change” in tables 3..5 of errata sheet V1.8 <ul style="list-style-type: none"> Text modules already published in TC3xx Errata Advance Information 2021-12: ASCLIN_TC.012, CCU_TC.005, GTM_TC.H026, GTM_TC.H027, PMS_TC.H011, SAFETY_TC.H019, SAFETY_TC.H020, SCR_TC.024, SCU_TC.033 Text modules already published in TC3xx Errata Advance Information 2022-01: ADC_TC.H033, ASCLIN_TC.H007, GTM_AI.406, GTM_AI.408, OCDS_TC.H015, SMU_TC.H016 Removed SCU_TC.H016 (RSTSTAT reset values - documentation update): updated in TC3xx User’s Manual V1.2.0 and following

Revision history

Document version	Date of release	Description of changes
1.9	2022-07-29	<p>Update:</p> <ul style="list-style-type: none"> Documentation reference changed to Safety Manual v2.0 (see table 1) New/updated text modules see column “Change” in tables 3..5 of errata sheet V1.9 <ul style="list-style-type: none"> Text modules already published in TC3xx Errata Advance Information 2022-05: ADC_TC.H043, FLASH_TC.H021, MTU_TC.H016, SCU_TC.H025 Text modules already published in TC3xx Errata Advance Information 2022-06: GTM_AI.454, INT_TC.H006, LBIST_TC.H003, MCMCAN_AI.024, MCMCAN_AI.H002, SAFETY_TC.026, SAFETY_TC.027 Removed due to updates in Safety Manual v1.12 and following: <ul style="list-style-type: none"> SAFETY_TC.002 (section 6.325 SM[HW]:NVM.PFLASH:FLASHCON_MONITOR), SAFETY_TC.006 (section 6.428 SM[HW]:SMU:CCF_MONITOR) SAFETY_TC.007 (6.346 SM[HW]:PMS:VDDM_MONITOR) SAFETY_TC.H002 (section 6.97 SM[HW]:CPU.PTAG:ERROR_DETECTION) SAFETY_TC.H006 (section 6.349 SM[HW]:PMS:VDD_MONITOR) SAFETY_TC.H007 (section 6.43 SM[HW]:CLOCK:PLL_LOSS_OF_LOCK_DETECTION) SAFETY_TC.H008 (section 6.47 SM[HW]:CONVCTRL:PHASE_SYNC_ERR) SAFETY_TC.H015 (section 6.336 SM[HW]:NVM:STARTUP_PROTECTION) SAFETY_TC.H016 (section 5.32 ESM[SW]:CPU:SOFTERR_MONITOR)

Revision history

Document version	Date of release	Description of changes
1.10	2022-11-11	<p>Update:</p> <ul style="list-style-type: none"> Documentation reference changed to TC3xx User's Manual V2.0.0 (see table 1) New/updated text modules see column "Change" in tables 3..5 of errata sheet V1.10 <ul style="list-style-type: none"> Text modules already published in TC3xx Errata Advance Information 2022-08: FlexRay_TC.H005, SCR_TC.019 Text modules already published in TC3xx Errata Advance Information 2022-09: INT_TC.H006, MBIST_TC.H001 Removed: <ul style="list-style-type: none"> ASCLIN_TC.012 (not applicable to design implementation in AURIX™ family) CPU_TC.H021 (does not apply to TC33x/TC32x (only one CPU core)) Removed due to updates in TC3xx documentation (see also table 1): <ul style="list-style-type: none"> ADC_TC.P014 (updated figure "Equivalent Circuitry for Analog Inputs" included in TC33x/TC32x AA Data Sheet V0.7 (and newer versions)) ADC_TC.H034 (updated footnote on QCONV in table "VADC 5V" in TC33x/TC32x AA Data Sheet V0.7 (and newer versions)) BROM_TC.H017 (corrected in footnote 1 to table "ALL CHECKS PASSED" indication by CHSW" in Firmware chapter of product specific Appendix V1.3.0 (and newer versions)) CCU_TC.004 (updated in description of register OSCCON in Clocking System chapter of TC3xx UM V1.6.0 (and newer versions)) CPU_TC.H020 (updated in tables "Register Overview – SPR", "Register Overview – DLMU", sections "Scratch Pad SRAMs", "DLMU SRAMs", "Register access enable Protection", "Safety Protection registers" in CPU chapter of TC3xx UM V1.5.0 (and newer versions)) FLASH_TC.H019 (updated in section "Write Burst Once" in NVM chapter of TC3xx UM V1.4.0 (and newer versions)) GTM_TC.021 (updated in description of registers GTM_CANOUTSEL0, GTM_CANOUTSEL1 in GTM chapter of product specific Appendix V1.3.0 (and newer versions)) GTM_TC.022 (updated in description of register ATOMi_AGC_ENDIS_STAT in GTM chapter of TC3xx UM V2.0.0) GTM_TC.H022 (updated in description of register ATOMi_AGC_ENDIS_CTRL in GTM chapter of TC3xx UM V1.4.0 (and newer versions)) GTM_TC.H026 (updated in Table 208 "Assignment of TOUTSEL Registers to TOUTy Outputs" in TC33x/TC32x Appendix to TC3xx User Manual V2.0) MTU_TC.019 (updated in description of register MCi_MCONTROL in MTU chapter of TC3xx UM V1.4.0 (and newer versions)) MTU_TC.H017 (updated in section "SRAM Error Detection & Correction (EDC/ECC)" in MTU chapter of TC3xx UM V2.0.0) PINNING_TC.H002 (notes added at the beginning of "Package Variant Pin Configuration" chapters for TQFP-144, TQFP-100 and TQFP-80 packages in TC33x/TC32x AA Data Sheet V1.0 (and newer versions))

Revision history

Document version	Date of release	Description of changes
		<ul style="list-style-type: none"> - PMS_TC.012 (updated in section “Primary under-voltage monitors and Cold PORST” in PMS/PMSLE chapter of TC3xx UM V1.6.0/V1.5.0 (and newer versions)) - PMS_TC.H005 (updated in section “Standby Controller (SCR) Interface” in PMS/PMSLE chapter of TC3xx UM V1.6.0 (and newer versions)) - PMS_TC.H006 (updated in table “EVR33 External Component Reference” in PMSLE chapter of TC3xx UM V1.6.0 (and newer versions) and in table “EVR33 LDO” in TC33x/TC32x Data Sheet V1.0 (and newer versions)) - RESET_TC.P003 (updated in table “Reset” in TC33x/TC32x AA Data Sheet V0.7 (and newer versions)) - SAFETY_TC.H018 (updated in Safety Manual v2.0, sections 4.3.1 (Safety Related Functions, table in Introduction), 4.3.2.6 (Digital Acquisition ASIL B/D), 4.3.2.7 (Digital Actuation ASIL B/D)) - SCR_TC.H013 (notes added after the description of register RCT_CON in SCR chapter of TC3xx UM V1.1.0 (and newer versions)) - SCR_TC.H015 (updated in table “WUF Configuration Registers Address Map” in SCR chapter of TC3xx UM V2.0.0) - SCU_TC.H022 (updated in section “Functional Description” of chapter “LBIST Support” in SCU chapter of TC3xx UM V2.0.0) - SMU_TC.H015 (updated in figure “Reference clocks for FSP timings” and in description of register FSP in SMU chapter of TC3xx UM V1.6.0 (and newer versions))

Revision history

Document version	Date of release	Description of changes
2.0	2023-03-15	<p>Update to latest errata sheet document template and aligned with AURIX™ TC4xx errata sheet flow (details see below).</p> <p>For new and changed errata see also column "Change" in tables 2, 3, and 4.</p> <p>New:</p> <ul style="list-style-type: none"> GTM_AI.H482, PADS_TC.P014, PMS_TC.H015 ADC_TC.H044, CCU6_TC.H001, FlexRay_AI.H010, PORTS_TC.009, RESET_TC.H007, SCU_TC.H026, SCU_TC.H027 (Errata already published in TC3xx Errata Advance Information 2022-12) CCU_TC.P001, GTM_AI.421, GTM_AI.H480, GTM_AI.H481, GTM_AI.487, GTM_AI.488 (Errata already published in TC3xx Errata Advance Information 2023-01) <p>Changed:</p> <ul style="list-style-type: none"> GTM_AI.352, PMS_TC.006 (Errata already published in TC3xx Errata Advance Information 2022-12) GTM_AI.408, SCR_TC.016, SCU_TC.H026 (Errata already published in TC3xx Errata Advance Information 2023-01) <p>Removed:</p> <ul style="list-style-type: none"> ADC_TC.H036 - Updated in section "Buffer for the Analog Input" in EVADC chapter of TC3xx user manual V1.5.0 (and newer versions) ADC_TC.H037 - Information included in section "Result FIFO buffer timing" with TC3xx user manual V2.0.0 ADC_TC.H039 - Information included in section "Result FIFO buffer timing" with TC3xx user manual V2.0.0 <p>When an erratum is used by different families or devices, the erratum is now identical in all errata sheets. Differences between the different families or devices are clearly highlighted in the erratum:</p> <ul style="list-style-type: none"> CPU_TC.131, FLASH_TC.P003, FlexRay_AI.104, FlexRay_AI.105, FlexRay_AI.106, GTM_AI.353, MCMCAN_AI.023, PMS_TC.H008, QSPI_TC.017, SENT_TC.H006, SMU_TC.012, SRI_TC.H001, STM_TC.H004 <p>Following editorial changes were applied to several (not all) errata (examples):</p> <ul style="list-style-type: none"> Misspellings, typos, and case sensitivity Aligned with latest Infineon writing guidelines Added 'Description' section title when missing Changed literals: 0b -> subscripted B, 0x -> subscripted H Added '™' where missing (e.g. TriCore™) Standard footnote numbers are incremented over the entire document (and not per erratum). Table footnotes are numbered per table <p>In order to increase readability and comprehensibility and to standardize, some errata texts have been slightly changed. These are not changes in content. Below are some examples:</p> <ul style="list-style-type: none"> ADC_TC.H040 - Erratum is moved from chapter 'Parametric deviations' to chapter 'Application hints' GTM_AI.364 - "...UDMODE=1,3" --> "...UDMODE = 1 or 3 ..." SCR_TC.H010 - Changed ordered list from 'a, b, c' to '1, 2, 3'

Revision history

Document version	Date of release	Description of changes
2.1	2023-08-21	<p>For new and changed errata see also column "Change" in tables 2, 3, and 4.</p> <p>New:</p> <ul style="list-style-type: none"> FLASH_TC.H024, GTM_AI.H497, GTM_TC.031, SCR_TC.H016 DMA_TC.H018, LBIST_TC.H005, MBIST_TC.H002, MCMCAN_AI.025, MCMCAN_TC.006, MTU_TC.H019, NVM_TC.H001, PADS_TC.016 (is replacing PADS_TC.H009), PORTS_TC.H018, SCU_TC.H028 (Errata already published in TC3xx Errata Advance Information 2023-05) ADC_TC.H045, BROM_TC.H020, CPU_TC.H022, (Errata already published in TC3xx Errata Advance Information 2023-06) <p>Changed:</p> <ul style="list-style-type: none"> GTM_AI.353 (Erratum already published in TC3xx Errata Advance Information 2023-06) <p>Removed:</p> <ul style="list-style-type: none"> BROM_TC.H008 - Updated in section "CAN BSL flow" of chapter "AURIX™ TC3xx Platform Firmware" in TC3xx UM V1.1.0 (and newer versions) PADS_TC.H009 - Replaced by PADS_TC.016
2.2	2023-12-11	<p>For new and changed errata see also column "Change" in tables 2, 3, and 4.</p> <p>New:</p> <ul style="list-style-type: none"> GTM_AI.H803 ADC_TC.H046, CPU_TC.H023, GTM_AI.442, PMS_TC.H018, PMSLE_TC.H001 (Errata already published in TC3xx Errata Advance Information 2023-09) GTM_AI.410, GTM_AI.516, GTM_AI.517, PMS_TC.H019, SMU_TC.015 (Errata already published in TC3xx Errata Advance Information 2023-10) <p>Changed:</p> <ul style="list-style-type: none"> GTM_AI.516 (Update of technical content in comparison to TC3xx Errata Advance Information 2023-10), SCU_TC.H028 <p>Removed:</p> <ul style="list-style-type: none"> GTM_AI.H511: Initially GTM_AI.H511 was published with TC3xx Errata Advance Information 2023-10. It is now removed as this AppHint is not applicable to TC3xx devices. <p>TC4xx family specific content has been removed or erratum has been editorial re-written for better readability. No update of technical content.</p> <ul style="list-style-type: none"> GTM_AI.H480, GTM_AI.H481, GTM_AI.H482, GTM_AI.H497, MCMCAN_AI.023, MCMCAN_AI.025, MCMCAN_AI.H002, MCMCAN_TC.H006, MCMCAN_TC.H007, QSPI_TC.017, SRI_TC.H001, STM_TC.H004

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